

# PN7220

## NFC controller with NCI interface supporting EMV and NFC Forum applications

Rev. 3.3 — 16 April 2024

Product data sheet

### 1 General description

This document describes the functionality and electrical specification of the PN7220 high-power NFC controller family with NCI interface.

As an NCI 2.2 compliant NFC controller with high RF output (2 W) and high receiver sensitivity, the NXP PN7220 is a robust solution for payment terminals and all readers that must generate a strong RF field in a difficult environment. Offering full compliance with EMVCo 3.1 L1 analog and digital, the PN7220 simplifies designs while ensuring interoperability with a broad range of smartcards and mobile phones.

In addition to the reader/writer functionality, the device supports the host card emulation of ISO14443-A cards up to 848 kbit/s and allows to connect up to 3 TDA8035 which offer the possibility for an ISO7816 contact interface connection.

The PN7221 is based on the PN7220 and supports all features of PN7220 plus "Enhanced Contactless Polling" (ECP) by Apple - this description is not part of this document. Note, that the ECP feature is available after formal authorization only.

Two host connection options are available for this product:

1. Connection to one single host - this is typically one host running an Android operating system
2. Connection to two hosts - in this case one host is typically a security CPU connected by the SPI interface to meet PCI compliance requirements for an EMVCo payment subsystem, and the second host connected by an I2C interface which is typically used to run an Android operating system for all non-EMVCo payment related applications.

The PN7220 communicates with a connected host through a physical interface using the NCI 2.2 protocol.

The PN7220 supports two types of configurable polling loops: one NFC Forum polling loop, and one EMVCo compliant polling loop. Switching between the polling loops is done based on a hardware input (GPIO) triggered by a connected host - in case of a switching of the polling loop all data from an ongoing transaction is cleared from the internal buffers, the NCI software stack is being reset and an RF reset is being executed. This helps to ensure data integrity for the performed transaction and allows to connect the right logical software endpoints to each of the polling loops.

To speed-up the switching between NFC Forum polling and EMVCo polling and ease the RF configuration of each polling loop, two independent sets of RF configuration data can be stored in EEPROM. This allows to optimize each polling loop to meet individual RF requirements.

The PN7220 product family supports highly innovative and unique features which do not require any host controller interaction. These features include dynamic power control (DPC), adaptive waveform control (AWC), and fully automatic EMD error handling.

Additional documents supporting a design-in of the are available from NXP, this additional design-in information is not part of this document.

In this document, the term "MIFARE card" refers to a contactless card with an embedded MIFARE IC.



## 2 Features and benefits

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### 2.1 RF functionality

#### 2.1.1 ISO/IEC14443-A

- Reader/writer mode supporting ISO/IEC 14443-A R/W up to 848 kbit/s

#### 2.1.2 ISO/IEC 14443-B

- Reader/writer mode supporting ISO/IEC 14443-B up to 848 kbit/s

#### 2.1.3 FeliCa

- Reader/writer mode supporting FeliCa 212 kbit/s and 424 kbit/s (without crypto)

#### 2.1.4 Tag type reading

- Supports reading of all NFC tag types ( type 2, type 3, type 4A and type 4B, type 5 )

#### 2.1.5 MIFARE card reading

- Reader/writer communication mode for the MIFARE card family including MIFARE Classic Crypto supporting MIFARE Classic en-/decryption is integrated in hardware

#### 2.1.6 ISO/IEC 15693

- Reader/writer mode supporting ISO/IEC 15693 (ICODE)
  - RX: "Manchester" encoding with 424 kHz single-subcarrier (SSC) and 6.6 kBd
  - RX: "Manchester" encoding with 424 kHz single-subcarrier (SSC) and 26 kBd
  - RX: "Manchester" encoding with 424 kHz single-subcarrier (SSC) and 53 kBd
  - TX: "1 of 4" encoding with 10 % modulation (53 kBd)
  - TX: "1 of 4" encoding with 100 % modulation (53 kBd).

#### 2.1.7 NFC Forum compliancy

- NFC Forum version 13 compliance for R/W – analog and digital

#### 2.1.8 EMVCo contactless compliancy

- Contactless EMVCo 3.1 compliance for R/W – digital
- Contactless EMVCo 3.1 compliance for R/W analog can be achieved, but depends on connected antenna geometry and size, matching network and RF settings.

### 2.1.9 Host interface

The devices PN7220 and PN7221 support one host interface using a single interface connection based on a I<sup>2</sup>C interface host interface (host interface 1) with data rates up to 3.4 Mbit/s.

In addition, the device support two host interfaces using one interface connection based on a I<sup>2</sup>C interface (host interface 2) up to 3.4Mbit/s and one SPI interface (host interface 1) up to 15Mbit/s.

The logical interface layer of the host interfaces is based on the NCI 2.2 interface specification, enhanced by NXP proprietary commands.

## 2.2 Transmitter

- Transmitter with high RF output power of 2.0 W
- Dynamic power control 2.0 (DPC) (dynamic power control without processing load on host MCU)
- Adaptive waveshaping control (AWC)

## 2.3 Receiver

- Robust receiver: Automatic configuration, advanced insensitivity against TFT display noise for higher RF performance

## 2.4 Integrated polling loop

- RF polling loop according to NFC Forum
- RF Polling loop according to EMVCo 3.1, integrated EMVCo L1 software stack

## 2.5 Integrated DC-DC

The PN7220 implements an integrated DC-DC which can be used to supply the transmitter. Since the supply voltage of the transmitter LDO can be up to 6.0 Volts, this simplifies the design of the power supply.

A single supply concept for the RF system, for example, with single 3.3 V supply, is possible and allows making use of the maximum RF output power by providing a maximum transmitter supply voltage.

The integrated DC-DC is used by the dynamic power control (DPC) to reduce the maximum power dissipation of the chip.

The usage of the DC-DC is optional.

For applications making use of the low-power card detection, the DC-DC is available.

## 2.6 RF debugging support

- RF debugging without external probing of test signals possible by sampling debug data into chip-internal memory based on pre-define trigger conditions – ideal debugging solution for PCI-compliant POS terminals
- One digital and one analog debug signal is provided by the chip for connection of an oscilloscope

## 2.7 ISO7816 contact interface

The product supports the connection of up to three TDA8035 ICs which is the default EEPROM configuration of the device.

The device features an integrated EMVCo L1 contact card activation, and is compliant with contactless EMVCO specification 3.x.

The contact interface can be used for a single or dual host configuration.

### 3 Applications

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- Payment terminals following the COTS security requirements with full EMVCo3.1 analog and digital compliancy
- Multi-Application terminals
- Ticket validators for the controlling staff in public transport
- E-Vehicle charging stations
- Vending machines

## 4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DD(VBAT)}$	supply voltage on pin VBAT (analog and digital supply)	$V_{BAT} \geq V_{DDIO}$	2.4	-	5.5	V
$V_{DD(VDDIO)}$	supply voltage on pin VDDIO (supply for host interface and GPIOs)	1.8 V supply	1.62	-	1.98	V
		3.3 V supply	2.4	-	3.6	V
$V_{DD(VDDPA)}$	supply voltage on pin VDDPA (input of the transmitter power amplifier)	PN7220 - supply with VDDPA from internal VDDPALDO with DC-DC	1.5	-	5.7	V
$I_{pd}$	power down current	$V_{DD(VDDPA)} = V_{DD(VDDIO)} = V_{DD(VDD)} = 3.0\text{ V}$ ; hard power down state; pin VEN set LOW, $T_{amb} = 25\text{ }^{\circ}\text{C}$ , External supply by VDDIO	-	40	105	$\mu\text{A}$
$I_{stb}$	standby current	$T_{amb} = 25\text{ }^{\circ}\text{C}$	-	45	110	$\mu\text{A}$
$I_{DD(VDDPA)}$	supply current on pin VDDPA	supplied via VUP_TX (TX_LDO active)	-	-	350	mA
		supplied without DC-DC and TXLDO active	-	-	400	mA
$P_{(PA)}$	transmitter output power	supplied via VUP_TX (TX_LDO active)	-	-	2.0	W
		supplied without DC-DC and TXLDO active	-	-	2.3	W
$T_{amb}$	ambient operating temperature	in still air with exposed pins soldered on a 4 layer JEDEC PCB,	-40	-	+85	$^{\circ}\text{C}$
$T_{amb}$	ambient operating temperature	in still air with exposed pins soldered on a 4 layer JEDEC PCB,	-40	-	+85	$^{\circ}\text{C}$
		in still air with exposed pins soldered on a 4 layer JEDEC PCB, TX current = 120 mA @ VDDPA = 3.6 V	-40	-	+105	$^{\circ}\text{C}$
$T_{stg}$	storage temperature	no supply voltage applied	-55	-	+150	$^{\circ}\text{C}$
$T_{j\_max}$	maximum junction temperature	-	-	-	+125	$^{\circ}\text{C}$

## 5 Firmware versions

### Firmware version 1.00

- Android reads out this firmware version as 03.01.00
- Available on chip for PN7220 and PN7221

#### *Functionality of Firmware 1.00*

- HOST interface:
  - Single CPU configuration (HIF\_SEL0 pulled to '0')
  - HIF1-I2C interface
- Mode switch GPIO handling to either start in NFC Forum mode or EMVCo mode.
- EMVCo polling for Type A, Type B, Type F, and VAS (PN7221 only).
- NFC Forum polling for Type A, Type B, Type F, Type V, and VAS (PN7221 only) in Reader Mode.
- Proprietary commands:
  - NCI\_PROPRIETARY\_ACT\_CMD/RSP
  - WTX\_NTF
  - EMVCo Collision Error NTF
  - TEST\_PRBS\_CMD/RSP
  - REG\_TEST\_API\_CMD/RSP
  - CTS Support
  - SWITCH\_RF\_FIELD\_CMD/RSP
  - EEPROM\_ACCESS\_CMD/RSP
  - LOAD\_PROTOCOL\_CMD/RSP

### Firmware version 2.01

- Android reads out this firmware version as 03.02.01
- Available on chip for PN7220 and PN7221
- This version cannot be replaced by lower firmware versions. For example replacing FW2.01 by FW1.00 is not possible.

#### *New functionality of firmware version 2.01 compared to firmware version 1.00:*

- HOST interface
  - Dual CPU configuration (HIF\_SEL0 pulled to '1')
  - HIF2-I2C interface in NFC Forum mode (Mode Select pulled to '0')
  - HIF1-SPI Interface in EMVCo Mode (Mode Select pulled to '1')
- Mode switch GPIO handling to either start in NFC Forum mode or EMVCo mode in Dual CPU mode.
- NFC Forum polling for Type A (T4AT) in Listen mode.
- Contact support for maximum of three slots. One slot can be configured as Dynamic EMVCo slot.
- Proprietary commands
  - RAW\_EXCHANGE\_CMD/RSP

## 6 Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
PN7220EV/C100K	VFBGA64	Plastic thin fine-pitch ball grid array package; 64 balls, body 4.5 x 4.5 x 0.9 mm, delivered in 5 trays, MSL = 3. Minimum order quantity = 5 x 490 pcs The ending "K" in the product name is indicating the packing "multiple tray"; 12NC (order number) ending - 557 Version for connection to 1 host microcontroller Initialized with firmware version 1.00	SOT1307-2
PN7220EV/C100Y	VFBGA64	Plastic thin fine-pitch ball grid array package; 64 balls, body 4.5 x 4.5 x 0.9 mm, delivered on reel 13", MSL = 3. Minimum order quantity = 4000 pcs The ending Y in the product name is indicating the packing "reel"; 12NC (order number) ending - 518 Version for connection to 1 host microcontroller Initialized with firmware version 1.00	SOT1307-2
PN7221EV/C100K	VFBGA64	Plastic thin fine-pitch ball grid array package; 64 balls, body 4.5 x 4.5 x 0.9 mm, delivered in 5 trays, MSL = 3. Minimum order quantity = 5 x 490 pcs The ending "K" in the product name is indicating the packing "multiple tray"; 12NC (order number) ending - 557 Version for connection to 1 host microcontroller and ECP - Initialized with firmware version 1.00	SOT1307-2
PN7221EV/C100Y	VFBGA64	Plastic thin fine-pitch ball grid array package; 64 balls, body 4.5 x 4.5 x 0.9 mm, delivered on reel 13", MSL = 3. Minimum order quantity = 4000 pcs The ending Y in the product name is indicating the packing "reel"; 12NC (order number) ending - 518 Version for connection to 1 host microcontroller and ECP - Initialized with firmware version 1.00	SOT1307-2
PN7220EV/C101K	VFBGA64	Plastic thin fine-pitch ball grid array package; 64 balls, body 4.5 x 4.5 x 0.9 mm, delivered in 5 trays, MSL = 3. Minimum order quantity = 5 x 490 pcs The ending "K" in the product name is indicating the packing "multiple tray"; 12NC (order number) ending - 557 Version for connection to 1 or 2 host microcontroller Initialized with firmware version 2.01	SOT1307-2
PN7220EV/C101Y	VFBGA64	Plastic thin fine-pitch ball grid array package; 64 balls, body 4.5 x 4.5 x 0.9 mm, delivered on reel 13", MSL = 3. Minimum order quantity = 4000 pcs The ending Y in the product name is indicating the packing "reel"; 12NC (order number) ending - 518 Version for connection to 1 or 2 host microcontroller Initialized with firmware version 2.01	SOT1307-2



Table 2. Ordering information...continued

Type number	Package		
	Name	Description	Version
PN7221EV/C101K	VFBGA64	Plastic thin fine-pitch ball grid array package; 64 balls, body 4.5 x 4.5 x 0.9 mm, delivered in 5 trays, MSL = 3. Minimum order quantity = 5 x 490 pcs The ending "K" in the product name is indicating the packing "multiple tray"; 12NC (order number) ending - 557 Version for connection to 1 or 2 host microcontroller and ECP - Initialized with firmware version 2.01	SOT1307-2
PN7221EV/C101Y	VFBGA64	Plastic thin fine-pitch ball grid array package; 64 balls, body 4.5 x 4.5 x 0.9 mm, delivered on reel 13", MSL = 3. Minimum order quantity = 4000 pcs The ending Y in the product name is indicating the packing "reel"; 12NC (order number) ending - 518 Version for connection to 1 or 2 host microcontroller and ECP - Initialized with firmware version 2.01	SOT1307-2

7 Block diagram

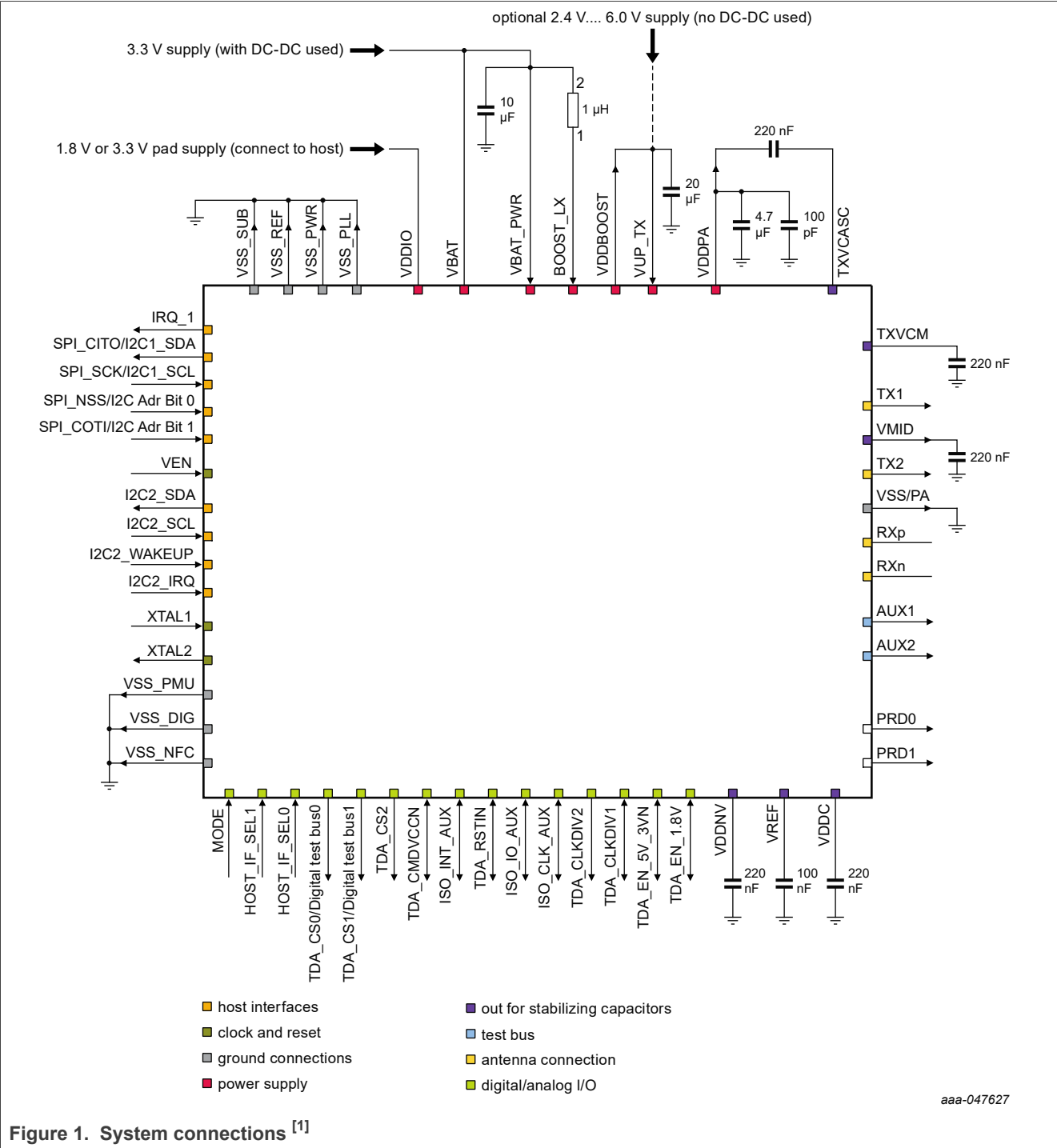


Figure 1. System connections [1]

[1] The replacement of "MOSI/MISO" to "COTI/CITO" in this document follows the recommendation of the NXP - I<sup>2</sup>C standards organization.

The PN7220 is connected to an application processor / host CPU based on an NCI interface.

The device offers high compatibility to existing solutions which offer an NCI interface (Host IF\_1). The physical interface used for the connection is a I2C interface.

Host IF\_1 allows I<sup>2</sup>C data rates up to 3.4 Mbit/s.

*I<sup>2</sup>C address:*

The PN7220 host interface 1 supports the 7-bit addressing mode, first 5-bits are fixed and is decimal 40, last two bits are configurable using ADDR0 and ADDR1 pins . This provides maximum flexibility even in cases where the I<sup>2</sup>C bus is shared with other devices on top of the PN7220.

*Default mode after boot:*

The system is always booting in mode (EMVCo polling or NFC Forum polling) defined by the level on the pin MODE/GPIO2.

*Switching between NFC Forum and EMVCo polling:*

Switching to a EMVCo polling loop is done based on a physical signal "MODE/GPIO2" controlled by the application processor / host CPU. All previous data from earlier communications are erased, and the NCI software stack is being reset. The system enters then the new EMVCo polling mode. Switching back to NFC Forum mode again clears all previous data from earlier communication and resets the NCI software stack.

8 Pinning information

8.1 Pin description VFBGA64

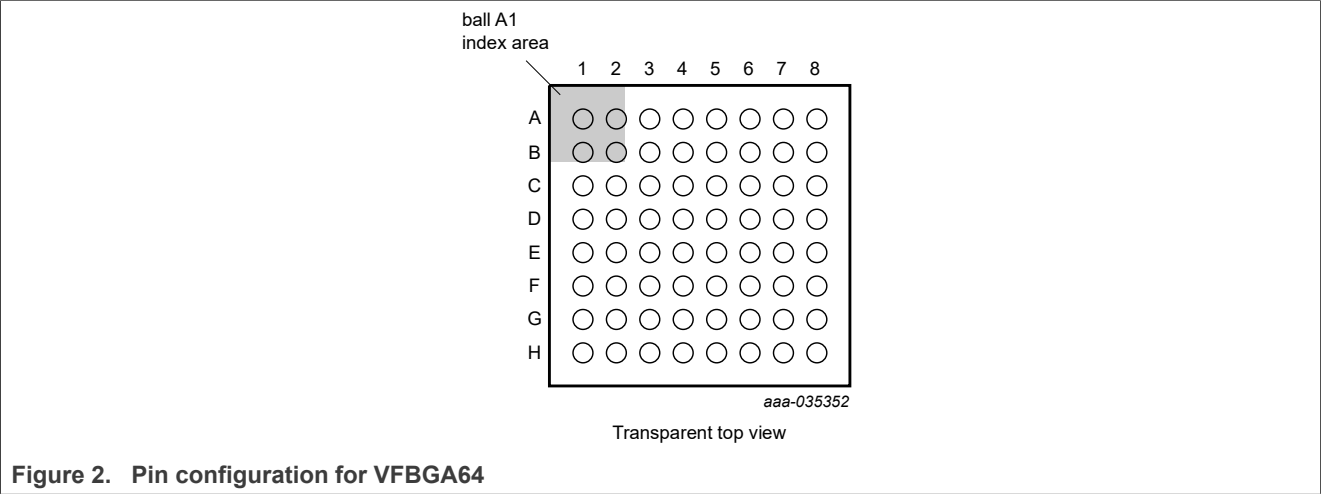


Figure 2. Pin configuration for VFBGA64

Table 3. Pin description VFBGA64

Pin Number	Symbol <sup>[1]</sup>	Type	Description <sup>[1]</sup>
<b>Host Interface 1 (I<sup>2</sup>C / SPI)</b>			
E6	SPI CITO / I2C1_ SDA	Output	One CPU system: I <sup>2</sup> C1_ SDA
			Two CPU system: SPI CITO
E5	SPI SCK / I2C1_ SCL	Input	One CPU system: I <sup>2</sup> C1_ SCL
			Two CPU system: SPI SCK
D6	SPI NSS / I2C1 Adr Bit 0	Input	One CPU System: I <sup>2</sup> C Adr Bit 0 (Address is configured using 5 fixed bits (40d - 028h) and 2 Bits from D5/D6) I <sup>2</sup> C interface address can be configured to 0x28 (00), 0x29 (01), 0x2A (10), 0x2B (11) based on D6 and D5 Pins
			Two CPU system: SPI NSS
D5	SPI COTI / I2C1 Adr Bit 1	Input	One CPU system: I <sup>2</sup> C Adr Bit 1 ((Address is configured using 5 fixed bits (40d - 028h) and 2 Bits from D5/D6) I <sup>2</sup> C interface address can be configured to 0x28 (00), 0x29 (01), 0x2A (10), 0x2B (11) based on D6 and D5 Pins
			Two CPU system: SPI COTI
B7	IRQ1	Output	Host communication IF1 / event interrupt signal

## NFC controller with NCI interface supporting EMV and NFC Forum applications

Table 3. Pin description VFBGA64...continued

Pin Number	Symbol <sup>[1]</sup>	Type	Description <sup>[1]</sup>
<b>Host Interface 2 (I2C)</b>			
A6	I2C2_SDA	Input/Output	One CPU system: n.c. Two CPU system: I <sup>2</sup> C 2 SDA
B6	I2C2_SCL	Input	One CPU system: n.c. Two CPU system: I <sup>2</sup> C 2 SCL
D7	I2C2_WAKEUP	Input	one CPU system: GND Two CPU system: Standby wakeup signal
H8	I2C2_IRQ	Output	One CPU system: n.c. Two CPU system: Host communication interface 2 event interrupt signal
<b>Hardware reset</b>			
B3	VEN	Input	Hardware reset, low active (independent from V <sub>VDDIO</sub> )
<b>Host interface and Mode selection</b>			
E7	MODE	Input	Mode selection (EMVCo or NFC Forum polling loop) Input H: EMVCo polling mode Input L: NFC Forum polling mode Input defines always EMVCo or NFC Forum polling loop, but the used host interface is different dependent on the configuration of C7: C7= Level L at boot (1 CPU system): NFC Forum and EMVCo polling loop data transfer is done always using host interface 1 C7 = Level H at boot (2 CPU system): NFC Forum polling loop is doing data transfer using host interface 2 and EMVCo polling loop is doing data transfer using host interface 1
C6	HOST_IF_SEL1	Input	Shall always be on GND on PN7220
C7	HOST_IF_SEL0	Input	Host interface select 0 - selection of 1 or 2 CPU system Level L: Host Interface 1 active after boot (I2C Host Interface 2 has no function) Level H: Host Interface 2 is always active after boot, SPI Interface 1 is active only after selecting EMVCo mode on E7 - MODE/GPIO2 HIF_SEL0 pin is read by FW after POR or reset via VEN or boot from low-power mode (OFF, standby, LPCD etc.).
<b>Xtal connection</b>			
F8	XTAL1	Input	Crystal / system clock input
G8	XTAL2	Output	Clock output (amplifier-inverted signal output) for crystal
<b>Supply pins</b>			
H2	VSS_PA	Supply GND	Transmitter ground
G3	VSS_PLL	Supply GND	PLL ground (low noise)
A2	VSS_PWR	Supply GND	DC-DC boost ground
D3	VSS_REF	Supply GND	PMU ground
B2, E3	VSS_SUB	Supply GND	Substrate ground

Table 3. Pin description VFBGA64...continued

Pin Number	Symbol <sup>[1]</sup>	Type	Description <sup>[1]</sup>
C3	VSS_PMU	Supply GND	PMU ground
F4	VSS_DIG	Supply GND	Digital ground
F3	VSS_NFC	Supply GND	NFC ground
E1	VBAT	Supply	System supply, used to supply the analog and digital blocks, memory and internal voltage references
A8	VDDIO	Supply	I/O pads power supply
G1	VDDPA	Supply	Transmitter supply
F1	VUP_TX	Supply	Input supply voltage for transmitter LDO
B1	VDDBOOST	Supply	DC-DC boost supply
A1	BOOST_LX	Output	Boost inductance loopback, to be connected to boost inductor
A3	VBATPWR	Supply	To be connected to boost inductor and transmitter power supply
<b>Outputs for stabilizing cap</b>			
A4	VDDNV	Output	Nonvolatile memory power supply, to be connected to ground via 220 nF blocking cap
D2	VREF	Output	High quiescent reference voltage, to be connected to ground via 100 nF blocking cap
C1	VDDC	Output	Power supply for Digital Core, to be connected to ground via 220 nF blocking cap
G2	TXVCM	Output	Transmitter voltage common mode, to be connected to ground via 220 nF blocking cap
F2	TXVCASC	Output	TX decoupling cap, to be connected to VDDPA
H6	VMID	Output	Stabilizing capacitor connection output, to be connected to electrical symmetry point of antenna (typically antenna ground) by 100 nF blocking cap
<b>RF Debug signals</b>			
G7	AUX_1	Output	Test bus 1
F7	AUX_2	Output	Test bus 2
<b>Antenna connections</b>			
H5	RXP	Input	Receiver input "Positive"
H4	RXN	Input	Receiver input "Negative"
H1	TX1	Output	Antenna driver output 1
H3	TX2	Output	Antenna driver output 2
<b>Analog/Digital inputs and outputs</b>			
E8	TDA_CS0 / GPIO0	Output	Digital test bus0 / TDA chip select 0
D8	TDA_CS1 / GPIO1	Output	Digital test bus1 / TDA chip select 1

Table 3. Pin description VFBGA64...continued

Pin Number	Symbol <sup>[1]</sup>	Type	Description <sup>[1]</sup>
<b>Security feature</b>			
B4	PRD1	Input/ Output	Package removal detection, internally connected to PRD2
G4	PRD2	Input/ Output	Package removal detection, internally connected to PRD1
<b>TDA8035 interface</b>			
A7	TDA_CS2	Output	TDA chip select 2 (TDA_CS2) <b>Note:</b> Pulldown resistor required. EEPROM configuration to configure as TDA_CS. Default is TDA_CS = disabled.
B5	TDA_CMDVCCN / GPIO5	Input/Output	TDA_CMDVCCN
C4	ISO_INT_AUX	Input/Output	Auxiliary Card Interrupt: <b>In case no TDA is connected, connection to GND is mandatory</b>
C5	TDA_RSTIN / GPIO4	Input/Output	TDA_RSTIN
D4	ISO_IO_AUX	Input/Output	Auxiliary Card I/O
E4	ISO_CLK_AUX	Input	Auxiliary Card Clock
F5	TDA_CLKDIV2 / SPIM_COTI	Input	TDA_CLKDIV2
F6	TDA_CLKDIV1 / SPIM_CITO	Input / Output	TDA_CLKDIV1
G5	SPIM_SCLK / TDA_EN_5V_3V	Input / Output	TDA_EN5V_3V
G6	SPIM_SSN / TDA_EN_1.8V	Input / Output	TDA_EN_1.8V
<b>Pins not to be connected</b>			
A5	PVDD_OUT	Output	Do not connect
B8	SWDIO	Input/Output	Do not connect
C2	TEST	Input/Output	Do not connect.
C8	SWD_CLK	Input	Do not connect
D1	USB_VBUS	Supply	Do not connect
E2	AD1	Input	Do not connect
H7	VTUNE1	Output	Do not connect

[1] The replacement of "MOSI/MISO" to "COTI/CITO" in this document follows the recommendation of the NXP - I2C standards organization.

For good RF performance, all blocking capacitors shall be placed on the same side of the PCB. Traces from pin to capacitor shall be as short as possible.

All supply GND connections shall be connected by low-ohmic connections on the PCB.

**"Do not connect" means: No connection to power supply or GND.**

## 9 Functional description

PN7220 can be connected to a host controller through the physical host interface - a pulldown resistor is required.

The logical interface toward the host controller is NCI 2.2-compliant Ref. [2] with additional commands for NXP-specific product features.

The device implements a contactless EMVCo3.1 compliant polling loop and allows to be compliant to contactless EMVCo L1 digital.

The EEPROM configuration allows to configure the device to support up to three contact interfaces using a TDA8035 for interfacing to ISO7816 compliant cards.

ISO7816 contact card activation is supported by the device.

Enhanced RF debugging and easy configuration are supported by usage of the SPI interface, analog and digital debug outputs (AUX) and the CLIF test station.

### 9.1 Functional overview

The PN7220 is an NFC controller with high transmitter output power. It implements the RF functionality like an antenna driving and receiver circuitry and the functionality to realize an NFC Forum and EMVCo compliant reader.

#### Connection to host controller

Two host connection options do exist for this product:

1. Connection to one single host - this is typically one host running an Android operating system
2. Connection to two hosts - in this case one host is typically a security CPU connected by the SPI interface to meet PCI compliance requirements for an EMVCo payment subsystem, and the second host connected by an I2C interface which is typically used to run an Android operating system for all non-EMVCo payment related applications.

For NFC data exchange a high-level NCI 2.2 protocol implementation extended by proprietary commands is available.

For the two host system which makes use of two host interfaces, the switching of the polling loops is switching the physical interfaces. The system is always booting up in the non-EMVCo mode using the I2C interface. The SPI interface connecting the security CPU is disabled at this time. Switching to EMVCo mode disables the I2C interface completely, and activates the SPI interface which is connected e.g. to a security microcontroller. Effectively, the NFC Forum polling loop data transfer is linked to the I2C interface, and the EMVCo polling loop data transfer is linked to the SPI interface.

The processing of the NCI commands had been improved on the PN7220 compared to previous NFC reader generations with NCI interface which eases the meeting of EMVCo timing requirements.

#### Integrated NFC Forum polling loop

All supported RF technologies can be independently enabled within this PCD polling loop. The sequence of RF technologies within the PCD polling loop cannot be modified.



### Integrated EMVCo3.1 L1 polling loop

The PN7220 implements an integrated EMVCo3.1 PCD-compliant polling loop. The polling loop can be configured to poll as well for FeliCa compliant cards following the EMVCo specification for “other technologies”. Alternatively, the device can be configured to poll for FeliCa cards exclusively. In addition, the PN7221 allows to configure the ECP. The firmware of the device had been optimized for low latency which helps to achieve the EMVCo timing requirements even with Android-based host systems.

### Selection of a dedicated polling loop: NFC Forum or EMVCo

The selection of a dedicated polling loop is done based on a hardware input MODE.

After reset, the polling loop which can be activated depends on the MODE selection. It can be either EMVCo or NFC Forum compliant polling.

Switching the polling loop from one mode to the other is done by changing the level of the MODE input pin. Switching from NFC Forum polling mode to the EMVCo polling mode resets the NCI stack, clears all data in the buffers, performs an RF reset and allows then to activate the polling according to EMVCo 3.1. Switching back to the NFC Forum polling mode, again reset resets the NCI stack, performs an RF reset, clears all data in the buffers and is ready to receive NCI Interface commands to activate NFC Forum polling.

In addition to the selection of the polling loop, the MODE input activates a dedicated user defined set of RF configuration parameters. With this, a different RF behaviour for EMVCo and NFC Forum can be realized.

This switching of modes based on an external mode pin is working faster than alternative solutions based on loading configuration files, and allows a more secure implementation of the software on the host MCU.

### Contact interface

The product allows to connect up to 3 TDA8035 which offer the possibility for an ISO7816 contact interface connection.

### Clock supply

The PN7220 uses an external 27.12 MHz crystal as clock source for generating the RF field and its internal digital logic. Alternatively, an internal PLL allows using an accurate external clock source of either 24 MHz, 32 MHz, and 48 MHz (configured in EEPROM register CLK\_INPUT\_FREQ, 0012h)). This allows saving the 27.12 MHz crystal in systems which implement one of the mentioned clock frequencies. For EMVCo compliant applications and best RF performance, the usage of a 27.12MHz crystal is recommended.

### Integrated DC-DC

The DC-DC is a step-up converter and is able to deliver an output voltage from approx. 2.8 V up to 6.0 V. The targeted output voltage can be configured by software. It allows a single supply voltage (for example, 3.3 V) while delivering maximum RF output power. Dependent on the application target either a direct transmitter supply or a transmitter supply by the integrated DC-DC can be chosen. The DC-DC is controlled by the Dynamic Power Control 2.0 to keep the power dissipation of the chip minimized in antenna loading cases which require a reduction of the RF output power.

### Transmitter LDO (TX\_LDO)

The Transmitter output drivers are supplied by a transmitter LDO which reduces external noise and is used for the DPC functionality to lower the supply voltage of the transmitters. The high granularity of 100 mV for setting the TX\_LDO output voltage together with a sophisticated control loop and true current measurement ensures that a DPC regulation is not accidentally treated as received data.

### Low-power card detection

The low-power card detection (LPCD) allows saving battery charge during polling for NFC counterparts like cards and mobile phones. In general, the low-power card detection provides a functionality, which allows to power down the reader for a certain amount of time to save energy. After some time, the reader becomes active again to poll for cards. If no card is detected, the reader can go back to the power down state. During the polling time, a host controller can be set to a power-saving mode. An interrupt request from the PN7220 allows waking up the host controller in case an antenna detuning by a card or cell phone had been detected.

### Dynamic power control 2.0

The next generation Dynamic Power Control (DPC2.0) with true transmitter current measurement works autonomous without host interaction. Avoiding additional host controller processing load is important for time critical applications like payment. A fast control response time of less than 1 ms allows using optimized antenna matchings.

### Adaptive wave shape control

The Adaptive Wave Shape Control (AWC) helps to keep the waveshapes within specification limits, even in case of antenna detuning. This simplifies the time-consuming antenna matching procedure and does not require any matching compromises to be taken.

### Receiver signal level control

The receiver signal chain consists of an automatic controller RF input attenuator and a true Baseband Amplifier (BBA). This feature delivers an outstanding communication range with tags, labels, cards, and mobile phones.

### RF Debugging

Comprehensive and innovative debug features are implemented to support the NFC reader development even for difficult and non-standard compliant cards and mobile phones. An integrated contactless test station allows performing a non-intrusive debugging of receiver signals without the need of connecting additional wires to the chip. Capturing of chip-internal signals is done by configuring flexible trigger conditions, sampled internal data is stored in RAM memory, transferred by SPI to a host microcontroller and visualized on a PC by the NFC Cockpit development tool. A virtual comfort interface (VCOM) is supported by the NFC cockpit tool, which allows to use the NFC cockpit together with any host microcontroller. Analog and digital debug signals (AUX1, AUX2) are available as well and allow the connection of an Oscilloscope for analog and digital signal debugging.

The receiver signal processing is optimized to cope with noisy environments. This is beneficial, especially in case a TFT display or DC-DCs are part of the NFC system design.

### Automatic EMD error handling

An automatic EMD handling performed without host interaction relaxes the timing requirements on the host controller. Automatic EMD error handling according to ISO/IEC14443 and EMVCo 3.0 is supported. In addition, the EMD error handling is widely configurable, which allows adaptations in case of future possible specification changes.

### Firmware update

The PN7220 supports a secure update of the implemented firmware. In Secure Firmware update mode, the PN7220 requires no dedicated physical handling of the SPI interface lines. The firmware download does not require any additional hardware pin to be handled, instead the download mode is activated by a command, followed by a hardware reset. After booting from reset, the PN7220 will be in download mode.

### EEPROM configuration

Non-Volatile EEPROM memory of the PN7220 is used to store configuration data that must be preserved in case the PN7220 is not connected to any supply voltage. The configuration for dedicated RF protocols and antenna-dependent configuration is defined in this non-volatile memory as well as other configuration data which must be preserved during power supply disconnect is stored in this EEPROM memory. Examples for these are settings for receiver sensitivity, DPC, waveshaping, LPCD, and power supply configurations.

### RF configuration

The PN7220 allows an automatic RF protocol selection based on the actual polling loop state. Pre-defined user configuration data is stored in non-volatile memory (EEPROM) and is automatically loaded for the modulation scheme currently activated by the polling loop.

Two dedicated configuration sets do exist for the RF configuration: One defining the settings in case the EMVCo polling loop is active, and another one on case the NFC Forum polling loop is active. Activating a dedicated polling loop automatically causes the related RF configuration to be loaded from the non-volatile memory. There is no need to load configuration files like it is required by other products supporting the NCI interface.

The loading of the RF configuration to the non-volatile memory is typically done only once during production.

**Note:** *Frequent automatic reloading of the RF configuration in the application is not recommended, since the number of possible configuration updates (EEPROM programming cycles) is technically limited. The device allows to store data which requires a frequent update in the application in registers / RAM.*

## 9.2 NCI interface

The functionality of the NCI interface is described in the user manual and the NCI 2.2 Interface standard.

9.3 Byte and bit order

The byte and bit order describes the order of bytes or bits within a binary representation of a value in the memory, which can be a register or EEPROM.

"Array size" defines the number of elements of "type size". Type size can be uint8 (8 bit), uint16 (16 bit) or uint32 (32 bit).

The location of byte-sized data (8 bit) with an array size of 2 is as follows:

- Value hex: 0x1234
- address x: 12
- address x+1: 34

The location of word-sized data (16 bit) is as follows:

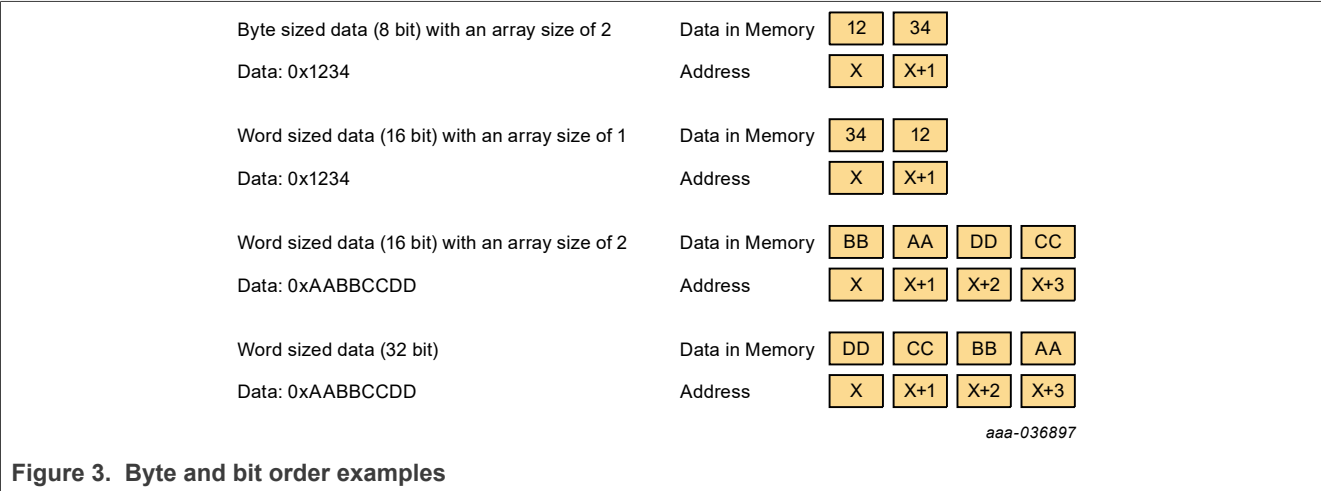
- Value hex: 0x1234
- address x: 34
- address x+1: 12

The location of word-sized data (16 bit) in an array size of 2 is as follows:

- The placement of the array is large endian, the placement of nibbles of the variable is small endian.
- Value hex: 0xAABBCCDD
- address x: BB
- address x+1: AA
- address x+2: DD
- address x+3: CC

The location of double word-sized data (32 bit) is as follows:

- Value hex: 0xAABBCCDD
- address x: DD
- address x+1: CC
- address x+2: BB
- address x+3: AA



Data from the EEPROM is read in little-endian format - LSB first. This means that the byte at the lower address is read first.

The PN7220 is a little-endian system. This means that the byte at the lower address is read first.

9.4
Initial calibration

The PN7220 requires a calibration before the RF field is switched on for the first time with unloaded condition. "Unloaded" means: Without any additional metal in proximity of the antenna, except for the NFC reader components itself.

During development of new readers, this calibration shall be done each time the antenna design, antenna matching, or EMC filter is modified.

The calibration sequence is the following:

Write EEPROM CfgNovCal – 0x00

Write REGISTER TX\_NOV\_CALIBRATE\_AND\_STORE\_VAL - 0x01

Write EEPROM CfgNovCal – 0x02

9.5
System power states

The PN7220 can operate in different power states. The functionality and current consumption is dependent on the actual system power state.

Power states can be changed by the level on the pin VEN and by connecting/disconnecting the power supply of VBAT. Power state change will also be triggered by certain events - VDDIO Loss, overcurrent detection, overtemperature.

In addition, state changes are triggered possible by host commands.

Disconnecting and connecting the power supply on VBAT restarts the PN7220 always in Active State after releasing the pin VEN (transition low to high).

A transition of low to high on pin VEN restarts the PN7220 always in Active State.

[Table 4](#) lists the supported power states.

Table 4. PN7220 power states

Power state	Description	Typical current consumption
Power off	The NFC system (supply pin VBAT, RF transmitter) is not supplied by a battery/system PMU. Other domains might be supplied (for example, I/O pad interface on pin VDDIO). Device is not functional	-
PMU off	The NFC system is disabled by the host via a low signal on pin VEN. No internal clocks of the PN7220 are active. Entry to PMU OFF can also be triggered by power loss on VDDIO. Wake-up events to change PMU OFF state: Power reset on pin VBAT, VEN rising edge, VDDIO restore.	5 $\mu$ A
ULP standby	Not supported	-

Table 4. PN7220 power states...continued

Power state	Description	Typical current consumption
Standby	The NFC system can switch after a specific time of inactivity automatically into a low-power mode to minimize power dissipation. The state of external interfaces is maintained properly. PMU operates in low-power state. Wake-up counter clock is available. PCRM is supplied and running in low-power mode. I/Os are supplied by VDDC_LP. PMU FSM in PCRM manages the transition in power state. Wake-up sources: Activity on host IF, SWPM communication, LPDET, wake-up counter, power loss on VDDIO, GPIO, RxPROT, No High Temp on TX and so on.	45 $\mu$ A
Active	The PN7220 is able to process internal or external events or data. All external power supply sources and the external clock must be available, and all internal clocks are active.	20 mA (system without RF current)

9.6 Power supply

The device allows to configure different power supply options for the transmitter power amplifier. To make use of them, a combination of external connections and chip internal configurations must be done. The following supply options are available:

- Internal VDDPA configuration: The TX power amplifier is supplied by the internal voltage regulator (TX\_LDO). In this configuration the DPC, current measurement and overcurrent protection is available. In addition, the TX\_LDO is adding an improved rejection of noise on the supply lines.
- Direct VDDPA configuration: This configuration is recommended for applications which require highest efficiency, like battery supplied devices. In this configuration, a battery can be connected directly to the transmitter supply avoiding the voltage drop of approximately 0.3 V caused by the TX\_LDO. A clean supply voltage without noise is required to achieve a good RF performance. In this configuration the DPC, current measurement and overcurrent protection is not available.

9.6.1 System power supply overview

The PN7220 is using three different supplies each for the following functional blocks:

1. Supply for the host interface and GPIOs (VDDIO)
2. Supply for the analog and digital blocks (VBAT/VBAT\_PWR)
3. Supply of the RF drivers (VDDPA), DC-DC (VBAT\_PWR), and TX\_LDO (VUP)

The functionality of the GPIOs, host interface and internal analog and digital blocks is independent from the supply of the RF driver. This allows to configure a dedicated transmitter supply configuration at any time. Care shall be taken to switch on the RF field only after the transmitter-related power supply had been configured according to the external physical supply connections (VDDPA, VBAT\_PWR, VUP).

The power supply configuration is configured in EEPROM and therefore will not get lost in case of power supply loss or reset of the chip. Typically, this configuration is only performed once during the production of a reader.

RF field shall not be turned on without setting the correct power supply configuration in the EEPROM.

**Note:** The Voltage on pin VDDIO must always be smaller or equal to the Voltage on pin VBAT.

### 9.6.2 Connecting blocking capacitors

Some pins are connected to blocking supply capacitors. PCB traces to these capacitors must be as short as possible, and a low-ohmic grounding of the GND-side of the capacitors is required for optimized RF performance.

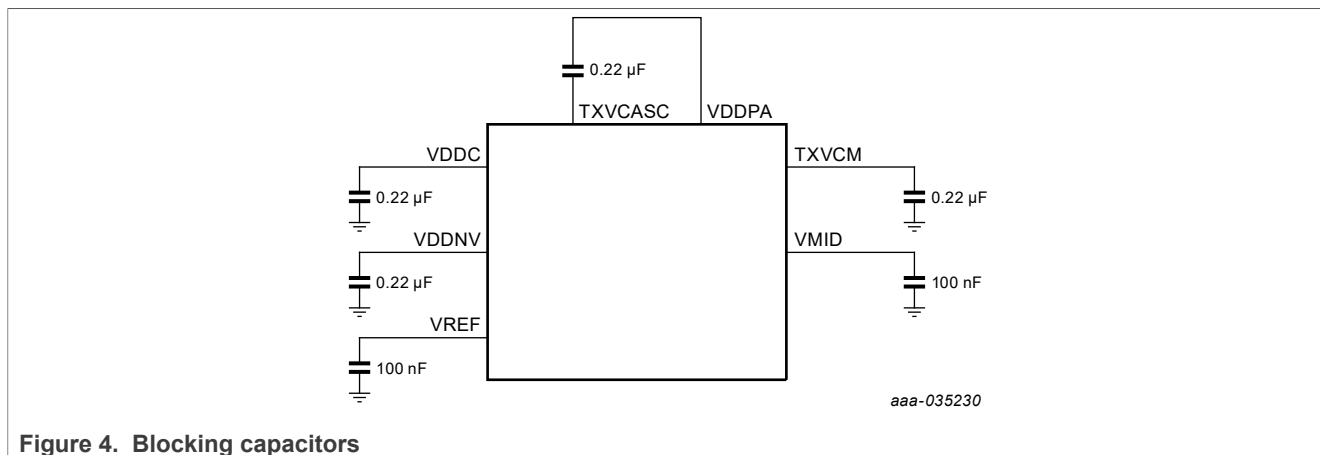


Figure 4. Blocking capacitors

### 9.6.3 Transmitter power supply

The PN7220 is configured by EEPROM for the different power supply options.

The following EEPROM Addresses are used to configure the power supply of the transmitter:

DCDC\_PWR\_CONFIG (0000h) - Enables/disables and configures the DC-DC according to the external supply connections.

TX\_LDO\_CONFIG (address 0002h) - Enables/disables and configures the TX\_LDO.

TX\_LDO\_VDDPA\_HIGH (address 0006h) - initial out voltage when DPC is used.

TX\_LDO\_VDDPA\_LOW (address 0007h) - lowest VDDPA when DPC is used.

TX\_LDO\_VDDPA\_MAX\_RDR (address 0008h) - maximum voltage to be set in reader mode used by DPC.

TX\_LDO\_VDDPA\_MAX\_CARD (address 0009h) - VDDPA maximum voltage to be set in card mode used by DPC.

No specific registers are required to configure the pad supply (VDDIO) or the supply for the analog and digital blocks (VUP).

### 9.6.3.1 TX\_LDO transmitter supply

TX\_LDO supplied VDDPA configuration: The TX power amplifier is supplied by the internal voltage regulator (TX\_LDO).

In this configuration the DPC, current measurement and overcurrent protection is available. In addition, the TX\_LDO is adding an improved rejection of noise on the supply lines.

A decoupling cap is required on VDDPA pin.

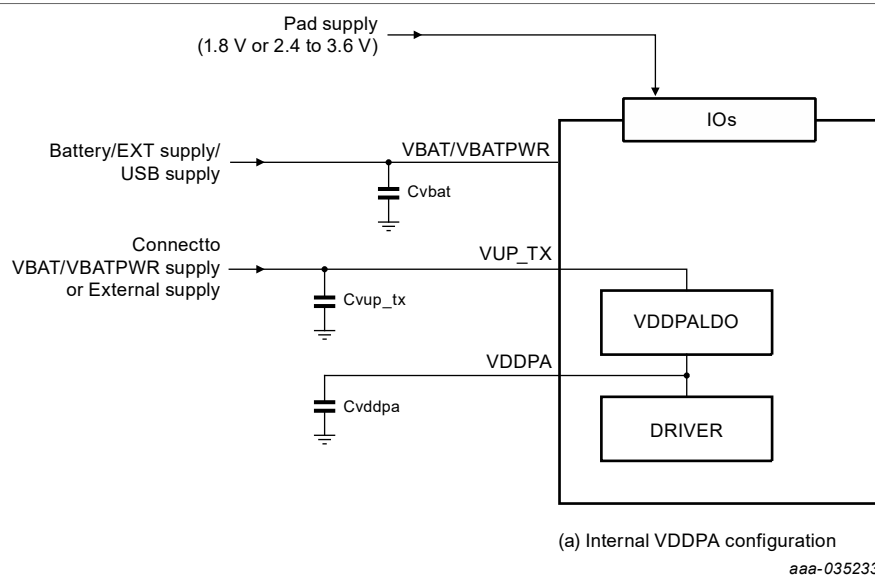


Figure 5. Transmitter supply



9.6.3.2 Direct transmitter supply

Direct VDDPA configuration:

TX\_LDO must be configured OFF by SW configuration. VUP\_TX and VDDPA connected to VBAT/VBATPWR.

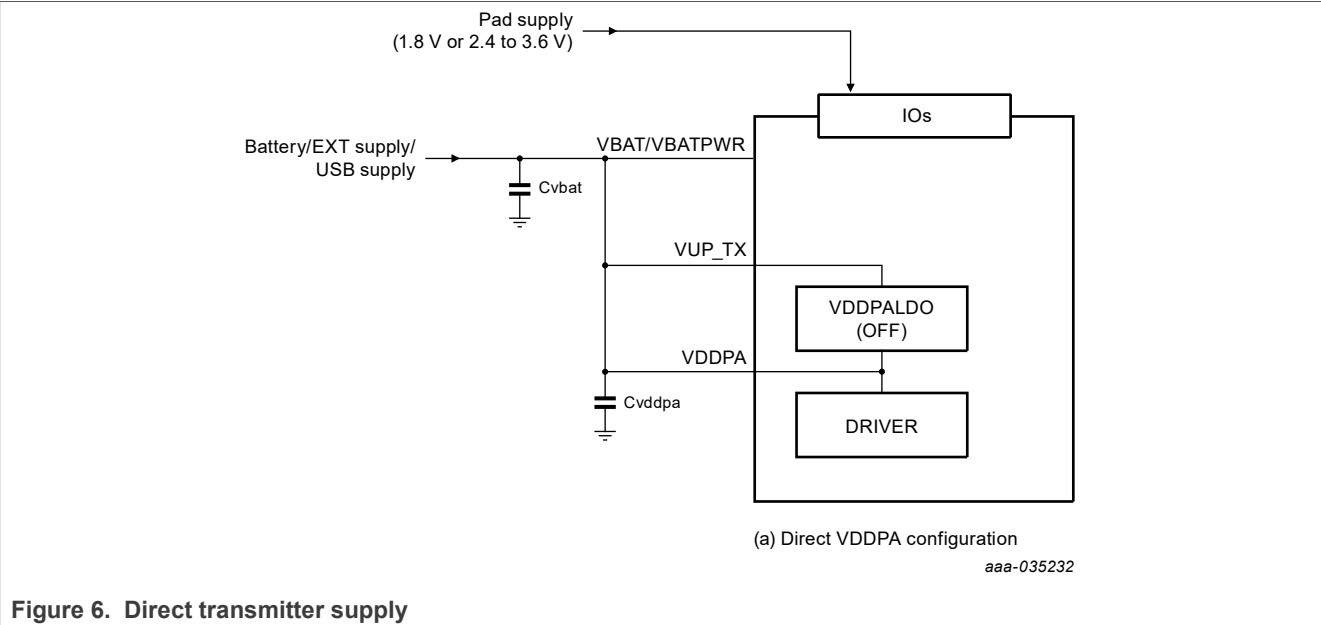


Figure 6. Direct transmitter supply

9.6.3.3 DC-DC (boost) supply

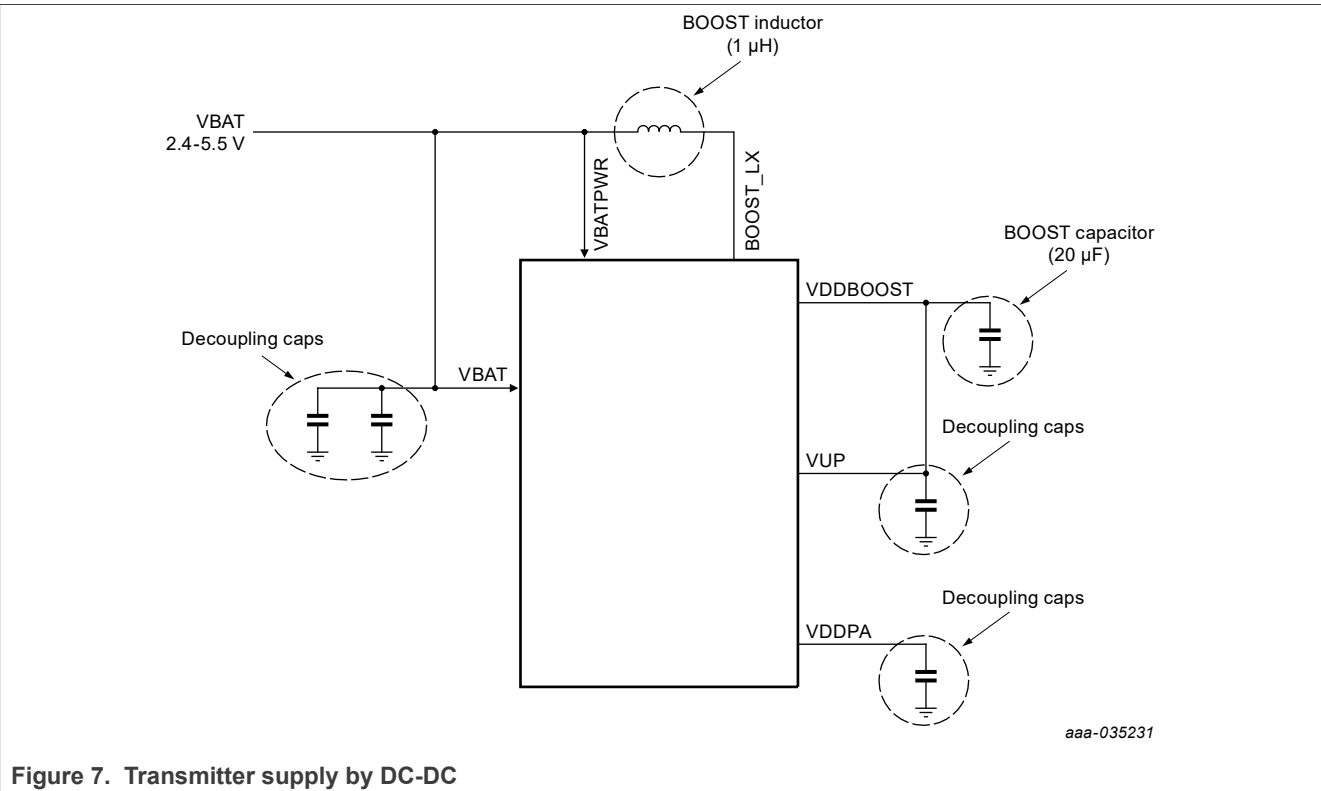
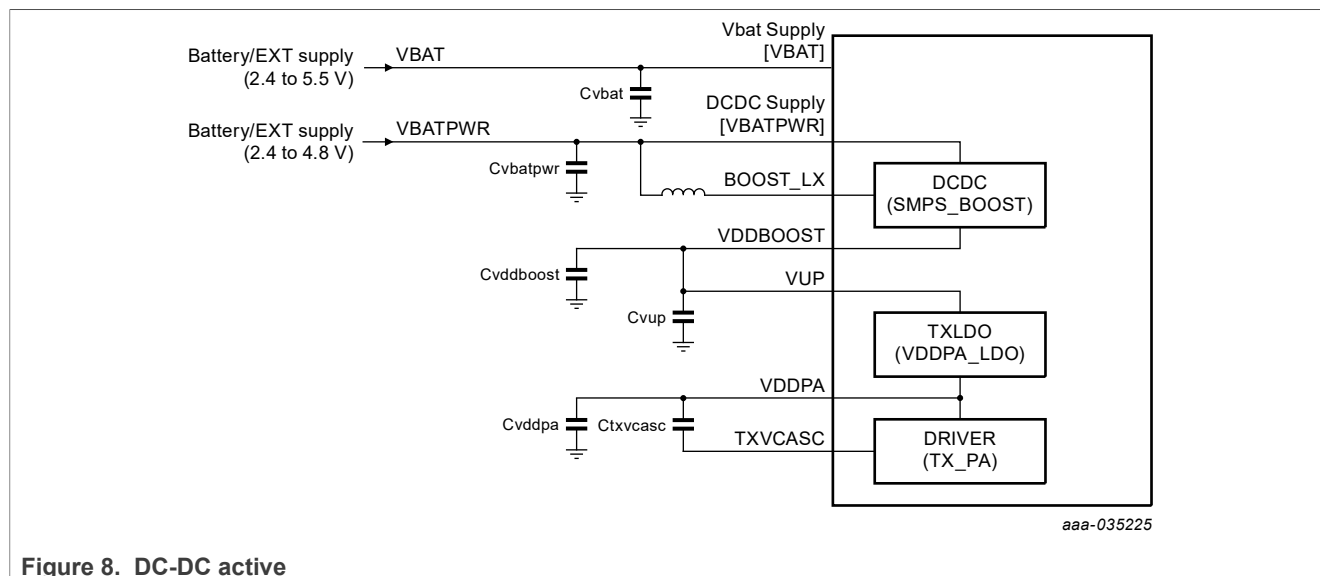


Figure 7. Transmitter supply by DC-DC

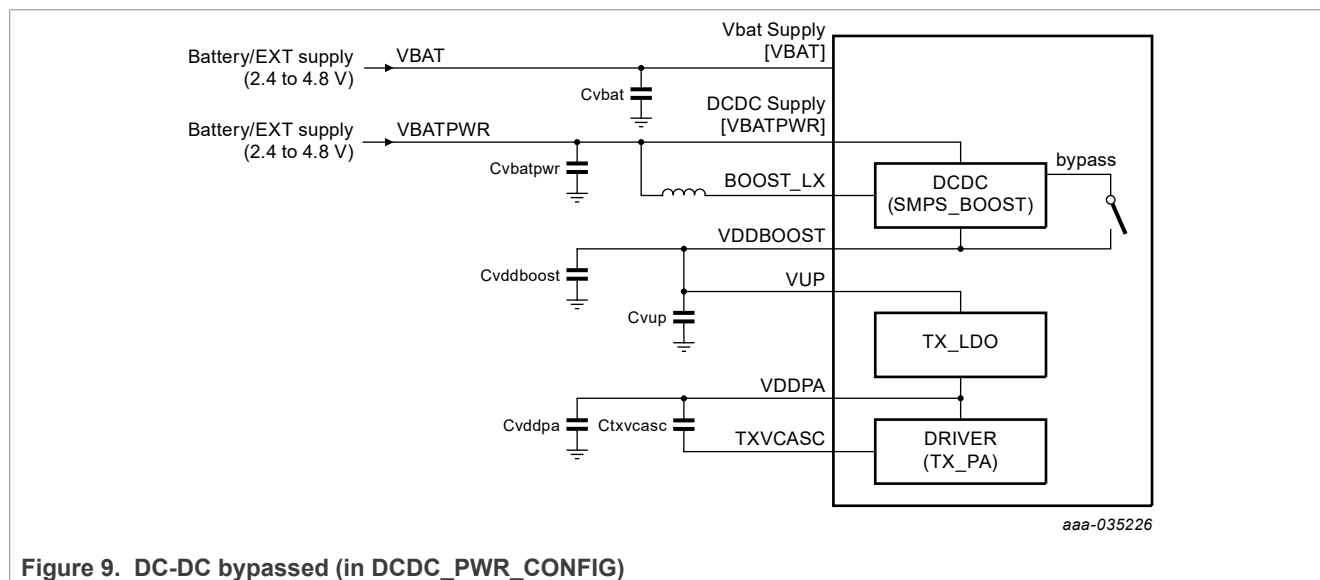
#### 9.6.3.4 Configuration example 1: TX\_LDO transmitter supply - DC-DC active

VBAT is connected to VBATPWR.



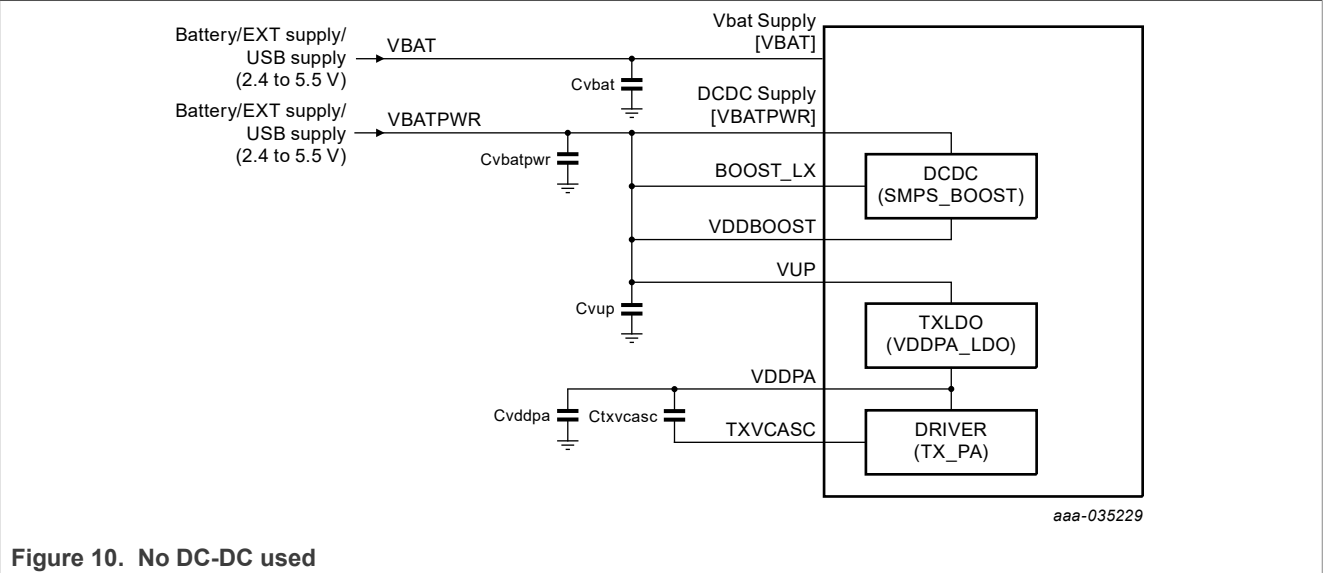
### 9.6.3.5 Configuration example 2: TX\_LDO transmitter supply - DC-DC bypassed

VBAT is connected to VBATPWR.



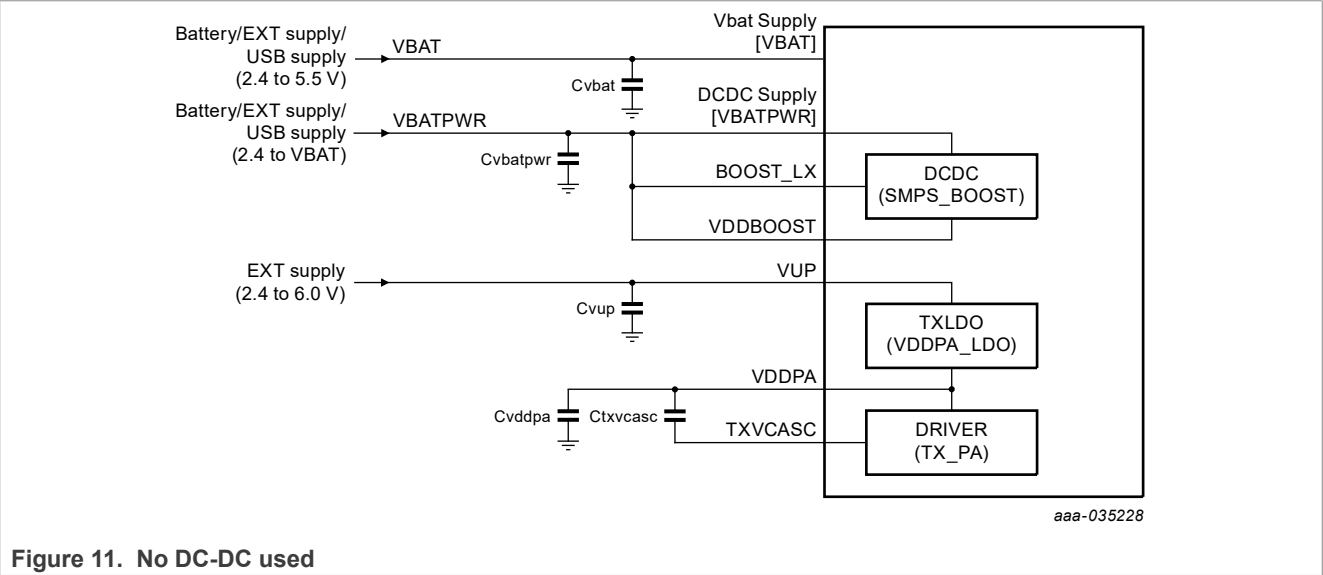
9.6.3.6 Configuration example 3: TX\_LDO transmitter supply connected to VBAT - no DC-DC

VBAT is connected to VBATPWR.



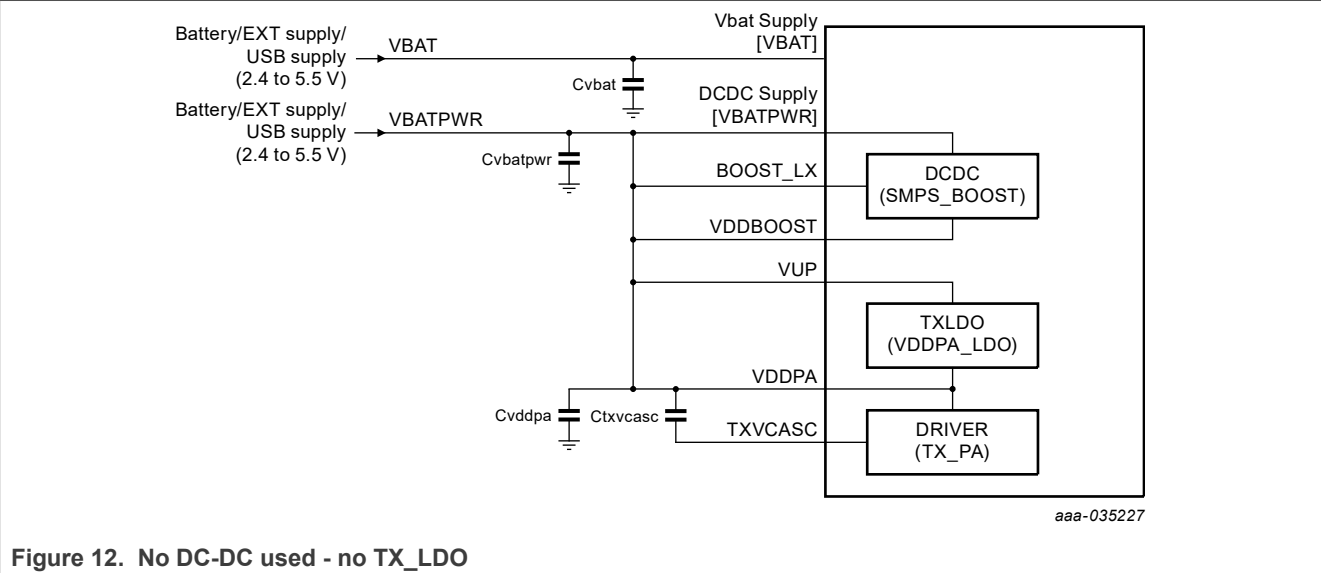
9.6.3.7 Configuration example 4: TX\_LDO supplied independent from VBAT - no DC-DC

VBAT is connected to VBATPWR.



9.6.3.8 Configuration example 5: TX\_LDO not used - no DC-DC

VBAT is connected to VBATPWR.



## 9.6.3.9 Supply voltage range for transmitter supply configuration examples

Table 5. Supply voltage range configuration

Supply	Config1: TX_LDO transmitter supply DC-DC active	Config2: TX_LDO transmitter supply DC-DC bypassed	Config3: TX_LDO transmitter supply connected to VBAT no DC-DC	Config4: TX_LDO supplied independent from VBAT no DC-DC	Config5: TX_LDO not used no DC-DC
EEPROM configuration for DPC ENABLED - configured in DPC_CONFIG (address 0076h)					
DCDC_ PWR_ CONFIG (address 0000h)	- 0xE4(Variable BOOST with Auto Bypass). - 0xE2(Fixed BOOST)	0xE4 (Variable BOOST with Auto Bypass)	0x01	0x01	NA
TXLDO_ VDDPA_ HIGH (0x06)	0x0 (1.5 V)	0x0(1.5 V)	0x0(1.5 V)	0x0(1.5 V)	NA
TXLDO_ VDDPA_ MAX_ RDR (0008h)	0x2A(5.7 V)	0x2A(5.7 V)	0x2A(5.7 V)	0x2A(5.7 V)	NA
BOOST_ DEFAULT_ VOLTAGE (000Ah)	0x1D (6 V).	NA	NA	NA	NA
EEPROM configuration - DPC DISABLED - configured in DPC_CONFIG (address 0076h)					
DCDC_ PWR_ CONFIG (address 0000h)	- 0xE4(Variable BOOST with Auto Bypass). - 0xE2(Fixed BOOST)	0xE4 (Variable BOOST with Auto Bypass)	0x21	0x21	0x00
TXLDO_ VDDPA_ HIGH (0x06)	0x0 (1.5 V)	0x0(1.5 V)	0x0(1.5 V)	0x0(1.5 V)	0x0(1.5 V)
TXLDO_ VDDPA_ MAX_ RDR (0008h)	NA	NA	NA	NA	NA
BOOST_ DEFAULT_ VOLTAGE (000Ah)	0x1D (6 V).	NA	NA	NA	NA

Table 6. Supply voltage range

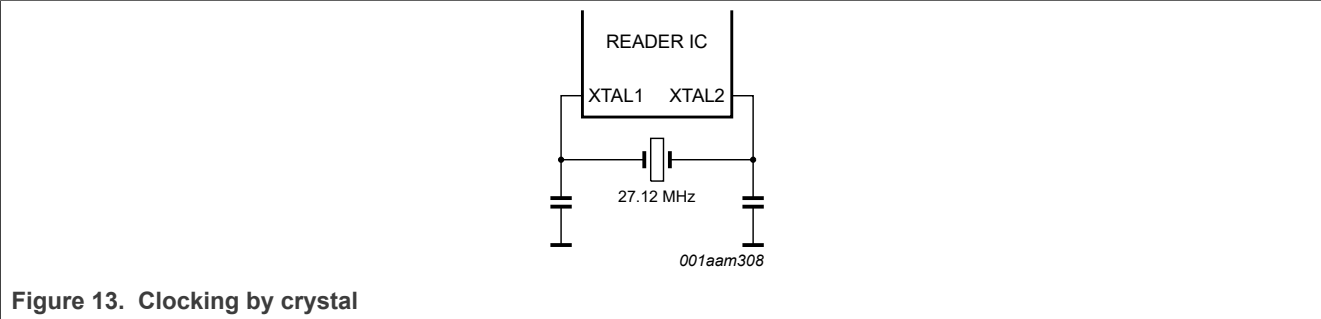
Supply	Config1: TX_LDO transmitter supply DC-DC active	Config2: TX_LDO transmitter supply DC-DC bypassed	Config3: TX_LDO transmitter supply connected to VBAT no DC-DC	Config4: TX_LDO supplied independent from VBAT no DC-DC	Config5: TX_LDO not used no DC-DC
VBAT	2.8 V ... 4.8 V	2.8 V ... 4.8 V	2.4 V ... 5.5 V	2.4 V ... 5.5 V	2.4 V ... 5.5 V
VBATPWR	2.8 V ... 4.8 V	2.8 V ... 4.8 V	2.4 V ... 5.5 V	2.4 V ... 5.5 V	2.4 V ... 5.5 V
VUP	3.1 V ... 6.0 V	2.8 V ... 6.0 V	2.4 V ... 6.0 V	2.4 V ... 6.0 V	2.4 V ... 5.5 V
VDDPA	VUP-0.3V drop of TX_LDO. max 5.7 V	VBATPWR - 0.5 V voltage drop	internally connected to TX_LDO	internally connected to TX_LDO	2.4 V ... 5.5 V

9.7 Clock generation

The device supports the operation with two clock options, which is configured in EEPROM address CLK\_INPUT\_FREQ (0012h).

One option is clocking by a crystal (default), the other a clocking by an external clock input frequency.

It is important to consider additional phase noise introduced, for example by clock drivers in the design. Phase noise of the external clock has an impact on the RF performance which can be achieved.



9.8 External interfaces

The PN7220 requires the connection of a power supply, and a clock source like crystal or external clock and a host microcontroller connected to at least one NCI host interface for operation.

Additional connections of the package require the connection of stabilizing capacitors and ground.

The RF interface connects transmitter and receiver to the EMC filter of a connected antenna matching network. Additional connections are available for the GPIOs (on PN7220 only outputs are implemented).

The device supports the connection of up to 3x TDA8035 contact reader ICs which allow to realize an ISO/IEC7816 compliant interfaces.

## 9.9 Transmitter overcurrent and temperature protection

The PN7220 implements different mechanisms to protect the chip against damage.

On the one hand, an overcurrent protection exists which shuts down the transmitter driver if there is a out of spec current. This can be enabled in EEPROM TXLDO\_CONFIG (0002h), bit 11: overcurrent enable (0: disable, 1: enable)

An NCI notification is used to indicate the shut-down of the transmitter driver to a connected host.

On the other hand, an internal temperature sensor allows to monitor the temperature of the chip. This is configured in the EEPROM TEMP\_WARNING (0648h). Three temperatures can be configured: 114 °C, 2:125 °C, 3:130 °C.

An NCI notification is used to indicate this temperature warning to a connected host.

The actual measured temperature is available in the register TEMP\_SENSOR (005Bh). The chip will go into standby immediately.

This is a safety feature only. A design shall not functionally rely on this feature since the operating conditions will be violated if the overcurrent detection becomes active.

## 9.10 Dynamic power control (DPC)

The DPC is used for a special antenna tuning, called "symmetric antenna tuning". For an "asymmetric antenna tuning", the DPC is not required.

However, even for "asymmetric antenna tuning" with high output power needs, it might turn out that the RF field is too strong near of the antenna to be compliant with ISO/IEC14443 requirements. In this case, the DPC can be used as well to reduce the RF output power dependent on the distance of the card from the reader antenna.

The DPC works very well with a tuning called "symmetric tuning". With symmetric tuning, a detuning of the antenna is causing a reduction of the antenna impedance. This low antenna impedance might lead to a current which is too high for the targeted application. The DPC allows to limit the transmitter current even under antenna detuning conditions.

DPC is useful:

- To achieve NFC Forum and ISO/IEC 14443 compliancy (e.g. NFC Forum Power Transfer Maximum, ISO/IEC 14443 Field Emission Maximum)
- To improve interoperability

The Dynamic Power Control (DPC 2.0) allows controlling the transmitter driver voltage in 100 mV steps dependent on the actual transmitter current.

A lookup table is used to configure the transmitter output voltage and by this control the RF output power.

**The DPC allows to define two different targets current and maximum VDDPA settings for the two available modes to address EMVCo and NFC-related requirements with the same antenna.**

Features of the Dynamic power control (DPC 2.0):

- True current measurement provides maximum information for the regulation loop
- The transmitter current can be limited and additionally reduced according to detected transmitter current condition / antenna detuning condition
- DPC works autonomously without host interaction causing no additional processing load on the host
- Fastest response time of 1 ms for regulation
- Used for adaptive waveshape control (AWC)
- Used for adaptive RX sensitivity control (ARC)

The DPC is able to operate in two modes:

1. Current limiting mode
2. Current limiting + Current reduction mode

The DPC is configured in the EEPROM, this configuration is used after startup. This avoids that the host must configure the chip after each reset or power off.

The following EEPROM registers are most relevant for the DPC configuration:

**DPC\_Config:** Enables/Disables the DPC (enable: 0x39, disable: 0x00)

**DPC\_TargetCurrent:** Unloaded VDDPA target current in mA, the target current +/- Hysteresis is limiting the current for the DPC.

- The DPC\_TargetCurrent is the current which can be measured for the selected antenna impedance and transmitter supply voltage in unloaded condition. This is the current the system is designed to operate at. For each of the modes - NFC Forum and EMVCo, one dedicated configuration does exist:

DPC\_TargetCurrent\_EMVCo

DPC\_TargetCurrent\_NFC

VDDPA\_max\_EMVCo

VDDPA\_max\_NFC

All other DPC-related settings are used for both modes.

**DPC\_Hysteresis:** Absolute difference to current target current in mA that triggers a DPC update event.

- The configuration of the hysteresis ensures, that the DPC is not regulating if small changes of the transmitter current occur due to external disturbances. A typical value for the DPC\_Hysteresis is e.g. 20 mA.

**DPC\_Lookup\_Table:** configures the current reduction

The DPC\_LOOKUP\_TABLE allows, in addition to the limitation of the current, to configure:

- an additional current reduction on top of the current limitation, achieved by further lowering the transmitter supply voltage
- a relative change of modulated amplitude level
- and a relative change of falling and raising edge time constant for ASK10 % and ASK100 % modulations

This lookup table is initialized with 0x00 for devices delivered from the factory. (The customer development board is already initialized with useful data in EEPROM which work well with the antenna of the board).

The 0x00 entry in the DPC\_LOOKUP\_TABLE means that no additional function then the current limitation takes place for the DPC.

In order to achieve a limitation of the current even in the case of an antenna impedance that is lowered, the Transmitter supply voltage is reduced accordingly.

This transmitter supply voltage reduction is now used as index for the DPC\_LOOKUP\_TABLE.



For a specific transmitter supply voltage, it is possible to further reduce the current below the value of DPC\_TargetCurrent or to configure parameters for waveshaping and modulation. All these entries are relative values, granularity of the entries dependent on the transmitter supply voltage is 0.1 V, resulting in 42 table entries.

The DPC updates the content of the following register dependent on the antenna load / lookup table configuration:

0x30 - DGRM\_RSSI

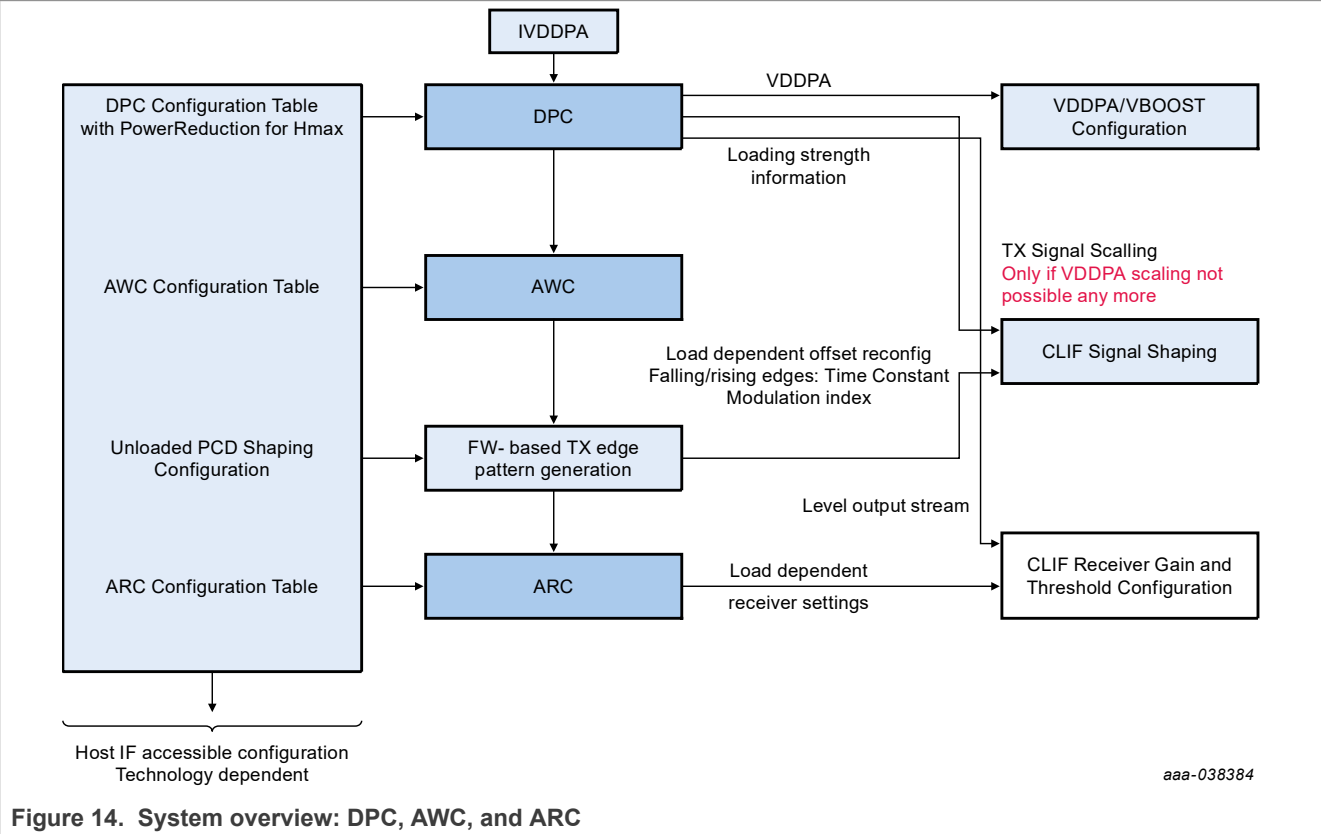


Figure 14. System overview: DPC, AWC, and ARC

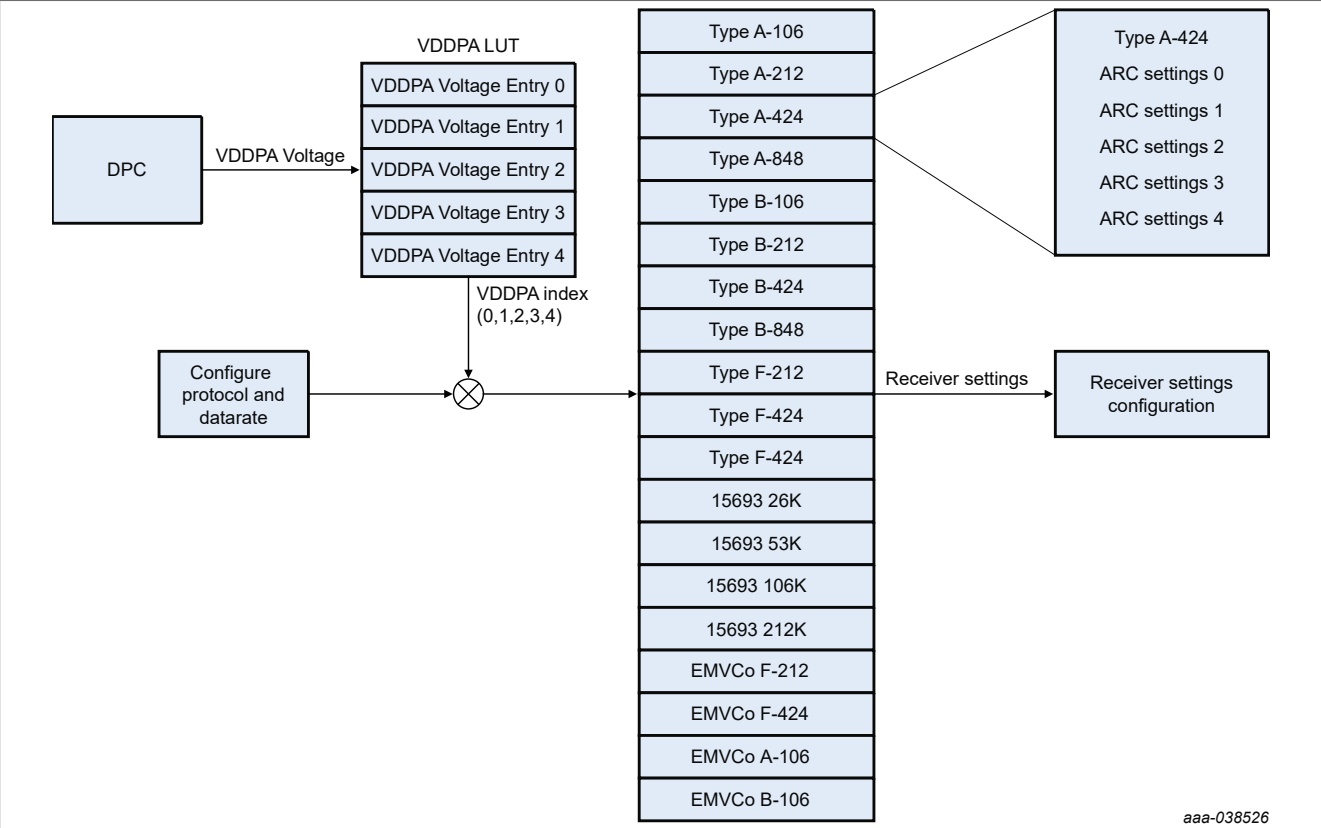


Figure 15. System overview: DPC, AWC, and ARC

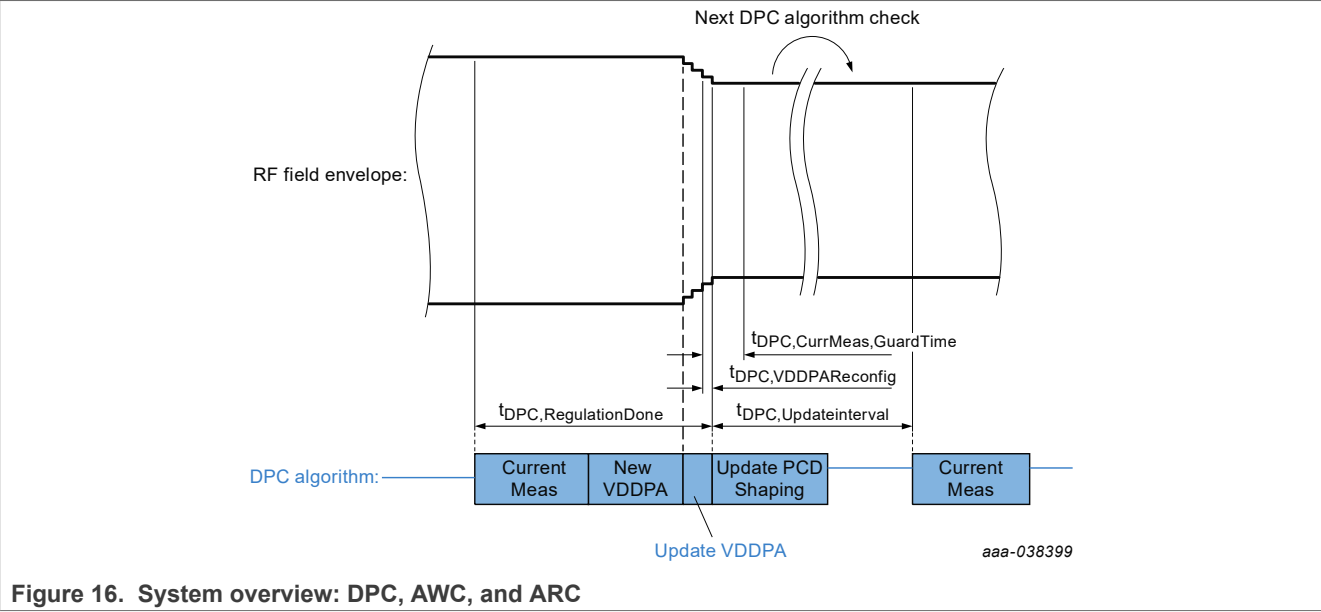


Figure 16. System overview: DPC, AWC, and ARC

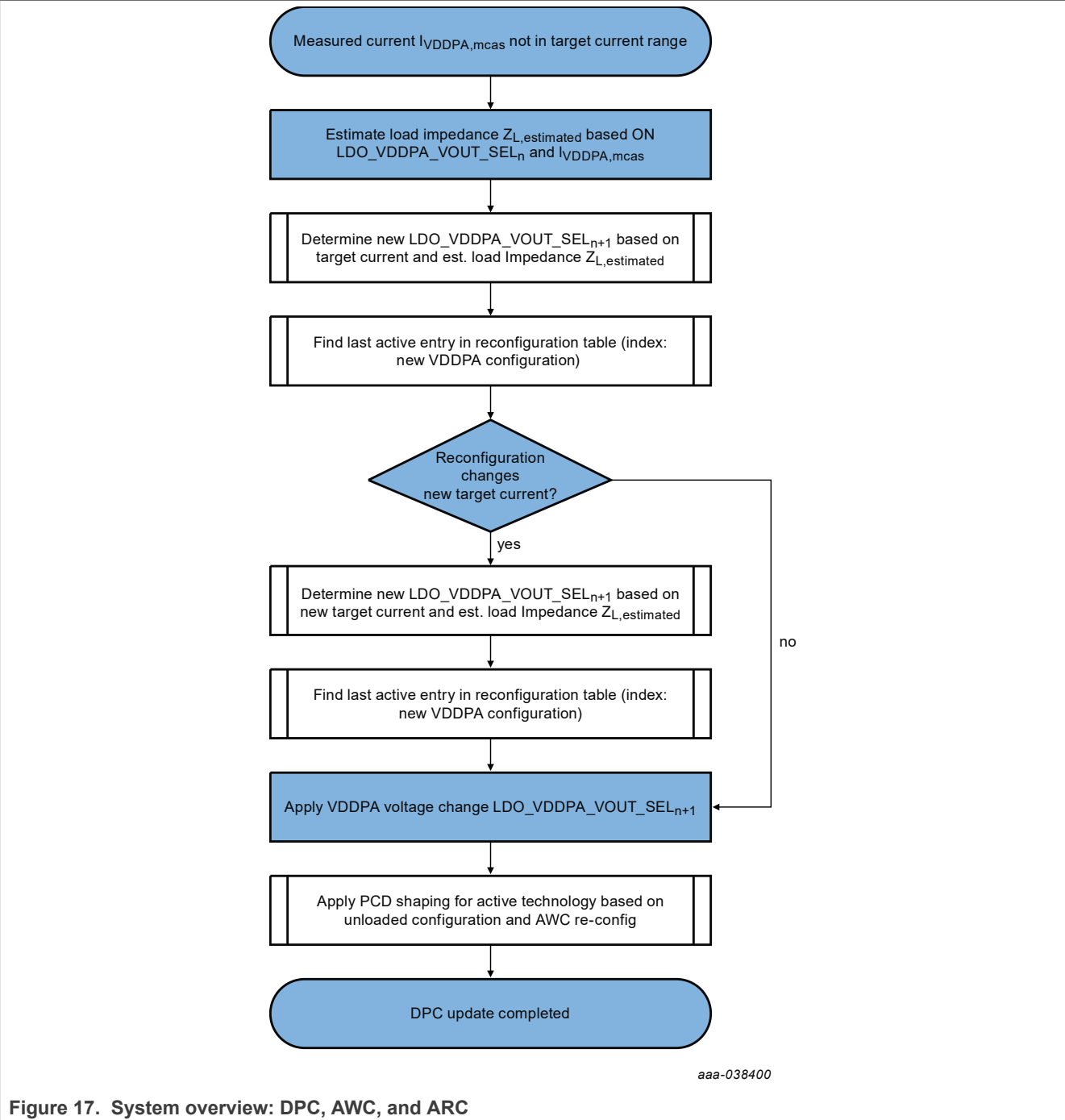


Figure 17. System overview: DPC, AWC, and ARC

### 9.10.1 DPC algorithm

The DPC algorithm is controlling the transmitter current. It is using the following states:

1. Current measurement: Performs VDDPA current measurement
2. New VDDPA: Determine new VDDPA configuration based on measured current  

$$\text{VDDPA New (for target current of } I_{\text{target}}) = \text{VDDPA Voltage} / \text{VDDPA current} * I_{\text{target}}$$
3. Update VDDPA: Perform output power update
4. Update PCD Shaping: Apply AWC configuration updates for active technology
5. Update RX sensitivity parameter only for short duration

Reconfiguration table includes Relative changes of target current and of waveform parameters adaption for all VDDPA voltage configurations. The VDDPA configuration is implicitly defined by the row index. The first row refers to LDO\_VDDPA\_VOUT\_SEL=0 (represents 1V5).

EXAMPLE:

Unloaded configuration After Field ON:

VDDPA max set to 42 (5.7 V) ·target current set to 280 mA

Technology B106: amp\_mod=200

Falling edge time constant=rising edge time constant=3

**Table 7. DPC\_LOOKUP\_TABLE element, defining the configuration for one dedicated VDDPA voltage**

Function	Bit	Description
ENTRY 0	31:0	This is the entry for 1.5 V.
Target current reduction	31:23	ENTRY 0 -LSB - byte 0 Voltage step between DPC entries = 100 mV. Voltage offset start = 1.5 V bEntry_00 = 1V5 ... bEntry_42 = 5V7 Bits[7:0] = Target current reduction in mA (unsigned)
AWC amp mod change	23:16	ENTRY 0 - byte 1 Bits[7:0] = Relative change of modulated amplitude level (signed)
AWC edge time constant for ASK100	15:8	ENTRY 0 - byte 2 Bits[3:0] = ASK100, Relative change of falling edge time constant (signed) Bits[7:4] = ASK100, Relative change of rising edge time constant (signed)
AWC falling edge time constant for ASK10	7:0	ENTRY 0 -MSB - byte 4 Bits[3:0] = ASK10, Relative change of falling edge time constant (signed) Bits[7:4] = ASK10, Relative change of rising edge time constant (signed)

Loaded configuration After Field ON:

DPC regulates from unloaded VDDPA configuration 42 to 31. Consequently, new configuration to be applied based on index entry 31.

Target current stays at 280 mA.

Technology B106: amp\_mod=205, falling edge time constant=2, rising edge time constant=0

## 9.11 Adaptive waveshaping control (AWC)

Depending on the level of detected detuning of the antenna, waveshaping related register settings can be automatically updated.

Two different waveshaping mechanisms can be used:

1. Firmware based shaping (1,2,3)
2. Lookup table based shaping (4,5,6)

The firmware based shaping allows to correct rise times and overshoot with linear transition shapes.

The lookup table based shaping allows maximum flexibility and enables to configure almost any possible correction.

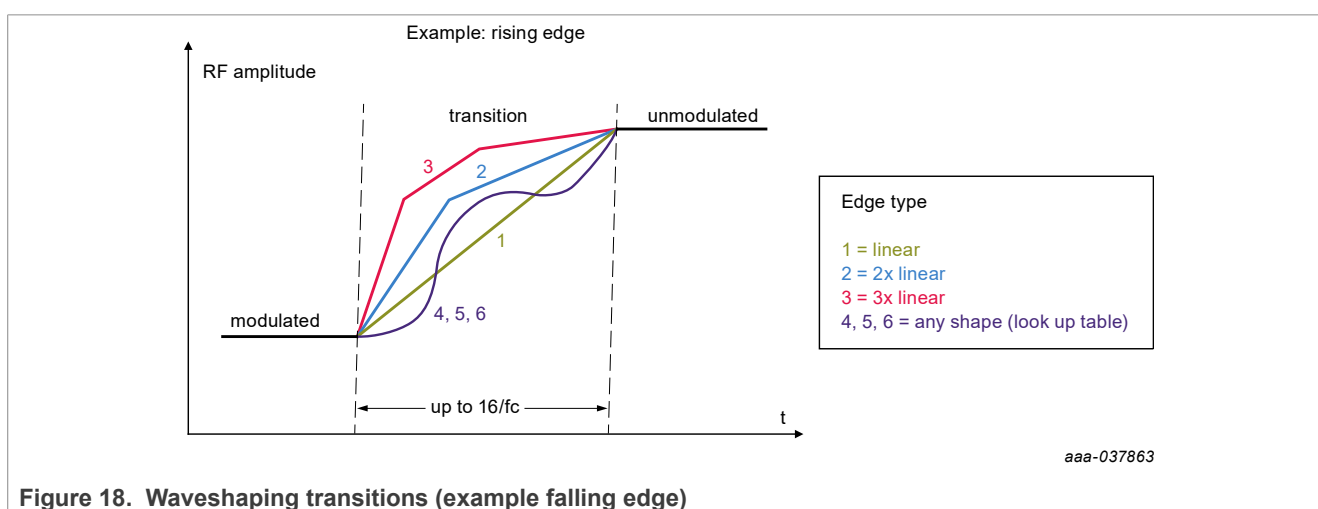


Figure 18. Waveshaping transitions (example falling edge)

The shaping related register settings are stored in a lookup table located in EEPROM, and selected dependent on the actual detected detuning condition.

Each lookup table entry allows the configuration not only of a dedicated waveshaping configuration for the corresponding detuning condition. But allows in addition to configure the waveshaping individually dependent on the actual protocol which is active.

Features of the Adaptive Waveshape Control:

- No external components required
- No need to compromise antenna matching to meet waveshape requirements
- Waveshapes automatically adapted according to detected detuning condition
- RF standards define envelope timing and residual carrier parameters required for compliance and interoperability.

The device supports the design of compliant antennas by allowing to actively shaping the style of edge transition for falling and rising edges. The shaping of modulation edges is achieved by selecting one from three edge transition styles:

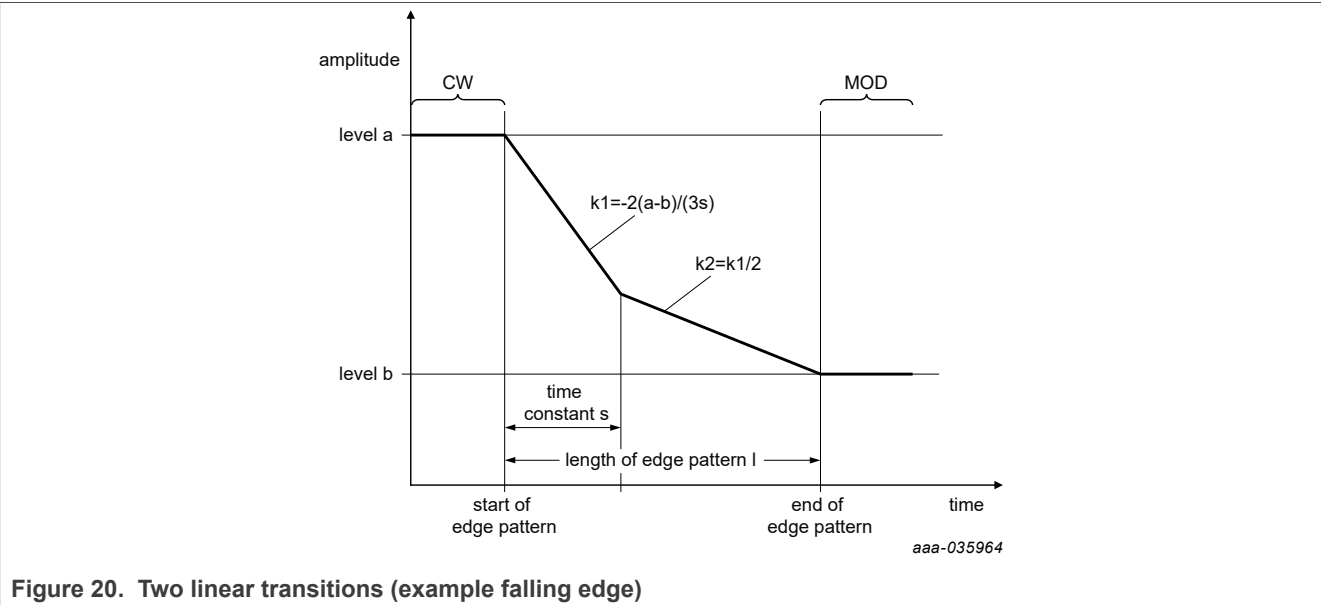
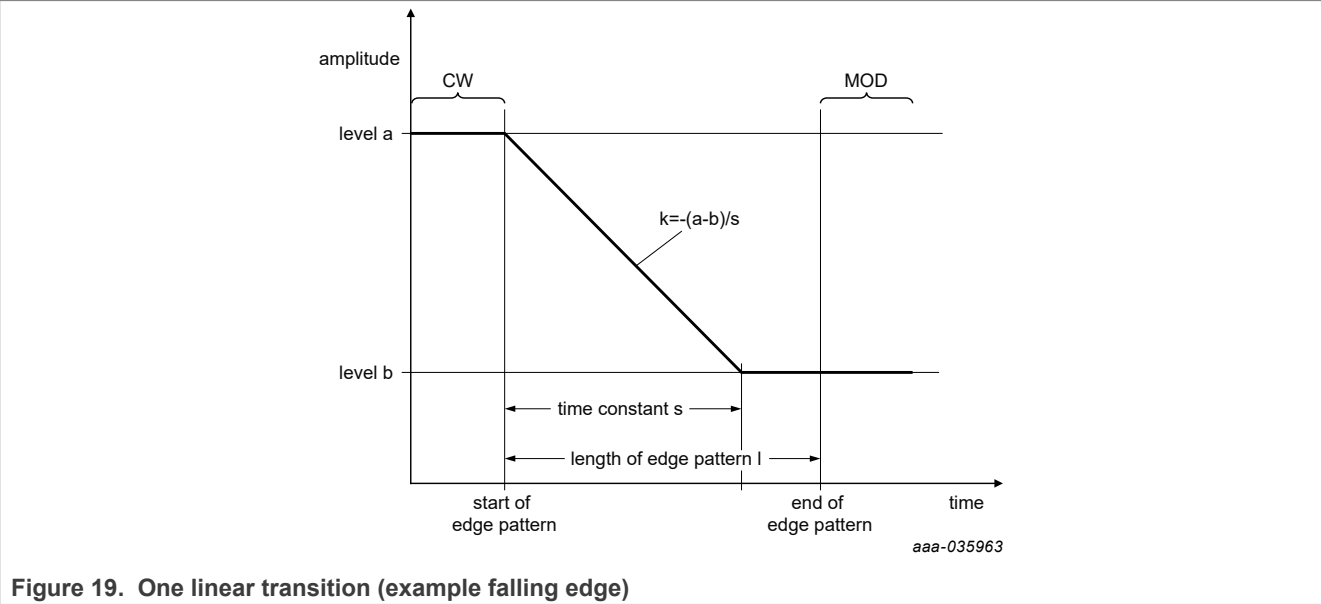
1. Linear transition between two amplitude levels
2. Two linear transitions between amplitude levels and
3. Three linear transitions between amplitude levels.

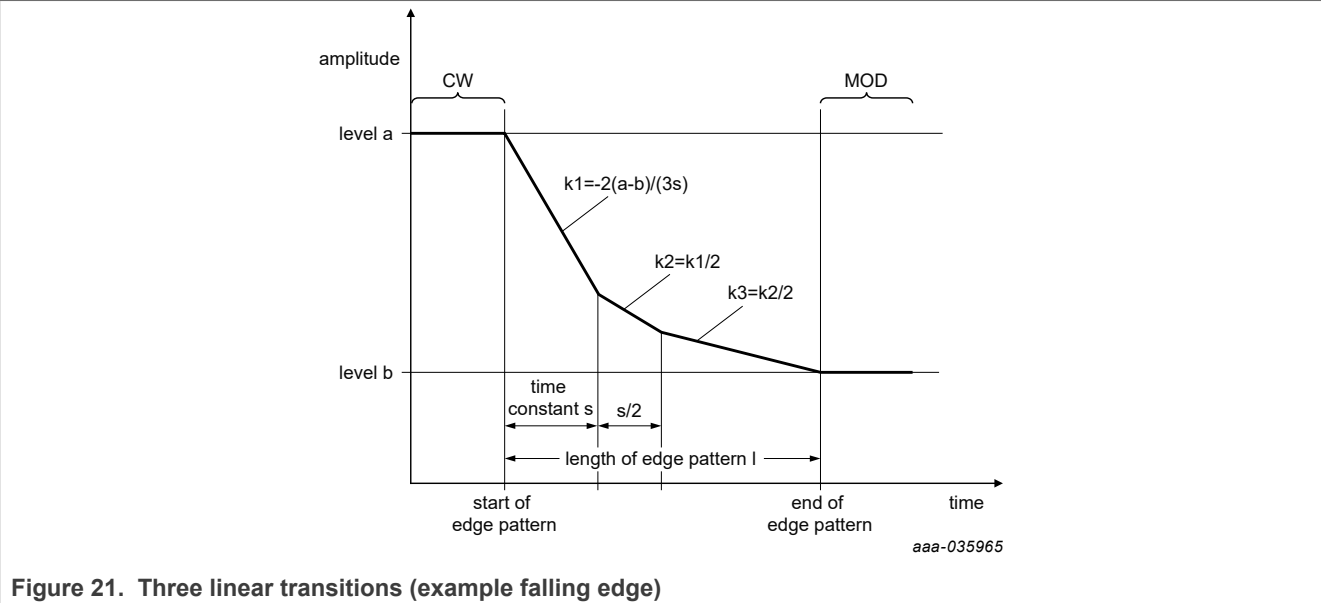
The type of the transition is selected in the EEPROM registers EDGE\_TYPE\_(protocol). It can be defined independent for each RF protocol and data rate - for both falling and rising edge.

The EEPROM registers EDGE\_STYLE\_(protocol) define the time constant "s" of falling/rising edge (depends on edge style).

The EEPROM registers EDGE\_LENGTH\_(protocol) define the total length of the edge pattern.

Figure 19 to Figure 21 illustrate the edge type for the falling edge.





The transition patterns are used as implicit pre-distortion to compensate effects of TX loading circuitry (for example, resonant circuitry parameters) to the emitted RF envelope.

9.12 Adaptive receiver control (ARC)

Depending on the level of detected antenna detuning, receiver-related register settings can be automatically updated. The receiver-related registers which are allowed to be dynamically controlled are:

DGRM\_RSSI\_REG (30h) ->DGRM\_SIGNAL\_DETECT\_TH\_OVR\_VAL  
 SIGPRO\_RM\_Tech\_REG (22h) ->RM\_MF\_GAIN,

The adaptive receiver control settings override the default RM\_MF\_GAIN and DGRM\_SIGNAL\_DETECT\_TH\_OVR\_VAL settings configured by the command LOAD\_RF\_CONFIGURATION (0Dh).

The ARC algorithm is called when VDDPA voltage changes after DPC. There are two lookup tables used in ARC algorithm i.e VDDPA lookup and ARC lookup. In case of a VDDPA change, an EEPROM lookup (at current protocol and baud rate) is performed. The receiver-related settings i.e RM\_MF\_GAIN, DGRM\_SIGNAL\_DETECT\_TH\_OVR\_VAL and IIR\_ENABLE are read from EEPROM lookup table and configured in registers.

**VDDPA lookup table:**

VDDPA lookup table defines a maximum of five voltage ranges. Number of VDDPA voltage ranges used in ARC algorithm is configured in bArcConfig[2:0]. VDDPA voltage output from DPC algorithm is input to VDDPA lookup. VDDPA lookup returns VDDPA\_range\_index (i.e 0,1,2,3,4).

Table 8. ARC\_VDDPA EEPROM configuration bit description

Function	Bit	Description
ARC VDDPA Setting	7:0	Byte[4] = ARC_VDDPA_0: ARC_VDDPA_3 > VDDPA < ARC_VDDPA_4
	7:0	Byte[3] = ARC_VDDPA_0: ARC_VDDPA_2 > VDDPA < ARC_VDDPA_3
	7:0	Byte[2] = ARC_VDDPA_0: ARC_VDDPA_1 > VDDPA < ARC_VDDPA_2
	7:0	Byte[1] = ARC_VDDPA_0: ARC_VDDPA_0 > VDDPA < ARC_VDDPA_1

Table 8. ARC\_VDDPA EEPROM configuration bit description...continued

Function	Bit	Description
	7:0	Byte[0] = ARC_VDDPA_0: $1.5 > \text{VDDPA} < \text{ARC\_VDDPA\_0}$

**ARC lookup table:**

**VDDPA index** and **RF protocol/datarates** are input to ARC lookup. There are five Receiver settings entries for each protocol and data rates. ARC algorithm select one out of five entries (at current protocol and baud rate) based on VDDPA\_range\_index.

[Table 9](#) shows ARC settings for Type A-106.

Table 9. ARC\_RM\_A106 EEPROM configuration bit description

Function	Bit	Description
RM_RX_ARC_4	15:0	Bit[15] 0: ARC settings always apply 1: ARC settings applicable during FDT, Bits[14:10] = RFU Bit [9] = Enable the IIR filter. Bits[8:7] = MF_GAIN (this value will be applied to the SIGPR_RM_Tech register, applies as soon as the ARC is enabled) Bits[6:0] = DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)
RM_RX_ARC_3	15:0	Bit[15] 0: ARC settings always apply 1: ARC settings applicable during FDT, Bits[14:10] = RFU Bit [9] = Enable the IIR filter. Bits[8:7] = MF_GAIN (this value will be applied to the SIGPR_RM_Tech register, applies as soon as the ARC is enabled) Bits[6:0] = DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)
RM_RX_ARC_2	15:0	Bit[15] 0: ARC settings always apply 1: ARC settings applicable during FDT, Bits[14:10] = RFU Bit [9] = Enable the IIR filter. Bits[8:7] = MF_GAIN (this value will be applied to the SIGPR_RM_Tech register, applies as soon as the ARC is enabled) Bits[6:0] = DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)



Table 9. ARC\_RM\_A106 EEPROM configuration bit description...continued

Function	Bit	Description
RM_RX_ARC_1	15:0	Bit[15] 0: ARC settings always apply 1: ARC settings applicable during FDT, Bits[14:10] = RFU Bit [9] = Enable the IIR filter. Bits[8:7] = MF_GAIN (this value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled) Bits[6:0] = DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)
RM_RX_ARC_0	15:0	Bit[15] 0: ARC settings always apply 1: ARC settings applicable during FDT and DPC change Bits[14:10] = RFU Bit [9] = Enable the IIR filter. Bits[8:7] = MF_GAIN (this value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled) Bits[6:0] = DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)

**Note:** For ISO14443-A: In case ARC is disabled, it requires DPC\_SIGNAL\_DETECT\_TH\_OVR\_VAL larger than 0x50 (with MF\_GAIN = 2 (default))

**Note:** For ISO14443-A: In case Bit[15] is configured to 0, it requires DPC\_SIGNAL\_DETECT\_TH\_OVR\_VAL larger than 0x50 (with MF\_GAIN = 2 (default)) if the ARC is enabled.

### 9.13 Energy-saving card detection

The low-power card detection (LPCD) is an energy-saving card polling configuration for the PN7220. During LPCD, a host microcontroller can be set into power-saving mode, as no host controller interaction is required.

A low frequency timer is implemented to drive a wake-up counter, which triggers a periodic activation of the antenna drivers to emit a short pulse which allows to detect a detuning of the antenna. In case of a detected antenna detuning, the system is woken up from power-saving mode. It sends an interrupt signal to the connected host microcontroller to wake up the host microcontroller from power-saving mode and to indicate a change of the antenna detuning condition.

A low frequency timer is implemented to drive a wake-up counter, which triggers a periodic activation of the antenna drivers to emit a short pulse which allows to detect a detuning of the antenna. In case of a detected antenna detuning and the system is woken up from power-saving mode.

There is no trimming for the Low Frequency Timer required.

The NCI configuration is enabled to enter the LPCD mode with a total duration once a RF\_DISCOVER\_CMD is issued by the DH.

### 9.13.1 Low-power card detection (LPCD)

The low-power card detection (LPCD) is an energy-saving card polling configuration for the PN7220. During LPCD, a host microcontroller can be set into power-saving mode, as no host controller interaction is required. The host microcontroller is woken up from power-saving mode by an IRQ send by the PN7220.

A low frequency oscillator (there is no trimming for the low frequency oscillator required) is implemented to drive a wake-up counter, which triggers a periodic activation of the antenna drivers to emit a short RF pulse. This RF pulse allows to detect a detuning of the antenna by presence of conductive objects in proximity of the antenna (card, cell phone, metal).

In case of a detected antenna detuning, the system wakes up from power-saving mode. It sends an interrupt signal to the connected host microcontroller to wake up the host microcontroller from power-saving mode and to indicate a change of the antenna detuning condition.

A low frequency oscillator (LFO) is implemented to drive a wake-up counter, waking-up PN7220 from Standby mode. This allows implementation of low-power card detection polling loop at application level.

The host microcontroller can then perform a card polling sequence to verify if the technology of the object causing the antenna detuning is supported by the system.

Before entering the LPCD mode, ADC\_I and ADC\_Q reference value must be determined. This is done during the so-called calibration.

#### LPCD calibration phase

- a) An initial calibration measurement is performed to set up the RX chain parameters namely HFATT, DCO\_DAC\_I\_CTRL and DCO\_DAC\_Q\_CTRL values.
- b) The next measurement is done using the RX chain parameters that are set up, to arrive at the ADC\_I and ADC\_Q values which are used as reference values. All following LPCD measurements are done relative to the LPCD calibration measurement.

**The LPCD loop** itself works in two phases:

First the standby phase is controlled by the wake-up counter (timing defined in the instruction), which defines the duration of the standby of the PN7220.

Second phase is the detection-phase. The RF field is switched on for a defined time (EEPROM configuration) and then the ADC\_I and ADC\_Q values are compared to a reference value.

- If the ADC\_I and ADC\_Q values exceed the reference value, PN7220 will wake-up from standby and shall try to perform Technology detection and if successful RF\_INTF\_ACTIVATED\_NTF shall be sent to Device Host.
- If the ADC\_I and ADC\_Q values do not exceed the thresholds of the reference value, then PN7220 will enter into standby mode again.

These two phases are executed in a loop until:

- Card / metal is detected (LPCD\_IRQ is raised).
- Reset occurs, which resets all the system configurations. The LPCD is also terminated in this case.
- NTS on host interface
- RF Level Detected

The behavior of the generated field is different dependent on the activation state of the DPC function:

- If the DPC feature is not active, the ISO/IEC14443 type A 106 kbit/s settings are used during the sensing time.
- If the DPC is active, the RF\_ON command is executed. The RF field is switched on as soon as the timer configured by the SWITCH\_MODE command elapses. The RF field is switched on for a duration as defined

for an activated DPC. The timer for the LPCD\_FIELD\_ON\_TIME starts to count as soon as the RF\_ON command terminates.

**Table 10. Low-Power Card Detection: relevant EEPROM configuration**

Name	Description
LPCD_AVG_SAMPLES	Defines how many samples of the I and Q values are used for the averaging. Used to optimize the system to achieve highest detection sensitivity versus false alarms.
LPCD_RSSI_TARGET	Value to be used as the RSSI target in the calibration phase to arrive at the RX chain parameters. This parameter is used to arrive at an optimal target voltage level at RXP.
LPCD_RSSI_HYST	Value to be used as the RSSI hysteresis in the calibration phase to arrive at the RX chain parameters. This is used to avoid oscillations while arriving at the target voltage level at RXP.
LPCD_THRESHOLD	If the difference between the measured value of I/Q and the reference value for I/Q is greater than the threshold on either channels, then a card is detected.
LPCD_VDDPA	VDDPA voltage when DC-DC (internal or external) or external power source is used to feed TXLDO
XTAL_CHECK_DELAY	Interval which is used to check if XTAL is ready (unit is 256/fc, e.g. ~18.8 us). For fastest startup this time, a check is performed at a time slightly higher than the expected startup time of the crystal.

**Table 11. Low-Power Card Detection: relevant EEPROM configuration**

Name	Description
LPCD_AVG_SAMPLES	Defines how many samples of the I and Q values are used for the averaging. Used to optimize the system to achieve highest detection sensitivity versus false alarms.
LPCD_RSSI_TARGET	Value to be used as the RSSI target in the calibration phase to arrive at the RX chain parameters. This parameter is used to arrive at an optimal target voltage level at RXP.
LPCD_RSSI_HYST	Value to be used as the RSSI hysteresis in the calibration phase to arrive at the RX chain parameters. This is used to avoid oscillations while arriving at the target voltage level at RXP.
LPCD_THRESHOLD	If the difference between the measured value of I/Q and the reference value for I/Q is greater than the threshold on either channels, then a card is detected.
LPCD_VDDPA	VDDPA voltage when DC-DC (internal or external) or external power source is used to feed TXLDO
XTAL_CHECK_DELAY	Interval which is used to check if XTAL is ready (unit is 256/fc, e.g. ~18,8us). For fastest startup this time, a check is performed at a time slightly higher than the expected startup time of the crystal.

## 9.14 RF-level detection

The PN7220 implements an RF level detector (RFLD) and an NFC level detector (NFCLD) which allows to detect the presence of an external RF field.

The collision avoidance is not enabled for the EMVCo mode, and active for the NFC Forum mode.

### RF Level Detector:

During low-power card detection (LPCD), the RF level detector (RFLD) acts as wake-up source from power-saving mode.

The purpose of the RFLD function is to detect any signal at 13.56 MHz in order to wake up the PN7220 from power-saving mode.

### NFC Level Detector:

The NFC Level detector (NFCLD) is used during full power mode. The NFCLD function is required by NFC Forum to support the "RF collision avoidance".

The sensitivity of the NFCLD sensor can be configured by EEPROM register to meet the NFC Forum requirements.

It can be used as well in card mode to detect an external field.

## 9.15 Antenna connection

The PN7220 allows to connect antennas of different topology and matching to the transmitter.

Standard and recommended tuning of the antenna fitting to most applications is a symmetrical matched antenna connected to TX1, TX2 operating in push-pull operation.

VBAT is connected to VBATPWR.

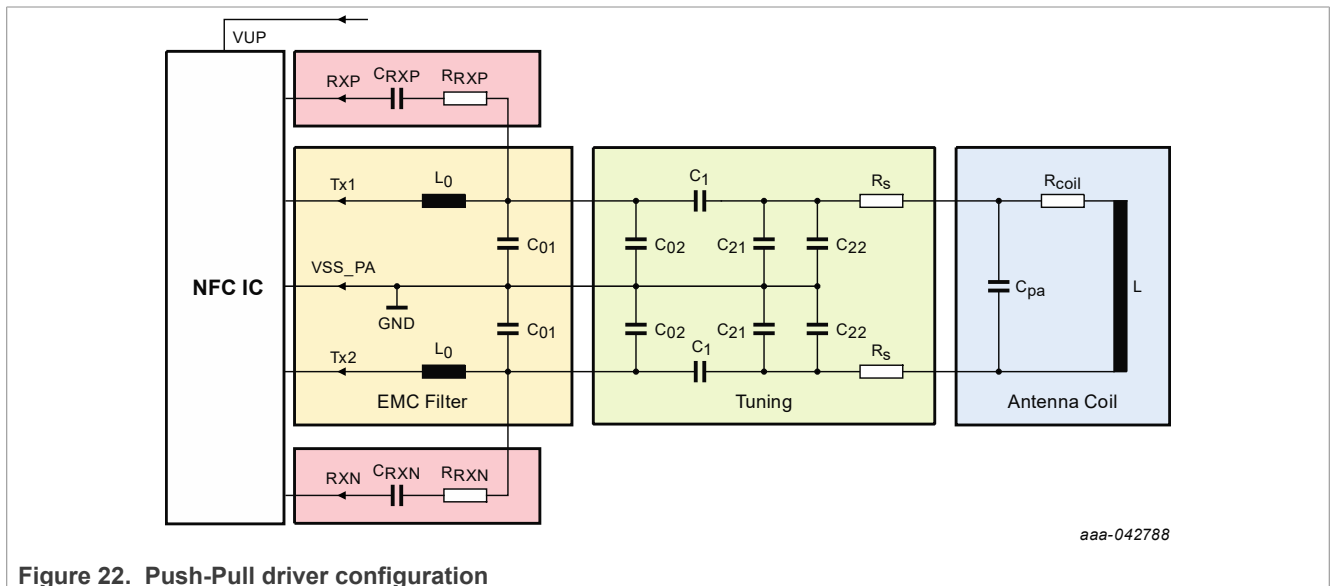


Figure 22. Push-Pull driver configuration

The PN7220 allows to operate the TX1, TX2 in common mode as well, which allows to use a single ended antenna. This configuration saves one EMC filter coil.

**Note:** The RSSI target for SE must be calculated as follows and differs from the differential antenna:

$RSSI\ target = Target\ RX\ Peak\ Voltage * 1024 / (1.8 * 2)$

Example: For a 1.2 V target:  $DGRM\_RSSI\_TARGET = 1.2 * 1024 / (1.8 * 2) = 341d = 0x155$

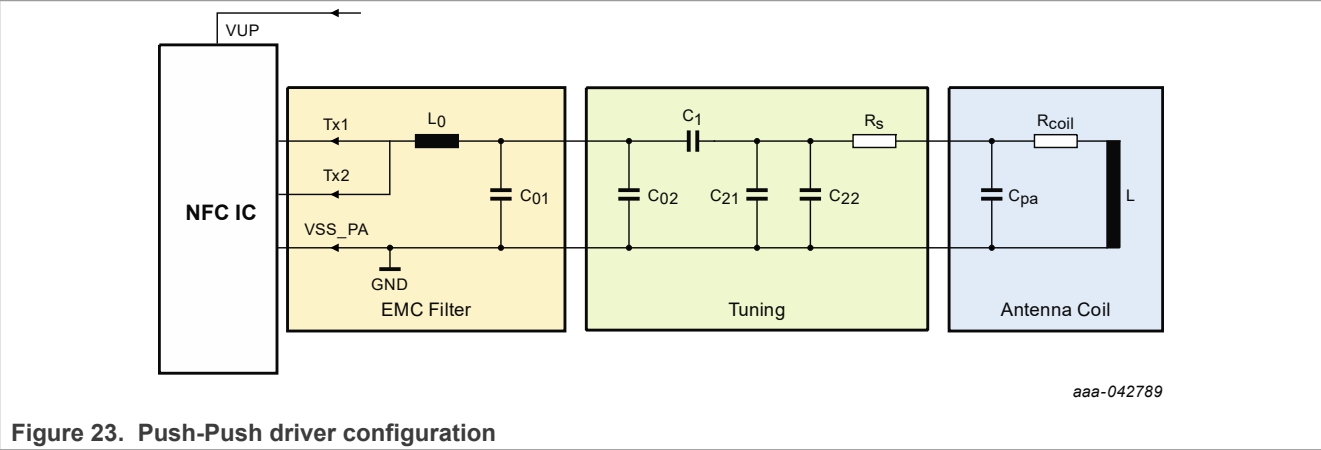


Table 12. Antenna register configuration

Register (Address)	Bit	Differential Antenna Push-Pull driver TX1, TX2	Single-Ended Push-Push driver TX1, TX2
SS_TX_CFG (0x15)	TX2_USE_TX1_CONF	1b	1b
SS_TX1_RMCFG (0x16)	TX1_CLK_MODE_TRANS_RM	111b	111b
SS_TX1_RMCFG (0x16)	TX1_CLK_MODE_MOD_RM	111b	111b
SS_TX1_RMCFG (0x16)	TX1_CLK_MODE_CW_RM	111b	111b
SS_TX2_RMCFG (0x17)	TX2_CLK_MODE_TRANS_RM	do not care	do not care
SS_TX2_RMCFG (0x17)	TX2_CLK_MODE_MOD_RM	do not care	do not care
SS_TX2_RMCFG (0x17)	TX2_CLK_MODE_CW_RM	do not care	do not care
DGRM_RSSI (0x30)	DGRM_RSSI_TARGET	direct entry	as per calculation for SE (RSSI target = Target RX Peak Voltage*1024/ (1.8*2))
ANA_RX_CTRL (0x43)	RX_MIXER_SE_MODE_EN	0	1
ANACTRL_TX_CONFIG (0x44)	TX_INV_P_RM	10b	00b
ANACTRL_TX_CONFIG (0x44)	TX_PWM_MODE_RM	0b	0b

Table 13. Antenna EEPROM configuration

EEPROM (Address)	Bit	Differential Antenna Push-Pull driver TX1, TX2	Single-Ended Push-Push driver TX1, TX2
TX_SHAPING_CONFIG (0x17)	0	0	0

**Note:** Recommendation is to use all the settings configured in EEPROM. For CLIF\_SS\_TX\_CFG\_REG, the value has to be configured in EEPROM for each technology and baud rate so that the value is loaded after every load protocol.

9.16 RF debug signals

The following signals are available for debugging purposes:

The test signals are selected by sending a command string to the PN7220.

If used, **ADC-Q must be routed always to AUX1, ADC-I must be routed always to AUX2.**

The analog test signals are analog representation of an internal digital value. The internal digital signal is converted by an 8-bit wide DAC to the analog signal.

This overview indicates the signals which are available for debugging purposes (indicated by numbers):

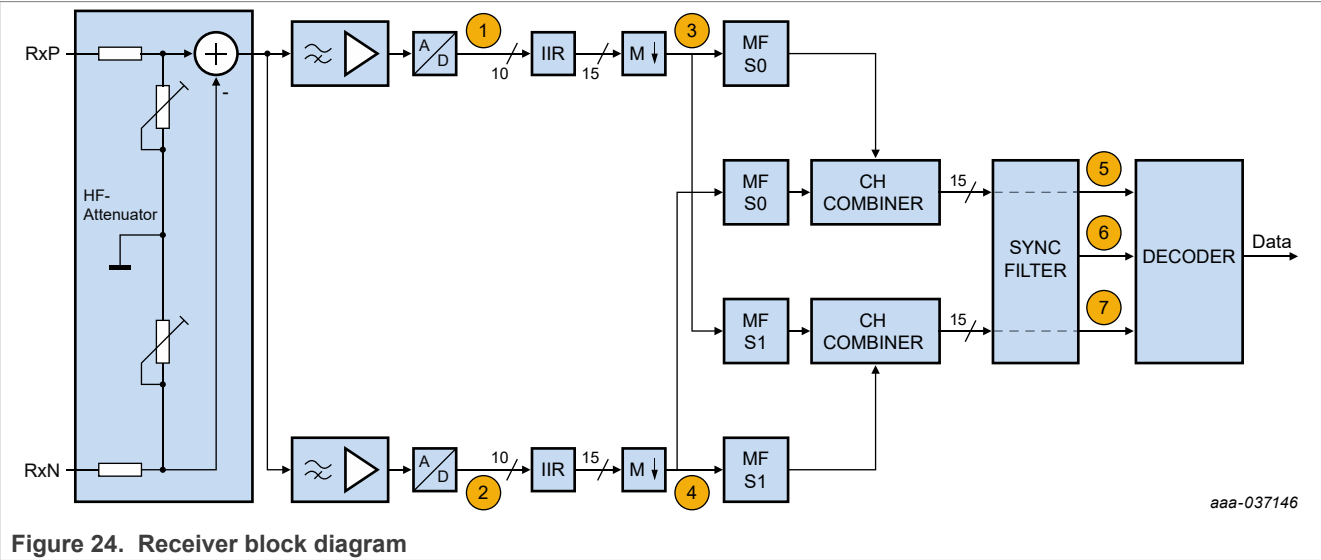


Table 14. DEBUG SIGNALS

Signal	REGISTER	SIGNAL NAME	BITS	Description
ADC Data I Channel (1)	obs_clif_tbcontrol_patchbox0	adc_data_i_i	9:2	Unfiltered I channel signal upper 7 bit of the 10 bit signed unfiltered I channel signal including sign (bit9)
	obs_clif_tbcontrol_patchbox1		9; 6:0	Unfiltered I channel signal lower 7 bit of the 10 bit signed unfiltered I channel signal including sign (bit9)
ADC Data Q Channel (2)	obs_clif_tbcontrol_patchbox2	adc_data_q_i	9:2	Unfiltered Q channel signal upper 7 bit of the 10 bit signed unfiltered Q channel signal including sign (bit9)
	obs_clif_tbcontrol_patchbox3		9; 6:0	Unfiltered Q channel signal lower 7 bit of the 10 bit signed unfiltered Q channel signal including sign (bit9)
Preprocessor Out I Channel (3)	obs_clif_sigpro_rm0	rm_cor_adc_i_o	14:8	Pre-processed ADC data I channel upper 7bit of 15bit signed pre-processed ADC data I channel, after IIR filter and down-sampling including sign (bit14) bit 15: RFU
	obs_clif_sigpro_rm1		7:0	Pre-processed ADC data I channel lower 8bit of 15bit signed pre-processed ADC data I channel, after IIR filter and down-sampling
Preprocessor Out Q Channel (4)	obs_clif_sigpro_rm2	rm_cor_adc_q_o	14:8	Pre-processed ADC data I channel upper 7bit of 15bit signed pre-processed ADC data Q channel, after IIR filter and down-sampling including sign (bit14) bit 15: RFU
	obs_clif_sigpro_rm3		7:0	Pre-processed ADC data I channel lower 8bit of 15bit signed pre-processed ADC data Q channel, after IIR filter and down-sampling
Output MF S0 (5)	obs_clif_sigpro_rm4	mf_pt_s0_d	14:8	Delayed matched filter S0 output, after CH combiner upper 7 bit of the 15 bit signed delayed matched filter S0 output, after Channel combiner including sign (bit14) bit 15: RFU (ignore)
	obs_clif_sigpro_rm5		7:0	Delayed matched filter S0 output, after CH combiner lower 8 bit of the 15 bit signed delayed matched filter S0 output, after Channel combiner
Output MF S1 (6)	obs_clif_sigpro_rm6	mf_pt_s1_d	14:8	Delayed matched filter S1 output, after CH combiner upper 7 bit of the 15 bit signed delayed matched filter S1 output, after Channel combiner including sign (bit14) bit 15: RFU (ignore) Remark: S1 is not relevant for type A 106
	obs_clif_sigpro_rm7		7:0	Delayed matched filter S1 output, after CH combiner lower 8 bit of the 15 bit signed delayed matched filter S1 output, after Channel combiner Remark: S1 is not relevant for type A 106

Table 14. DEBUG SIGNALS...continued

Signal	REGISTER	SIGNAL NAME	BITS	Description
Output Synchronization Filter (7)	obs_clif_sigpro_rm8	sync_filt_out	14:8	Synchronization filter output upper 7 bit of the 15 bit signed synchronization filter output including sign (bit14) bit 15: RFU (ignore)
	obs_clif_sigpro_rm9		7:0	Synchronization filter output lower 8 bit of the 15 bit signed synchronization filter output
clif_status	transceive_state		7:5	
	rx_cl_error		4	
	tx_envelope		3	
	rx_enevelope		2	
	svalid		1	
	sdata		0	
clif_transceive	rx_start_receive		7	
	rx_over_ok		6	
	rx_over_term		5	
	rx_resume		4	
	sgp_msg_busy		3	
	fig_reset_sigpro		2	
	fig_reset_rxdec		1	
	cfg_sw_reset_sigpro		0	

Table 15. TRIGGER SIGNALS

TRIGGER	REGISTER	SIGNAL NAME	BITS	Description
TX Active	obs_clif_txenc1	tx_active_o	1	high level indicates transmission of data Remark: Falling edge can be used to trigger on end of transmission.
RX Enable	obs_clif_sigpro_rm15	rx_enable_o	1	high level indicates that the reception is ongoing Remark: can be used to trigger on the start /end of reception
RX collision detected	obs_clif_sigpro_rm14	rm_scoll_o	1	high-level pulse indicates that the collision is detected during reception

## 9.17 Polling loop

The polling loop and related configuration are described in the user manual.



## 9.18 System settings and configuration

The configuration and behavior of the device is controlled at a central place.

EEPROM settings are a collection of all available configuration parameters that are needed for different operation modes. EEPROM settings serve as the source for the register settings.

The following two chapters list down the registers that are available to the user, as well as all available EEPROM configuration options.

**This list of registers and EEPROM configuration is copied from PN5190 - it will be updated for the final product. Not all registers /EEPROM might be available on the PN7220.**

### 9.18.1 CLIF register description

The default setting of a bit within a register is indicated by the "\*" or "Reset value". Value indicates the allowed range for the bits of a symbol.

Note that the firmware changes the content of some registers between an RF Exchange followed by an RF Reset command.

The detailed description of the registers is available in the User API documentation.

#### 9.18.1.1 List of CLIF registers

List of CLIF registers and its addresses

Table 16. List of CLIF registers

Register Name	Register address (Hex)	Register address (Decimal)
<a href="#">SYSTEM_CONFIG (0x00)</a>	0x00	0
<a href="#">CLIF_RX_STATUS (0x05)</a>	0x05	5
<a href="#">CLIF_RX_STATUS_ERROR (0x06)</a>	0x06	6
<a href="#">CLIF_STATUS (0x07)</a>	0x07	7
<a href="#">CLIF_CRC_TX_CONFIG (0x12)</a>	0x12	18
<a href="#">CLIF_SS_TX1_RMCFG (0x16)</a>	0x16	22
<a href="#">CLIF_SIGPRO_RM_TECH (0x22)</a>	0x22	34
<a href="#">CLIF_SIGPRO_IIR_CONFIG0 (0x2A)</a>	0x2A	42
<a href="#">CLIF_DGRM_BBA (0x2D)</a>	0x2D	45
<a href="#">CLIF_DGRM_RSSI (0x30)</a>	0x30	48
<a href="#">CLIF_CRC_RX_CONFIG (0x31)</a>	0x31	49
<a href="#">CLIF_RX_WAIT (0x32)</a>	0x32	50
<a href="#">CLIF_SS_TX1_CMCFG (0x3B)</a>	0x3B	59
<a href="#">CLIF_TIMER1_CONFIG (0x3F)</a>	0x3F	63
<a href="#">CLIF_TIMER1_RELOAD (0x40)</a>	0x40	64
<a href="#">TXLDO_VDDPA_CONFIG (0x54)</a>	0x54	84
<a href="#">TXLDO_VOUT_CURR (0x56)</a>	0x56	84
<a href="#">CLIF_RXM_FREQ (0x59)</a>	0x59	89

Table 16. List of CLIF registers...continued

Register Name	Register address (Hex)	Register address (Decimal)
<a href="#">INTERPOLATED_RSSI_REG (0x5C)</a>	0x5C	92
<a href="#">TX_NOV_CALIBRATE_AND_STORE_VAL_REG (0x5D)</a>	0x5D	93
<a href="#">CLIF_SS_TX1_RTRANS0 (0x80)</a>	0x80	128
<a href="#">CLIF_SS_TX1_RTRANS1 (0x81)</a>	0x81	129
<a href="#">CLIF_SS_TX1_RTRANS2 (0x82)</a>	0x82	130
<a href="#">CLIF_SS_TX1_RTRANS3 (0x83)</a>	0x83	131
<a href="#">CLIF_SS_TX2_RTRANS0 (0x84)</a>	0x84	132
<a href="#">CLIF_SS_TX2_RTRANS1 (0x85)</a>	0x85	133
<a href="#">CLIF_SS_TX2_RTRANS2 (0x86)</a>	0x86	134
<a href="#">CLIF_SS_TX2_RTRANS3 (0x87)</a>	0x87	135
<a href="#">CLIF_SS_TX1_FTRANS0 (0x88)</a>	0x88	136
<a href="#">CLIF_SS_TX1_FTRANS1 (0x89)</a>	0x89	137
<a href="#">CLIF_SS_TX1_FTRANS2 (0x8A)</a>	0x8A	138
<a href="#">CLIF_SS_TX1_FTRANS3 (0x8B)</a>	0x8B	139
<a href="#">CLIF_SS_TX2_FTRANS0 (0x8C)</a>	0x8C	140
<a href="#">CLIF_SS_TX2_FTRANS1 (0x8D)</a>	0x8D	141
<a href="#">CLIF_SS_TX2_FTRANS2 (0x8E)</a>	0x8E	142
<a href="#">CLIF_SS_TX2_FTRANS3 (0x8F)</a>	0x8F	143

## 9.18.1.2 SYSTEM\_CONFIG (0x00)

This register provides the system configuration on Autocoll, MFC Crypto bit generation, ISO15693 baud-rate, TXNOV calibration.

Table 17. SYSTEM\_CONFIG (0x00) register bit description

Bit	Symbol	Access	Value	Description
[31:9]	RFU	rw		Reserved
[8:8]	TX_NOV_CALIBRATE	rw		One time calibration when the host writes a 1 into this register, a one time calibration will be performed. <b>Note:</b> The calibration is resulting a short RF-on. All the power configurations shall be configured before setting this bit.
[7:7]	RFU	rw		Reserved
[6:5]	15693_CHANGE_DATARATE	rw		15693_changedatarate. By default, the basic data rate of 26 kB/s will be loaded, switching to a different higher data rate requires this config register to be updated. All relevant related registers will be updated automatically.
			0	RFU
			1	Change Data Rate to 53 kB/s
			2	Change Data Rate to 106 kB/s
			3	Change Data Rate to 212 kB/s
[4:2]	RFU	rw		Reserved
[1:1]	MFC_CRYPTON_ON	rw		MIFARE crypto bit generation for MIFARE Classic en/de-cryption
			0	MIFARE - crypto bit is not generated for MIFARE Classic en-/de-cryption
			1	MIFARE - crypto bit is generated for MIFARE Classic en-/de-cryption
[0:0]	AUTOCOLL_STATE_A	rw		Autocoll state for Type A
			0	TypeA Card mode: Autocoll entry with IDLE state of the card
			1	TypeA Card mode: Autocoll entry with HALT state of the card

## 9.18.1.3 CLIF\_RX\_STATUS (0x05)

This register provides the CLIF RX status.

Table 18. CLIF\_RX\_STATUS (0x05) register bit description

Bit	Symbol	Access	Value	Description
[31:27]	RESERVED	r-	0x0	Reserved
[26:20]	RX_COLL_POS	r-	0x0	Status indicating the bit position of the first collision detected in the data bit. The value is valid only when RX_COLLISION_DETECTED==1. The value of the RX_BIT_ALIGN is also taken into account (RX_COLL_POS = physical bit position in the flow + RX_BIT_ALIGN value). Indicates the collision position in the first 8 bytes only. Can be used during the Type A/ICODE/EPC anticollision procedure. 0x00 - 1st bit 0x01 - 2nd bit...0x7F - 128th bit. The status register is not updated by the collision detected on stop or parity bit.
[19:17]	RX_NUM_LAST_BITS	r-	0x0	Indicating the number of valid bits in the last byte received. This is generally used during ISO/IEC14443 type A anti-collision
			0	0: all bits are valid
			1	1: 1 bit is valid
			2	2: 2 bits are valid
			3	3: 3 bits are valid
			4	4: 4 bits are valid
			5	5: 5 bits are valid
			6	6: 6 bits are valid
[16:13]	RX_NUM_FRAMES_RECEIVED	r-	0x0	Indicates the number of frames received. The value is updated after every normal frame reception in RX_MULTIPLE mode. The value is valid only if the bit RX_MULTIPLE_ENABLE==1.
[12:0]	RX_NUM_BYTES_RECEIVED	r-	0x0	Number of bytes received on the RF interface. This field is not relevant when RX_MULTIPLE_ENABLE=='1'.

## 9.18.1.4 CLIF\_RX\_STATUS\_ERROR (0x06)

This register provides the CLIF\_RX\_ERROR status.

Table 19. CLIF\_RX\_STATUS\_ERROR (0x06) register bit description

Bit	Symbol	Access	Value	Description
[31:30]	RESERVED	r-	0x0	Reserved
[29:29]	EMD_DETECTED_IN_RXDEC	r-	0x0	The high level indicates that the EMD was detected (in the SigPro or in the RxDecoder or in both) during the reception.
[28:28]	EMD_DETECTED_IN_SIGPRO	r-	0x0	The high level indicates that the EMD was detected on the Physical layer (in the SigPro) during the reception.
[27:27]	EXT_RFOFF_DETECTED	r-	0x0	The high level indicates that the received frame length violated the configured minimum limit.
[26:26]	RX_FRAME_MAXLEN_VIOL	r-	0x0	The high level indicates that the received frame length is less or equal to the expected CRC field length
[25:25]	RX_FRAME_MINLEN_VIOL	r-	0x0	The high level indicates that the last received character in the frame has less than 8 bits.
[24:24]	RX_FRAME_LE_CRC	r-	0x0	The high level indicates that the last received character in the frame has 8 data bits but the expected parity bit is absent.
[23:23]	RX_NOT_FULL_BYTE	r-	0x0	The high level indicates that the last received character in the frame has 8 data bits but the expected stop bit is absent.
[22:22]	RX_MISSING_PARBIT_DETECTED	r-	0x0	The high level indicates that the collision was detected on the parity bit position.
[21:21]	RX_MISSING_STOPBIT_DETECTED	r-	0x0	The high level indicates that the collision was detected on the stop bit position.
[18:18]	RX_COLLISION_DETECTED	r-	0x0	The high level indicates that the collision was detected during the frame reception.
[17:17]	RX_STOP_ON_RXOVER	r-	0x0	The high level indicates that the frame reception was stopped by SGP_MSG_RXOVER_* message reception.
[16:16]	RX_STOP_ON_RFOFF	r-	0x0	The high level indicates that the frame reception was interrupted by external RF-field vanishing event.
[15:15]	RX_STOP_ON_ERR	r-	0x0	The high level indicates that the frame reception was stopped by detected communication error event.
[14:14]	RX_STOP_ON_LEN	r-	0x0	The high level indicates that the frame reception was normally stopped by byte counter expiration event. Relates to the protocols where the LEN field is used in the frame format (Felica RM/CM, FWEC RM/CM).

Table 19. CLIF\_RX\_STATUS\_ERROR (0x06) register bit description...continued

Bit	Symbol	Access	Value	Description
[13:13]	RX_STOP_ON_INVPAR	r-	0x0	The high level indicates that the frame reception was normally stopped by the inverted parity detection event. Relates to the TypeA RM 212 kbit/s - 848 kbit/s modes. 12 RX_STOP_ON_PATTERN R 0h The high level indicates that the frame reception was normally stopped by EOF pattern detection event. Relates to the TypeB RM/CM, B prime RM/CM modes.
[12:12]	RX_STOP_ON_PATTERN	r-	0x0	The high level indicates that the frame reception was normally stopped by EOF pattern detection event. Relates to the TypeB RM/CM, B prime RM/CM modes.
[11:11]	RX_STOP_ON_ANTICOLL	r-	0x0	The high level indicates that the frame reception was normally stopped by collision detected on data bit position. Relates to the bit-oriented frame reception in TypeA RM 106 kbit/s mode during the anticollision procedure.
[10:10]	RX_CRC_ERROR	r-	0x0	The high level indicates that the CRC error is detected in the received frame.
[9:9]	RX_LEN_ERROR	r-	0x0	The high level is set if the received frame is shorter than the length stated in the received frame LEN field OR if the LEN parameter in the received frame violates the configured [RX_FRAME_MINLEN:RX_FRAME_MAX LEN] limits. Can assert only in the mode where the LEN field is used in the frame format (Felica RM/CM, FWEC RM/CM).
[8:8]	RX_SIGPRO_ERROR	r-	0x0	The high level indicates that the communication error/ errors were detected during the frame reception on physical layer(in the SigPro).
[7:7]	RX_PARITY_ERROR	r-	0x0	The high level indicates that the parity error was detected during the frame reception.
[6:6]	RX_STOPBIT_ERROR	r-	0x0	The high level indicates that the stop bit error (0 level instead of 1 on the stop bit position) was detected during the frame reception.
[5:5]	RX_WRITE_ERROR	r-	0x0	The high level indicates that the error acknowledge status was received on theCLIF-system interface during the received frame transmission to the System RAM.
[4:4]	RX_BUFFER_OVFL_ERROR	r-	0x0	The high level indicates that the data payload length in the received frame exceeds the 28 bytes limit. Relates to the PollReq procedure in the Felica RM mode only.
[3:3]	RX_LATENCY_ERROR	r-	0x0	The high level indicates that the write request flow was corrupted due to traffic congestion on the system interface during the received frame transmission to the System RAM.
[2:2]	RX_DATA_INTEGRITY_ERROR	r-	0x0	The high level indicates that the data integrity corruption (parity/CRC/etc error)was detected in the received frame.

Table 19. CLIF\_RX\_STATUS\_ERROR (0x06) register bit description...continued

Bit	Symbol	Access	Value	Description
[1:1]	RX_PROTOCOL_ERROR	r-	0x0	The high level indicates that the protocol requirements violation (stop bit error, missing parity bit, not full byte received, etc) was detected in the received frame.
[0:0]	RX_CL_ERROR	r-	0x0	The high level indicates that some protocol/data integrity error/errors were detected during the frame reception

### 9.18.1.5 CLIF\_STATUS (0x07)

This register provides the CLIF status.

Table 20. CLIF\_STATUS (0x07) register bit description

Bit	Symbol	Access	Value	Description
[31:30]	RESERVED	r-	0x0	Reserved
[29:29]	CRC_OK	r-	0x1	This bit indicates the status of the actual CRC calculation. If 1 the CRC is correct. meaning the CRC register has the value 0 or the residue value if inverted CRC is used. Note: This flag should only be evaluated at the end of a communication
[28:28]	RX_SC_DETECTED	r-	0x0	Status signal indicating that a sub-carrier is detected.
[27:27]	RX_SOF_DETECTED	r-	0x0	Status signal indicating that a SOF has been detected.
[26:26]	TX_RF_STATUS	r-	0x0	If set to 1 this bit indicates that the drivers are turned on. meaning an RF-Field is created by the device itself.
[25:25]	RF_DET_STATUS	r-	0x0	If set to 1 this bit indicates that an external RF-Field is detected by the rf level detectors (after digital filtering)
[24:24]	ADC_Q_CLIPPING	r-	0x0	Indicates that the Q-Channel ADC has clipped (value 0 or 63), This bit is reset with Rx-reset (enabling of receiver).
[23:23]	ADC_I_CLIPPING	r-	0x0	Indicates that the I-Channel ADC has clipped (value 0 or 63), This bit is reset with Rx-reset (enabling of receiver).
[22:22]	DPLL_SATURATED_LIMIT	r-	0x0	Status signal indicating that the DPLL has reached its locking limits (integrator is at 0 or maximum)
[21:21]	DPLL_SATURATED_LOCK_RANGE	r-	0x0	Status signal indicating that the DPLL has reached its locking limits. (Saturation range configured via DPLL_SATURATION_VAL)
[20:20]	DPLL_FREQ_LOCK_SUPER_FINE	r-	0x0	Status signal indicating that the DPLL has reached frequency-lock with ~1.4Hz accuracy
[19:19]	DPLL_FREQ_LOCK_FINE	r-	0x0	Status signal indicating that the DPLL has reached frequency-lock with ~5Hz accuracy
[18:18]	DPLL_FREQ_LOCK_COARSE	r-	0x0	Status signal indicating that the DPLL has reached frequency-lock with ~50Hz accuracy

Table 20. CLIF\_STATUS (0x07) register bit description...continued

Bit	Symbol	Access	Value	Description
[17:17]	DPLL_PHASE_LOCK	r-	0x0	Status signal indicating that the DPLL has reached phase-lock (typically happens before DPLL_FREQUENCY_LOCK_COARSE is set).
[16:16]	DPLL_ENABLE	r-	0x0	This bit indicates that the DPLL Controller has enabled the DPLL (RF on RF frequency ok PLL locked)
[15:15]	RESERVED	r-	0x0	Reserved
[14:14]	BMA_TRANSFER_ONGOING	r-	0x0	Status signal from Buffer Manager to indicate that a transfer is actually ongoing.
[13:13]	TX_READ_ERROR	r-	0x0	This error flag is set to 1 if for an ongoing transmission data is not copied from RAM in time (BMA encountered read error) and therefore the transmission is aborted. <b>Note:</b> This case should not happen in normal operation
[12:12]	TX_LATENCY_ERROR	r-	0x0	This error flag is set to 1. if for an ongoing transmission data is not available in time (BMA latency too big) and therefore the transmission is aborted. <b>Note:</b> This case should not happen in normal operation
[11:11]	TX_NO_DATA_ERROR	r-	0x0	This error flag is set to 1. in case a transmission is started but no data is available (register NumBytesToSend == 0).
[10:8]	RF_ACTIVE_ERROR_CAUSE	r-	0x00	This status flag indicates the cause of an NFC-Active error. <b>Note:</b> These bits are only valid when the RF_ACTIVE_ERROR_IRQ is raised and will be cleared as soon as the bit TX_RF_ENABLE is set to 1.
			0x00	reset value
			0x01	External field was detected on within TIDT timing
			0x02	External field was detected on within TADT timing
			0x03	No external field was detected within TADT timings
			0x04	Peer did switch off RF field without but no Rx event was raised (no data received)
			0x05-0x07	Reserved.
[7:6]	RESERVED	r-	0x0	Reserved
[5:5]	RX_ENABLE	r-	0x0	This bit indicates if the RxDecoder is enabled. If 1 the RxDecoder was enabled by the Transceiver Unit and is now ready for data reception
[4:4]	TX_ACTIVE	r-	0x0	This bit indicates activity of the TxEncoder. If 1 a transmission is ongoing otherwise the TxEncoder is in idle state.



Table 20. CLIF\_STATUS (0x07) register bit description...continued

Bit	Symbol	Access	Value	Description
[3:3]	RX_ACTIVE	r-	0x0	This bit indicates activity of the RxDecoder. If 1 a data reception is ongoing. otherwise the RxDecoder is in idle state.
[2:0]	TRANSCIVE_STATE	r-	0x0	This registers hold the command bits
			0	0: IDLE state
			1	1: WaitTransmit state
			2	2: Transmitting state
			3	3: WaitReceive state
			4	4: WaitForData state
			5	5: Receiving state
			6	6: LoopBack state
			7	7: reserved

### 9.18.1.6 CLIF\_CRC\_TX\_CONFIG (0x12)

This register provides the settings for CLIF\_CRC\_TX\_CONFIG

Table 21. CLIF\_CRC\_TX\_CONFIG (0x12) register bit description

Bit	Symbol	Access	Value	Description
[31:16]	TX_CRC_PRESET_VALUE	rw	0x0	Arbitrary preset value for the Tx-Encoder CRC calculation.
[15:7]	RESERVED	r-	0x0	Reserved
[6:6]	TX_CRC_BYTE2_ENABLE	rw	0x0	If set, the CRC is calculated from the 2nd byte onwards (intended for HID). Note that this option is used in the Tx-Encoder.
[5:3]	TX_CRC_PRESET_SEL	rw	0x000	Preset value of the CRC register for the Tx-Encoder. For a CRC calculation using 5 bits, only the LSByte is used.
			000b	000b -> 0000h reset value
			001b	001b -> 6363h
			010b	010b -> A671h
			011b	011b -> FFFFh
			100b	100b -> 0012h
			101b	101b -> E012h
			110b	110b -> RFU
			111b	111b -> Use arbitrary preset value TX_CRC_PRESET_VALUE
[2:2]	TX_CRC_TYPE	rw	0x0	Controls the type of CRC calculation for the Tx-Encoder 0* 16-bit CRC calculation. reset value 1 5-bit CRC calculation
[1:1]	TX_CRC_INV	rw	0x0	Controls the sending of an inverted CRC value by the Tx-Encoder 0* Not inverted CRC checksum. reset value 1 Inverted CRC checksum
[0:0]	TX_CRC_ENABLE	rw	0x0	If set to one, the Tx-Encoder will compute and transmit a CRC.

### 9.18.1.7 CLIF\_SS\_TX1\_RMCFG (0x16)

This register provides the settings for CLIF\_SS\_TX1\_RMCFG

Table 22. CLIF\_SS\_TX1\_RMCFG (0x16) register bit description

Bit	Symbol	Access	Value	Description
[31:25]	RESERVED	r-	0x00	Reserved
[24:22]	TX1_CLK_MODE_TRANS_RM	rw	0x00	TX1 clock mode in RM during transition
[21:19]	TX1_CLK_MODE_MOD_RM	rw	0x00	TX1 clock mode of modulated wave in RM
[18:16]	TX1_CLK_MODE_CW_RM	rw	0x00	TX1 clock mode of unmodulated wave in RM
[15:8]	TX1_AMP_MOD_RM	rw	0x00	TX1 amplitude of modulated wave in RM ( 0x00 = 0 %modulation, 0xFF: 100 % modulation)

Table 22. CLIF\_SS\_TX1\_RMCFG (0x16) register bit description...continued

Bit	Symbol	Access	Value	Description
[7:0]	TX1_AMP_CW_RM	rw	0xFF	TX1 amplitude of unmodulated wave in RM ( 0x00 = 0 % signal, 0xFF: 100 % signal)

#### 9.18.1.8 CLIF\_SIGPRO\_RM\_TECH (0x22)

This register provides the settings for CLIF\_SIGPRO\_RM\_TECH

Table 23. CLIF\_SIGPRO\_RM\_TECH (0x22) register bit description

Bit	Symbol	Access	Value	Description
[31:30]	RM_NCO_PERIOD_SEL	rw	0x0	Defines the reset value for the NCO counter
[29:27]	RM_WAIT_RES_PERIOD_SEL	rw	0x0	Defines the reset value for the Delay counter
[26:26]	RM_EGT_WINDOW_TH_SEL	rw	0x0	Defines the EGT window threshold for Type B
[25:25]	RM_DC_REMOVAL_ENABLE	rw	0x0	Reserved
[24:23]	RM_DOWNSAMPLE_RATE_SEL	rw	0x0	Defines the down sample rate for the reader demod.
[22:20]	RM_SOF_NUM_CYCLES_SEL	rw	0x0	Defines the number of samples in I-Code SOF.
[19:17]	RM_MF_SEL	rw	0x0	Defines the selection for the Matched-Filters
[16:15]	RM_MF_GAIN	rw	0x0	Defines the gain of the Matched-Filters
[14:13]	RM_MRC_WEIGHT_SEL	rw	0x0	Defines the channel combiner weight on the lower channel
[12:12]	RM_AVG_FILT_GAIN	rw	0x0	Defines the averaging filter gain
[11:10]	RM_AVG_FILT_SEL	rw	0x0	Defines the averaging filter selection
[9:8]	RM_SYNC_FILT_IN_SEL	rw	0x0	Defines the input selection for the sync filter.
[7:6]	RM_SYNC_FILT_SEL	rw	0x0	Defines the synchronization filter selection
[5:3]	RM_WATCH_DOG_PERIOD_SEL	rw	0x0	Defines the reset value for the watch-dog counter
[2:2]	RM_EST_RESTART_ENABLE	rw	0x0	Reserved
[1:0]	RM_OOK_STAT_LEN	rw	0x3	Defines the number of samples used to check for invalid at the beginning of a reception in A106 and Icode. Value 0x0 = 2 samples, value 0x1 = 4 samples, value 0x2 = 8 samples, value 0x3 = 16 samples

#### 9.18.1.9 CLIF\_SIGPRO\_IIR\_CONFIG0 (0x2A)

This register provides the settings for CLIF\_SIGPRO\_IIR\_CONFIG0

Table 24. CLIF\_SIGPRO\_IIR\_CONFIG0 (0x2A) register bit description

Bit	Symbol	Access	Value	Description
[31:20]	RESERVED	r-	0x0	Reserved
[19:19]	IIR_SIGN_A2	rw	0x0	IIR A1 sign
[18:12]	IIR_COEF_A2	rw	0x0	IIR A1 coef (unsigned, MSB unused) Value is coded value/64
[11:11]	IIR_SIGN_A1	rw	0x0	IIR A0 sign

Table 24. CLIF\_SIGPRO\_IIR\_CONFIG0 (0x2A) register bit description...continued

Bit	Symbol	Access	Value	Description
[10:4]	IIR_COEF_A1	rw	0x0	IIR A0 coef (unsigned, MSB unused) Value is coded value/64
[3:1]	IIR_GAIN	rw	0x0	IIR filter gain
[0:0]	IIR_ENABLE	rw	0x0	Enable the IIR filter

#### 9.18.1.10 CLIF\_DGRM\_BBA (0x2D)

This register provides the settings for CLIF\_DGRM\_BBA

Table 25. CLIF\_DGRM\_BBA (0x2D) register bit description

Bit	Symbol	Access	Value	Description
[31:30]	DGRM_FALSE_ALARM_WAIT	rw	0x0	False alarm wait in multiples of 256 cycles
[29:29]	DGRM_BBA_FAST_MODE_ENABLE	rw	0x0	Enables the BBA fast mode
[28:26]	DGRM_GAIN_SHIFT_DELAY	rw	0x0	Defines the delay for digital gain compensation to match the latency from BBA gain
[25:24]	DGRM_BBA_TH_SEL	rw	0x0	Defines the threshold for the max absolute ADC value
[23:22]	DGRM_MAX_SWING_TH_SEL	rw	0x0	Defines the maximum swing threshold for decreasing BBA gain
[21:20]	DGRM_MIN_SWING_TH_SEL	rw	0x0	Defines the minimum swing threshold for increasing BBA gain
[19:18]	DGRM_WATER_LEVEL_TH_SEL	rw	0x0	Defines the water level threshold
[17:17]	RESERVED	rw	0x0	RESERVED
[16:14]	DGRM_BBA_MIN_VAL	rw	0x0	Defines the minimum value of BBA gain.
[13:11]	DGRM_BBA_MAX_VAL	rw	0x0	Defines the maximum value of BBA gain.
[10:8]	DGRM_BBA_INIT_VAL	rw	0x0	Defines initial value of BBA gain. If BBA fast and slow modes are disabled, this value defines the forced value.
[7:7]	DGRM_GUESS_BBA_GAIN_ENABLE	rw	0x0	Enables the initial guess of BBA gain based on noise power estimate
[5:5]	DGRM_NOISE_POWER_EST_ENABLE	rw	0x0	Enables the noise power estimator in free running mode
[4:2]	DGRM_NOISE_POWER_SHIFT_VAL	rw	0x0	Defines the number of bits to shift right in order to scale the noise power. This is in addition to the scaling due to accumulation
[1:0]	RESERVED	r-	0x0	Reserved

9.18.1.11 CLIF\_DGRM\_DCO (0x2E)

This register provides the settings for CLIF\_DGRM\_DCO

Table 26. CLIF\_DGRM\_DCO (0x2E) register bit description

Bit	Symbol	Access	Value	Description
[31:30]	DGRM_DCO_TRACK_AVG_LEN_SEL	rw	0x0	Defines the number of ADC samples to average during TRACK mode
[29:28]	DGRM_DCO_INIT_AVG_LEN_SEL	rw	0x0	Defines the number of ADC samples to average during INIT mode
[27:26]	DGRM_DCO_WAIT_PERIOD_SEL	rw	0x0	Defines the wait period after DCO DAC update and before estimating DCO
[25:24]	DGRM_DCO_TH_SEL	rw	0x0	Defines the DCO DAC threshold
[23:22]	DGRM_DCO_MAX_ITER_SEL	rw	0x0	Defines the maximum number of iterations in DCO DAC fast mode
[21:21]	DGRM_DCO_DAC_SLOW_MODE_ENABLE	rw	0x0	Enables DCO DAC slow mode before card response.
[20:20]	DGRM_DCO_DAC_FAST_MODE_ENABLE	rw	0x0	Enables DCO DAC fast mode
[19:10]	DGRM_DCO_DAC_Q_INIT_VAL	rw	0x0	Defines the initial value of the composite DAC for the Q channel. This is also the forced value if DCO DAC fast and slow modes are disabled. The 5 MSBs control the coarse DAC and the 5 MSBs control the fine DAC.
[9:0]	DGRM_DCO_DAC_I_INIT_VAL	rw	0x0	Defines the initial value of the composite DAC for the I channel. This is also the forced value if DCO DAC fast and slow modes are disabled. The 5 MSBs control the coarse DAC and the 5 MSBs control the fine DAC.

## 9.18.1.12 CLIF\_DGRM\_RSSI (0x30)

This register provides the settings for CLIF\_DGRM\_RSSI

Table 27. CLIF\_DGRM\_RSSI (0x30) register bit description

Bit	Symbol	Access	Value	Description
[31:31]	DGRM_DEMOD_EN_FORCE	rw	0x0	When set, forces demod_enable high
[30:30]	DGRM_NUM_GAIN_UPDT_FORCE	rw	0x0	When set, forces dgrm_num_gain_updt to be zero
[29:29]	DGRM_SIGNAL_DETECT_TH_OVR	rw	0x0	Enables the override of signal detect threshold. Override value is set based on DGRM_SIGNAL_DETECT_TH_OVR_VAL.
[28:27]	DGRM_RSSI_TRACK_AVG_LEN_SEL	rw	0x0	Defines the number of RSSI samples to average during track mode
[26:25]	DGRM_RSSI_INIT_AVG_LEN_SEL	rw	0x0	Defines the number of RSSI samples to average during INIT mode
[24:23]	DGRM_RSSI_WAIT_PERIOD	rw	0x0	Defines the number of RSSI samples to discard before averaging
[22:17]	DGRM_RSSI_HYST	rw	0x0	Hysteresis value for RSSI target
[16:7]	DGRM_RSSI_TARGET	rw	0x0	RSSI target value
[6:0]	DGRM_SIGNAL_DETECT_TH_OVR_VAL	rw	0x0	Defines the override value for signal detect threshold. when DGRM_SIGNAL_DETECT_TH_OVR is set. These bits are modified dynamically by the ARC algorithm based on the DPC voltage. Only if the ARC is disabled, the value written during LOAD_RF_CONFIGURATION(0x0D) is retained throughout the RF Field session

## 9.18.1.13 CLIF\_CRC\_RX\_CONFIG (0x31)

This register provides the settings for CLIF\_CRC\_RX\_CONFIG

Table 28. CLIF\_CRC\_RX\_CONFIG (0x31) register bit description

Bit	Symbol	Access	Value	Description
[31:16]	RX_CRC_PRESET_VALUE	rw	0x0	Arbitrary preset value for the Rx-Decoder CRC calculation.
[15:8]	RESERVED	r-	0x0	Reserved
[7:7]	RX_FORCE_CRC_WRITE	rw	0x0	If set, the Rx-Decoder will send to the RAM the CRC bits as well.
[6:6]	RX_CRC_ALLOW_BITS	rw	0x0	If activated the frame with length less than or equal CRC_length will be always sent to the System RAM as is, without CRC bits removal.
[5:3]	RX_CRC_PRESET_SEL	rw	0x000	Preset value of the CRC register for the Rx-Decoder. For a CRC calculation using 5bits only the LSByte is used.
			000b	000b -> 0000h reset value Note that this configuration is set by the Mode detector for FeliCa.
			001b	001b -> 6363h Note that this configuration is set by the Mode detector for ISO14443 type A.
			010b	010b -> A671h
			011b	011b -> FFFFh Note that this configuration is set by the Mode detector for ISO14443 type B
			100b	100b -> 0012h
			101b	101b -> E012h
			110b	110b -> RFU
			111b	111b -> Use arbitrary preset value RX_CRC_PRESET_VALUE
[2:2]	RX_CRC_TYPE	rw	0x0	Controls the type of CRC calculation for the Rx Decoder 0* 16-bit CRC calc
[1:1]	RX_CRC_INV	rw	0x0	Controls the comparison of the CRC checksum for the Rx-Decoder 0* Not inverted CRC value: 0000h reset value Note that this nit is cleared by the Mode detector for ISO14443 type A and FeliCa. 1 Inverted CRC value: F0B8h Note that this bit is set by the Mode detector for ISO14443 type B.
[0:0]	RX_CRC_ENABLE	rw	0x0	If set, the Rx-Decoder will check the CRC for correctness. Note that this bit is set by the Mode Detector when ISO14443 type B. or FeliCa (212 kBd or 424 kBd) is detected.

#### 9.18.1.14 CLIF\_RX\_WAIT (0x32)

This register provides the settings for CLIF\_RX\_WAIT

Table 29. CLIF\_RX\_WAIT (0x32) register bit description

Bit	Symbol	Access	Value	Description
[31:28]	RESERVED	r-	0x0	Reserved
[27:8]	RX_WAIT_VALUE	rw	0x0	Defines the rx_wait timer reload value. Note: If set to 00000h the rx_wait guard time is disabled
[7:0]	RX_WAIT_PRESCALER	rw	0x0	Defines the prescaler reload value for the rx_wait timer.

#### 9.18.1.15 CLIF\_SS\_TX1\_CMCFG (0x3B)

This register provides the settings for CLIF\_SS\_TX1\_CMCFG

Table 30. CLIF\_SS\_TX1\_CMCFG (0x3B) register bit description

Bit	Symbol	Access	Value	Description
[31:22]	RESERVED	r-	0x00	Reserved
[21:19]	TX1_CLK_MODE_MOD_CM	rw	0x00	TX1 clock mode of modulated wave in CM
[18:16]	TX1_CLK_MODE_CW_CM	rw	0x00	TX1 clock mode of unmodulated wave in CM
[15:8]	TX1_AMP_MOD_CM	rw	0x00	TX1 amplitude of modulated wave in CM
[7:0]	TX1_AMP_CW_CM	rw	0xFF	TX1 amplitude of unmodulated wave in CM

#### 9.18.1.16 CLIF\_TIMER1\_CONFIG (0x3F)

This register provides the settings for CLIF\_TIMER1\_CONFIG

Table 31. CLIF\_TIMER1\_CONFIG (0x3F) register bit description

Bit	Symbol	Access	Value	Description
[31:31]	RESERVED	r-	0x0	Reserved
[30:30]	T1_STOP_ON_RX_STARTED	rw	0x0	T1_STOP_EVENT: If set, the timer T1 is stopped when a data reception begins (1 <sup>st</sup> bit is received).
[29:29]	T1_STOP_ON_TX_STARTED	rw	0x0	T1_STOP_EVENT: If set, the timer T1 is stopped when a data transmission begins.
[28:28]	T1_STOP_ON_RF_ON_EXT	rw	0x0	T1_STOP_EVENT: If set, the timer T1 is stopped when the external RF field is detected.
[27:27]	T1_STOP_ON_RF_OFF_EXT	rw	0x0	T1_STOP_EVENT: If set, the timer T1 is stopped when the external RF field vanishes.
[26:26]	T1_STOP_ON_RF_ON_INT	rw	0x0	T1_STOP_EVENT: If set, the timer T1 is stopped when the internal RF field is turned on.
[25:25]	T1_STOP_ON_RF_OFF_INT	rw	0x0	T1_STOP_EVENT: If set, the timer T1 is stopped when the internal RF field is turned off.
[24:24]	T1_STOP_ON_RX_ENDED	rw	0x0	T1_STOP_EVENT: If set the timer T1 is stopped when an activity on RX is detected.
[23:18]	RESERVED	r-	0x0	Reserved



Table 31. CLIF\_TIMER1\_CONFIG (0x3F) register bit description...continued

Bit	Symbol	Access	Value	Description
[17:17]	T1_START_ON_RX_STARTED	rw	0x0	T1_START_EVENT: If set. the timer T1 is started when a data reception begins (1st bit is received).
[16:16]	T1_START_ON_RX_ENDED	rw	0x0	T1_START_EVENT: If set. the timer T1 is started when a data reception ends.
[15:15]	T1_START_ON_TX_STARTED	rw	0x0	T1_START_EVENT: If set. the timer T1 is started when a data transmission begins.
[14:14]	T1_START_ON_TX_ENDED	rw	0x0	T1_START_EVENT: If set. the timer T1 is started when a data transmission ends.
[13:13]	T1_START_ON_RF_ON_EXT	rw	0x0	T1_START_EVENT: If set. the timer T1 is started when the external RF field is detected.
[12:12]	T1_START_ON_RF_OFF_EXT	rw	0x0	T1_START_EVENT: If set. the timer T1 is started when the external RF field is not detected any more.
[11:11]	T1_START_ON_RF_ON_INT	rw	0x0	T1_START_EVENT: If set. the timer T1 is started when an internal RF field is turned on.
[10:10]	T1_START_ON_RF_OFF_INT	rw	0x0	T1_START_EVENT: If set. the timer T1 is started when an internal RF field is turned off.
[8:8]	T1_START_NOW	rw	0x0	T1_START_EVENT: If set. the timer T1 is started immediately.
[7:7]	RESERVED	r-	0x0	Reserved
[6:6]	T1_ONE_SHOT_MODE	rw	0x00	When set to 1 the counter value does not reload again until the counter value has reached zero
[5:3]	T1_PRESCALE_SEL	rw	0x00	Controls input frequency/period of the timer T0 when the prescaler is activated in T1_MODE_SEL.
			000b	000b -> 6.78 MHz counter
			001b	001b -> 3.39 MHz counter
			010b	010b -> 1.70 MHz counter
			011b	011b -> 848 kHz counter
			100b	100b -> 424 kHz counter
			101b	101b -> 212 kHz counter
			110b	110b -> 106 kHz counter
			111b	111b -> 53 kHz counter
[2:2]	T1_MODE_SEL	rw	0x00*	Configuration of the timer T1 clock.
			0b	Prescaler is disabled: the timer frequency matches CLIF clock frequency (13.56MHz).
			1b	Prescaler is enabled: the timer operates on the prescaler signal frequency (chosen by T1_PRESCALE_SEL).
[1:1]	T1_RELOAD_ENABLE	rw	0x00*	If set to 0 the timer T1 will stop on expiration.
			0b	After expiration the timer T1 will stop counting. i.e.. remain zero. reset value.
			1b	After expiration the timer T1 will reload its preset value and continue counting down.

Table 31. CLIF\_TIMER1\_CONFIG (0x3F) register bit description...continued

Bit	Symbol	Access	Value	Description
[0:0]	T1_ENABLE	rw	0x0	Enables the timer T1

#### 9.18.1.17 CLIF\_TIMER1\_RELOAD (0x40)

This register provides the settings for CLIF\_TIMER1\_RELOAD

Table 32. CLIF\_TIMER1\_RELOAD (0x40) register bit description

Bit	Symbol	Access	Value	Description
[31:20]	RESERVED	r-	0x0	Reserved
[19:0]	T1_RELOAD_VALUE	rw	0x0000	Reload value of the timer T1.

#### 9.18.1.18 TXLDO\_VDDPA\_CONFIG (0x54)

This register provides the settings for TXLDO\_VDDPA\_CONFIG

Table 33. TXLDO\_VDDPA\_CONFIG (0x54) register bit description

Bit	Symbol	Access	Value	Description
[31:8]	RESERVED	rw		Reserved
[7:0]	VDDPA_CONFIG	rw		VDDPALDO output voltage VDDPA_1V50

#### 9.18.1.19 TXLDO\_VOUT\_CURR (0x56)

This register provides the settings for TXLDO\_VOUT\_CURR

Table 34. TXLDO\_VOUT\_CURR (0x56) register bit description

Bit	Symbol	Access	Value	Description
[23:8]	TXLDO_CURRENT	r-		Indicates the TXLDO Current, measured value is indicated in mA (1 bit = 1 mA)
[7:0]	VDDPA_VOUT	r-		VDDPALDO output voltage VDDPA_1V50

#### 9.18.1.20 CLIF\_RXM\_FREQ (0x59)

This register provides the settings for CLIF\_RXM\_FREQ

Table 35. CLIF\_RXM\_FREQ (0x59) register bit description

Bit	Symbol	Access	Value	Description
[31:31]	RXM_FREQ_VALID	r-	0x00	CLIF_RXM_FREQ_REG fields are valid
[30:25]	RESERVED	r-	0x00	Reserved
[24:16]	RXM_FREQ	r-	0x00	frequency difference between the last two consecutive measures at 1.7 MHz (multiple of 13.56 MHz/4096). Signed. 2-Complement coded.
[15:9]	RESERVED	r-	0x00	Reserved
[8:0]	RXM_PHASE	r-	0x00	phase value

**9.18.1.21 INTERPOLATED\_RSSI\_REG (0x5C)**

This register provides the settings for INTERPOLATED\_RSSI\_REG

**Table 36. INTERPOLATED\_RSSI\_REG (0x5C) register bit description**

Bit	Symbol	Access	Value	Description
[31:0]	INTERPOLATED_RSSI	r-		Calculated Interpolated RSSI

**9.18.1.22 TX\_NOV\_CALIBRATE\_AND\_STORE\_VAL\_REG (0x5D)**

This register provides the settings for TX\_NOV\_CALIBRATE\_AND\_STORE\_VAL\_REG

**Table 37. TX\_NOV\_CALIBRATE\_AND\_STORE\_VAL\_REG (0x5D) register bit description**

Bit	Symbol	Access	Value	Description
[31:2]	RFU	rw		Reserved
[1:0]	TX_NOV_CALIBRATE_STORE	rw		Perform TX_NOV Calibration and store in User Area

**9.18.1.23 CLIF\_SS\_TX1\_RTRANS0 (0x80)**

This register provides the settings for CLIF\_SS\_TX1\_RTRANS0

**Table 38. CLIF\_SS\_TX1\_RTRANS0 (0x80) register bit description**

Bit	Symbol	Access	Value	Description
[31:24]	TX1_SS_RTRANS3	rw	0x00	TX1 rising transition value 3
[23:16]	TX1_SS_RTRANS2	rw	0x00	TX1 rising transition value 2
[15:8]	TX1_SS_RTRANS1	rw	0x00	TX1 rising transition value 1
[7:0]	TX1_SS_RTRANS0	rw	0x00	TX1 rising transition value 0

**9.18.1.24 CLIF\_SS\_TX1\_RTRANS1 (0x81)**

This register provides the settings for CLIF\_SS\_TX1\_RTRANS1

**Table 39. CLIF\_SS\_TX1\_RTRANS1 (0x81) register bit description**

Bit	Symbol	Access	Value	Description
[31:24]	TX1_SS_RTRANS7	rw	0x00	TX1 rising transition value 7
[23:16]	TX1_SS_RTRANS6	rw	0x00	TX1 rising transition value 6
[15:8]	TX1_SS_RTRANS5	rw	0x00	TX1 rising transition value 5
[7:0]	TX1_SS_RTRANS4	rw	0x00	TX1 rising transition value 4

**9.18.1.25 CLIF\_SS\_TX1\_RTRANS2 (0x82)**

This register provides the settings for CLIF\_SS\_TX1\_RTRANS2

**Table 40. CLIF\_SS\_TX1\_RTRANS2 (0x82) register bit description**

Bit	Symbol	Access	Value	Description
[31:24]	TX1_SS_RTRANS11	rw	0x00	TX1 rising transition value 11
[23:16]	TX1_SS_RTRANS10	rw	0x00	TX1 rising transition value 10

Table 40. CLIF\_SS\_TX1\_RTRANS2 (0x82) register bit description...continued

Bit	Symbol	Access	Value	Description
[15:8]	TX1_SS_RTRANS9	rw	0x00	TX1 rising transition value 9
[7:0]	TX1_SS_RTRANS8	rw	0x00	TX1 rising transition value 8

**9.18.1.26 CLIF\_SS\_TX1\_RTRANS3 (0x83)**

This register provides the settings for CLIF\_SS\_TX1\_RTRANS3

Table 41. CLIF\_SS\_TX1\_RTRANS3 (0x83) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX1_SS_RTRANS15	rw	0x00	TX1 rising transition value 15
[23:16]	TX1_SS_RTRANS14	rw	0x00	TX1 rising transition value 14
[15:8]	TX1_SS_RTRANS13	rw	0x00	TX1 rising transition value 13
[7:0]	TX1_SS_RTRANS12	rw	0x00	TX1 rising transition value 12

**9.18.1.27 CLIF\_SS\_TX2\_RTRANS0 (0x84)**

This register provides the settings for CLIF\_SS\_TX2\_RTRANS0

Table 42. CLIF\_SS\_TX2\_RTRANS0 (0x84) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX2_SS_RTRANS3	rw	0x00	TX2 rising transition value 3
[23:16]	TX2_SS_RTRANS2	rw	0x00	TX2 rising transition value 2
[15:8]	TX2_SS_RTRANS1	rw	0x00	TX2 rising transition value 1
[7:0]	TX2_SS_RTRANS0	rw	0x00	TX2 rising transition value 0

**9.18.1.28 CLIF\_SS\_TX2\_RTRANS1 (0x85)**

This register provides the settings for CLIF\_SS\_TX2\_RTRANS1

Table 43. CLIF\_SS\_TX2\_RTRANS1 (0x85) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX2_SS_RTRANS7	rw	0x00	TX2 rising transition value 7
[23:16]	TX2_SS_RTRANS6	rw	0x00	TX2 rising transition value 6
[15:8]	TX2_SS_RTRANS5	rw	0x00	TX2 rising transition value 5
[7:0]	TX2_SS_RTRANS4	rw	0x00	TX2 rising transition value 4

**9.18.1.29 CLIF\_SS\_TX2\_RTRANS2 (0x86)**

This register provides the settings for CLIF\_SS\_TX2\_RTRANS2

Table 44. CLIF\_SS\_TX2\_RTRANS2 (0x86) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX2_SS_RTRANS11	rw	0x00	TX2 rising transition value 11
[23:16]	TX2_SS_RTRANS10	rw	0x00	TX2 rising transition value 10

Table 44. CLIF\_SS\_TX2\_RTRANS2 (0x86) register bit description...continued

Bit	Symbol	Access	Value	Description
[15:8]	TX2_SS_RTRANS9	rw	0x00	TX2 rising transition value 9
[7:0]	TX2_SS_RTRANS8	rw	0x00	TX2 rising transition value 8

### 9.18.1.30 CLIF\_SS\_TX2\_RTRANS3 (0x87)

This register provides the settings for CLIF\_SS\_TX2\_RTRANS3

Table 45. CLIF\_SS\_TX2\_RTRANS3 (0x87) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX2_SS_RTRANS15	rw	0x00	TX2 rising transition value 15
[23:16]	TX2_SS_RTRANS14	rw	0x00	TX2 rising transition value 14
[15:8]	TX2_SS_RTRANS13	rw	0x00	TX2 rising transition value 13
[7:0]	TX2_SS_RTRANS12	rw	0x00	TX2 rising transition value 12

### 9.18.1.31 CLIF\_SS\_TX1\_FTRANS0 (0x88)

This register provides the settings for CLIF\_SS\_TX1\_FTRANS0

Table 46. CLIF\_SS\_TX1\_FTRANS0 (0x88) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX1_SS_FTRANS3	rw	0x00	TX1 falling transition value 3
[23:16]	TX1_SS_FTRANS2	rw	0x00	TX1 falling transition value 2
[15:8]	TX1_SS_FTRANS1	rw	0x00	TX1 falling transition value 1
[7:0]	TX1_SS_FTRANS0	rw	0x00	TX1 falling transition value 0

### 9.18.1.32 CLIF\_SS\_TX1\_FTRANS1 (0x89)

This register provides the settings for CLIF\_SS\_TX1\_FTRANS1

Table 47. CLIF\_SS\_TX1\_FTRANS1 (0x89) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX1_SS_FTRANS7	rw	0x00	TX1 falling transition value 7
[23:16]	TX1_SS_FTRANS6	rw	0x00	TX1 falling transition value 6
[15:8]	TX1_SS_FTRANS5	rw	0x00	TX1 falling transition value 5
[7:0]	TX1_SS_FTRANS4	rw	0x00	TX1 falling transition value 4

### 9.18.1.33 CLIF\_SS\_TX1\_FTRANS2 (0x8A)

This register provides the settings for CLIF\_SS\_TX1\_FTRANS2

Table 48. CLIF\_SS\_TX1\_FTRANS2 (0x8A) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX1_SS_FTRANS11	rw	0x00	TX1 falling transition value 11
[23:16]	TX1_SS_FTRANS10	rw	0x00	TX1 falling transition value 10

Table 48. CLIF\_SS\_TX1\_FTRANS2 (0x8A) register bit description...continued

Bit	Symbol	Access	Value	Description
[15:8]	TX1_SS_FTRANS9	rw	0x00	TX1 falling transition value 9
[7:0]	TX1_SS_FTRANS8	rw	0x00	TX1 falling transition value 8

**9.18.1.34 CLIF\_SS\_TX1\_FTRANS3 (0x8B)**

This register provides the settings for CLIF\_SS\_TX1\_FTRANS3

Table 49. CLIF\_SS\_TX1\_FTRANS3 (0x8B) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX1_SS_FTRANS15	rw	0x00	TX1 falling transition value 15
[23:16]	TX1_SS_FTRANS14	rw	0x00	TX1 falling transition value 14
[15:8]	TX1_SS_FTRANS13	rw	0x00	TX1 falling transition value 13
[7:0]	TX1_SS_FTRANS12	rw	0x00	TX1 falling transition value 12

**9.18.1.35 CLIF\_SS\_TX2\_FTRANS0 (0x8C)**

This register provides the settings for CLIF\_SS\_TX2\_FTRANS0

Table 50. CLIF\_SS\_TX2\_FTRANS0 (0x8C) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX2_SS_FTRANS3	rw	0x00	TX2 falling transition value 3
[23:16]	TX2_SS_FTRANS2	rw	0x00	TX2 falling transition value 2
[15:8]	TX2_SS_FTRANS1	rw	0x00	TX2 falling transition value 1
[7:0]	TX2_SS_FTRANS0	rw	0x00	TX2 falling transition value 0

**9.18.1.36 CLIF\_SS\_TX2\_FTRANS1 (0x8D)**

This register provides the settings for CLIF\_SS\_TX2\_FTRANS1

Table 51. CLIF\_SS\_TX2\_FTRANS1 (0x8D) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX2_SS_FTRANS7	rw	0x00	TX2 falling transition value 7
[23:16]	TX2_SS_FTRANS6	rw	0x00	TX2 falling transition value 6
[15:8]	TX2_SS_FTRANS5	rw	0x00	TX2 falling transition value 5
[7:0]	TX2_SS_FTRANS4	rw	0x00	TX2 falling transition value 4

**9.18.1.37 CLIF\_SS\_TX2\_FTRANS2 (0x8E)**

This register provides the settings for CLIF\_SS\_TX2\_FTRANS2

Table 52. CLIF\_SS\_TX2\_FTRANS2 (0x8E) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX2_SS_FTRANS11	rw	0x00	TX2 falling transition value 11
[23:16]	TX2_SS_FTRANS10	rw	0x00	TX2 falling transition value 10

Table 52. CLIF\_SS\_TX2\_FTRANS2 (0x8E) register bit description...continued

Bit	Symbol	Access	Value	Description
[15:8]	TX2_SS_FTRANS9	rw	0x00	TX2 falling transition value 9
[7:0]	TX2_SS_FTRANS8	rw	0x00	TX2 falling transition value 8

9.18.1.38 CLIF\_SS\_TX2\_FTRANS3 (0x8F)

This register provides the settings for CLIF\_SS\_TX2\_FTRANS3

Table 53. CLIF\_SS\_TX2\_FTRANS3 (0x8F) register bit description

Bit	Symbol	Access	Value	Description
[31:24]	TX2_SS_FTRANS15	rw	0x00	TX2 falling transition value 15
[23:16]	TX2_SS_FTRANS14	rw	0x00	TX2 falling transition value 14
[15:8]	TX2_SS_FTRANS13	rw	0x00	TX2 falling transition value 13
[7:0]	TX2_SS_FTRANS12	rw	0x00	TX2 falling transition value 12

### 9.18.2 EEPROM configuration description

The settings done in EEPROM are used for basic configuration which does not change frequently. Typically it is performed once during trimming or configuration of a product. The EEPROM has a limited number of erase/write cycles that can be performed. This means, that configurations that change frequently must be performed in standard registers which do not keep their value during reset and power off.

This section describes the EEPROM configuration of the PN7220.

**Writing to the EEPROM has to be performed with Read-Modify-Write for all memory addresses which contain RFU bits.**

#### 9.18.2.1 EEPROM configuration for power, TXLDO, XTAL and clocks

This section provides the configuration of different EEPROM parameters for the system.

##### 9.18.2.1.1 List of EEPROM configuration parameters for power, TXLDO, XTAL and clocks

Table 54. List of EEPROM configuration parameters for power, TXLDO, XTAL and Clocks

Configuration Parameter	Address (Hex)	Address (Decimal)	Size (in bytes)	EEPROM_AREA
<a href="#">DCDC_PWR_CONFIG (0x0000)</a>	0x0000	0	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">Section 9.18.2.1.3 DCDC_CONFIG (0x0001)</a>	0x0001	1	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TXLDO_CONFIG (0x0002)</a>	0x0002	2	4	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TXLDO_VDDPA_CONFIG (0x0006)</a>	0x0006	6	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TXLDO_VDDPA_MAX_RDR (0x0007)</a>	0x0007	7	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TXLDO_VDDPA_MAX_CARD (0x0008)</a>	0x0008	8	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">BOOST_DEFAULT_VOLTAGE (0x0009)</a>	0x0009	9	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">XTAL_CONFIG (0x000F)</a>	0x000F	15	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">XTAL_TIMEOUT (0x0010)</a>	0x0010	16	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">CLK_INPUT_FREQ (0x0011)</a>	0x0011	17	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">XTAL_CHECK_DELAY (0x0012)</a>	0x0012	18	1	E_PN76_EEPROM_SECURE_LIB_CONFIG



## 9.18.2.1.2 DCDC\_PWR\_CONFIG (0x0000)

Configuration for power.

Table 55. DCDC\_PWR\_CONFIG (0x0000)

Function	bit	Values	Description
DC-DC usage in card mode	[7]	0x00	DC-DC is not powered and set to bypass
		0x01	DC-DC is powered and not bypassed
DC-DC usage in reader mode	[6]	0x00	DC-DC is not powered and set to bypass
		0x01	DC-DC is powered and not bypassed
RFU	[5]		Do not touch. Default value is 0x01
VUP input voltage	[4:0]	0x00	Not connected or 0 V
		0x01	No DC-DC and internal VDDPA_LDO: VUP supplied by VBAT / VBATPWR (pin VUP_TX connected to VBAT/VBATPWR)
		0x02	Internal DC-DC: with auto by pass and variable boost w.r.t VDDPA (internal DPC controls VDDBOOST): DC-DC goes into pass through mode when the VDDPA goes below 3.3 V. When VDDPA is greater than 3.3 V, the DC-DC is configured to boost voltage in range of 3.3 V to 6 V. Internal DC-DC: with fixed VDDBOOST
		0x05 - 0x09	RFU
		0x10	No DC-DC and internal VDDPA_LDO: VUP supplied by external LDO (not connected to VBAT)

## 9.18.2.1.3 DCDC\_CONFIG (0x0001)

DCDC Configuration

Table 56. DCDC\_CONFIG (0x0001)

Function	bit	Values	Description
RFU	[7:5]		Reserved
DC-DC pass through feature	[4]	0x00	DC-DC pass through feature is not supported ( $V_{out} = 0\text{ V}$ or $5\text{ V}$ )
		0x01	DC-DC pass through feature is supported ( $V_{out} = 0\text{ V}$ or $5\text{ V}$ )
DC-DC for LPCD (Not ULPCD)	[3]	0x00	Use of DC-DC for LPCD disabled (Not ULPCD)
		0x01	Use of DC-DC for LPCD enabled (Not ULPCD)
RFU	[2:0]		Reserved

## 9.18.2.1.4 TXLDO\_CONFIG (0x0002)

Table 57. TXLDO\_CONFIG (0x0002)

Function	bit	Values	Description
RFU	[31:2]		Reserved
Overcurrent protection	[1]	0x00	Overcurrent protection feature disabled
		0x01	Overcurrent protection feature enabled
Enable Tx-LDO	[0]	0x00	TxLDO is disabled. No voltage output of the TxLDO
		0x01	TxLDO is enabled. Regulated voltage output of the TxLDO
RFU	[2:0]		Reserved

## 9.18.2.1.5 TXLDO\_VDDPA\_CONFIG (0x0006)

Table 58. TXLDO\_VDDPA\_CONFIG (0x0006)

Function	bit	Values	Description
VDDPA voltage level	[7:0]	0x00 - 0x2A	Value 0 indicates 1.5 V. Further VDDPA voltage would be $1.5\text{ V} + 0.1\text{ V} \times \text{this parameter value}$ . Maximum value of 0x2A indicates for 5.7 V

## 9.18.2.1.6 TXLDO\_VDDPA\_MAX\_RDR\_NFC\_FORUM (0x0007)

Table 59. TXLDO\_VDDPA\_MAX\_RDR\_NFC\_FORUM (0x0007)

Function	bit	Values	Description
VDDPA max voltage level	[7:0]	0x00 - 0x2A	Value 0 indicates 1.5 V. Further VDDPA voltage would be $1.5 + 0.1\text{ V} \times \text{this parameter value}$ . Maximum value of 0x2A indicates for 5.7 V

## 9.18.2.1.7 TXLDO\_VDDPA\_MAX\_RDR\_EMVCo (0x06A6)

Table 60. TXLDO\_VDDPA\_MAX\_RDR\_EMVCo (0x06A6)

Function	bit	Values	Description
VDDPA max voltage level	[7:0]	0x00 - 0x2A	Value 0 indicates 1.5 V. Further VDDPA voltage would be $1.5 + 0.1\text{ V} \times \text{this parameter value}$ . Maximum value of 0x2A indicates for 5.7 V

## 9.18.2.1.8 TXLDO\_VDDPA\_MAX\_CARD (0x0008)

Table 61. TXLDO\_VDDPA\_MAX\_CARD (0x0008)

Function	bit	Values	Description
VDDPA max voltage level	[7:0]	0x00 - 0x2A	Value 0 indicates 1.5 V. Further VDDPA voltage would be $1.5 + 0.1\text{ V} \times \text{this parameter value}$ . Maximum value of 0x2A indicates for 5.7 V

### 9.18.2.1.9 BOOST\_DEFAULT\_VOLTAGE (0x0009)

Table 62. BOOST\_DEFAULT\_VOLTAGE (0x0009)

Function	bit	Values	Description
VDDBOOST output voltage	[7:0]	0x00 - 0x1D	Value 0 indicates 3.1 V. Further VDDBOOST voltage would be $3.1\text{ V} + 0.1\text{ V} \times \text{this parameter value}$ . Maximum value of 0x1D indicates for 6 V
		Other values	RFU

### 9.18.2.1.10 XTAL\_CONFIG (0x000F)

Configuration for the XTAL startup procedure

Table 63. XTAL\_CONFIG (0x000F)

Function	bit	Values	Description
RFU	[7:1]		RFU
XTAL startup procedure	[0]	0x00	disable Crystal recalibration start after wake-up
		0x01	enable Crystal recalibration start after wake-up

### 9.18.2.1.11 XTAL\_TIMEOUT (0x0010)

Timeout for XTAL to be ready

Table 64. XTAL\_TIMEOUT (0x0010)

Function	bit	Values	Description
Configuration for XTAL startup procedure	[7:0]		Timeout for XTAL to be ready (in $\times 128\text{ }\mu\text{s}$ ). This configuration does not speed up the boot time.

### 9.18.2.1.12 XTAL\_DELAY (06B8h)

Used to configure the crystal start and stop timings.

Table 65. XTAL\_DELAY (address 06B8h) EEPROM configuration bit description

Address (hex)	Function	Bit	Description
06B8	XTAL_Delay	7:0	Configurable wait time to start the XTAL. 1 unit = 128 microsecond Total delay = Unit x 50 loops Default value = 1 = 6.4 millisecond
06B9	Delay-To-OFF	7:0	Delay before shutting down the LDO. After DCDC shutdown, when DPC is enabled to allow the cap on the LDO to discharge. 1 unit = 128 microsecond Default value = 1 = 128 microsecond
06BA	-	7:0	RFU
06BB	-	7:0	RFU

### 9.18.2.1.13 CLK\_INPUT\_FREQ (0x0011)

Configuration for the PLL input clock frequency

Table 66. CLK\_INPUT\_FREQ (0x0011)

Function	bit	Values	Description
RFU	[7:4]		RFU
PLL clock configuration	[3:0]	0x00	RFU
		0x01	RFU
		0x02	19,2 MHz - Low RF performance can be expected using this external clock frequency.
		0x03	24 MHz
		0x04	32 MHz
		0x05	48 MHz - Acceptable RF performance can be achieved using this external clock frequency.
		0x06	RFU
		0x07	RFU
		0x08	XTAL 27.12 MHz - Best RF Performance - Recommended for EMVCo compliant applications
		others	RFU

9.18.2.1.14 XTAL\_CHECK\_DELAY (0x0012)

Table 67. XTAL\_CHECK\_DELAY (0x0012)

Function	bit	Values	Description
RFRetry_numberU	[7:5]		Max Number of retries before a clock error is raised
Interval	[4:0]		Interval which is used to check if XTAL is ready (unit is 256/fc, e.g. ~18.8 μs). This is the time to try to lock the PLL, a stable crystal clock is required for locking. If the PLL is not locked, a next retry to lock the PLL will be done after this interval. This value can be used to optimize the startup time dependent on the crystal characteristics. This is important, e.g., for optimization of the LPCD and ULPCD.

9.18.2.1.15 VDDPA\_DISCHARGE (0x050D)

enable/disable fast VDDPA Discharge

Table 68. VDDPA\_DISCHARGE (0x050D)

Function	bits	Values	Description
RFU	[7:1]		Reserved
EnableFast VDDPADischarge	[0]	0x00	Disables fast discharge of VDDPA by setting VDDPA = 5.7 V and then to 1.5 V, during RF OFF
		0x01	Enables fast discharge of VDDPA by setting VDDPA = 5.7 V and then to 1.5 V, during RF OFF (default)

9.18.2.2 RM\_TX\_SHAPING - TX wave shaping for passive reader mode

This section provides the TX shaping for different type of cards in passive reader mode.

9.18.2.2.1 TX wave shaping for TypeA passive reader mode for all baud-rates.

This section provides the TX shaping for TypeA passive reader mode.

9.18.2.2.1.1 RESIDUAL\_AMPL\_LEVEL\_A106 (0x0014)

Residual amplitude level for A106

Table 69. RESIDUAL\_AMPL\_LEVEL\_A106 (0x0014)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.1.2 EDGE\_TYPE\_A106 (0x0015)

Edge type for A106

Table 70. EDGE\_TYPE\_A106 (0x0015)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

### 9.18.2.2.1.3 EDGE\_STYLE\_A106 (0x0016)

Time constant Edge style configuration for A106

Table 71. EDGE\_STYLE\_A106 (0x0016)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_A106 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A106 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_A106 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A106 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

### 9.18.2.2.1.4 EDGE\_LENGTH\_A106 (0x0017)

Edge length for A106

Table 72. EDGE\_LENGTH\_A106 (0x0017)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

### 9.18.2.2.1.5 RESIDUAL\_AMPL\_LEVEL\_A212 (0x0018)

Table 73. RESIDUAL\_AMPL\_LEVEL\_A212 (0x0018)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.1.6 EDGE\_TYPE\_A212 (0x0019)

Table 74. EDGE\_TYPE\_A212 (0x0019)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU



## 9.18.2.2.1.7 EDGE\_STYLE\_A212 (0x001A)

Table 75. EDGE\_STYLE\_A212 (0x001A)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_A212 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A212 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_A212 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A212 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.1.8 EDGE\_LENGTH\_A212 (0x001B)

Table 76. EDGE\_LENGTH\_A212 (0x001B)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.1.9 RESIDUAL\_AMPL\_LEVEL\_A424 (0x001C)

Table 77. RESIDUAL\_AMPL\_LEVEL\_A424 (0x001C)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.1.10 EDGE\_TYPE\_A424 (0x001D)

Table 78. EDGE\_TYPE\_A424 (0x001D)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.1.11 EDGE\_STYLE\_A424 (0x001E)

Table 79. EDGE\_STYLE\_A424 (0x001E)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_A424 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A424 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_A424 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A424 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.1.12 EDGE\_LENGTH\_A424 (0x001F)

Table 80. EDGE\_LENGTH\_A424 (0x001F)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.1.13 RESIDUAL\_AMPL\_LEVEL\_A848 (0x0020)

Table 81. RESIDUAL\_AMPL\_LEVEL\_A848 (0x0020)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.1.14 EDGE\_TYPE\_A848 (0x0021)

Table 82. EDGE\_TYPE\_A848 (0x0021)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.1.15 EDGE\_STYLE\_A848 (0x0022)

Table 83. EDGE\_STYLE\_A848 (0x0022)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_A848 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A848 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_A848 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A848 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.1.16 EDGE\_LENGTH\_A848 (0x0023)

Table 84. EDGE\_LENGTH\_A848 (0x0023)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.2 TX wave shaping for Type B passive reader mode for all baud-rates.

This section provides the TX shaping for Type B passive reader mode.

## 9.18.2.2.2.1 RESIDUAL\_AMPL\_LEVEL\_B106 (0x0024)

Table 85. RESIDUAL\_AMPL\_LEVEL\_B106 (0x0024)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.2.2 EDGE\_TYPE\_B106 (0x0025)

Table 86. EDGE\_TYPE\_B106 (0x0025)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.2.3 EDGE\_STYLE\_B106 (0x0026)

Table 87. EDGE\_STYLE\_B106 (0x0026)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_B106 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_B106 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_B106 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_B106 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.2.4 EDGE\_LENGTH\_B106 (0x0027)

Table 88. EDGE\_LENGTH\_B106 (0x0027)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.2.5 RESIDUAL\_AMPL\_LEVEL\_B212 (0x0028)

Table 89. RESIDUAL\_AMPL\_LEVEL\_B212 (0x0028)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.2.6 EDGE\_TYPE\_B212 (0x0029)

Table 90. EDGE\_TYPE\_B212 (0x0029)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU



## 9.18.2.2.2.7 EDGE\_STYLE\_B212 (0x002A)

Table 91. EDGE\_STYLE\_B212 (0x002A)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_B212 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_B212 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_B212 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_B212 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.2.8 EDGE\_LENGTH\_B212 (0x002B)

Table 92. EDGE\_LENGTH\_B212 (0x002B)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.2.9 RESIDUAL\_AMPL\_LEVEL\_B424 (0x002C)

Table 93. RESIDUAL\_AMPL\_LEVEL\_B424 (0x002C)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.2.10 EDGE\_TYPE\_B424 (0x002D)

Table 94. EDGE\_TYPE\_B424 (0x002D)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.2.11 EDGE\_STYLE\_B424 (0x002E)

Table 95. EDGE\_STYLE\_B424 (0x002E)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_B424 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_B424 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_B424 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_B424 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.2.12 EDGE\_LENGTH\_B424 (0x002F)

Table 96. EDGE\_LENGTH\_B424 (0x002F)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.2.13 RESIDUAL\_AMPL\_LEVEL\_B848 (0x0030)

Table 97. RESIDUAL\_AMPL\_LEVEL\_B848 (0x0030)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.2.14 EDGE\_TYPE\_B848 (0x0031)

Table 98. EDGE\_TYPE\_B848 (0x0031)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.2.15 EDGE\_STYLE\_B848 (0x0032)

Table 99. EDGE\_STYLE\_B848 (0x0032)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_B848 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_B848 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_B848 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_B848 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.2.16 EDGE\_LENGTH\_B848 (0x0033)

Table 100. EDGE\_LENGTH\_B848 (0x0033)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.3 TX wave shaping for Type F passive reader mode for all baud-rates.

This section provides the TX shaping for Type F passive reader mode.

## 9.18.2.2.3.1 RESIDUAL\_AMPL\_LEVEL\_F212 (0x0034)

Table 101. RESIDUAL\_AMPL\_LEVEL\_F212 (0x0034)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.3.2 EDGE\_TYPE\_F212 (0x0035)

Table 102. EDGE\_TYPE\_F212 (0x0035)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.3.3 EDGE\_STYLE\_F212 (0x0036)

Table 103. EDGE\_STYLE\_F212 (0x0036)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_F212 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_F212 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_F212 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_F212 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.3.4 EDGE\_LENGTH\_F212 (0x0037)

Table 104. EDGE\_LENGTH\_F212 (0x0037)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.3.5 RESIDUAL\_AMPL\_LEVEL\_F424 (0x0038)

Table 105. RESIDUAL\_AMPL\_LEVEL\_F424 (0x0038)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.3.6 EDGE\_TYPE\_F424 (0x0039)

Table 106. EDGE\_TYPE\_F424 (0x0039)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU



## 9.18.2.2.3.7 EDGE\_STYLE\_F424 (0x003A)

Table 107. EDGE\_STYLE\_F424 (0x003A)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_F424 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_F424 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_F424 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_F424 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.3.8 EDGE\_LENGTH\_F424 (0x003B)

Table 108. EDGE\_LENGTH\_F424 (0x003B)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.4 TX wave shaping for Type V (ISO15693) passive reader mode for all baud-rates.

This section provides the TX shaping for Type V (ISO15693) passive reader mode.

## 9.18.2.2.4.1 RESIDUAL\_AMPL\_LEVEL\_V10\_26 (0x004C)

Table 109. RESIDUAL\_AMPL\_LEVEL\_V10\_26 (0x004C)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.4.2 EDGE\_TYPE\_V10\_26 (0x004D)

Table 110. EDGE\_TYPE\_V10\_26 (0x004D)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.4.3 EDGE\_STYLE\_V10\_26 (0x004E)

Table 111. EDGE\_STYLE\_V10\_26 (0x004E)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V10_26 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V10_26 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V10_26 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V10_26 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.4.4 EDGE\_LENGTH\_V10\_26 (0x004F)

Table 112. EDGE\_LENGTH\_V10\_26 (0x004F)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.4.5 RESIDUAL\_AMPL\_LEVEL\_V10\_53 (0x0050)

Table 113. RESIDUAL\_AMPL\_LEVEL\_V10\_53 (0x0050)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.4.6 EDGE\_TYPE\_V10\_53 (0x0051)

Table 114. EDGE\_TYPE\_V10\_53 (0x0051)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.4.7 EDGE\_STYLE\_V10\_53 (0x0052)

Table 115. EDGE\_STYLE\_V10\_53 (0x0052)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V10_53 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V10_53 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V10_53 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V10_53 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.4.8 EDGE\_LENGTH\_V10\_53 (0x0053)

Table 116. EDGE\_LENGTH\_V10\_53 (0x0053)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.4.9 RESIDUAL\_AMPL\_LEVEL\_V10\_106 (0x0054)

Table 117. RESIDUAL\_AMPL\_LEVEL\_V10\_106 (0x0054)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.4.10 EDGE\_TYPE\_V10\_106 (0x0055)

Table 118. EDGE\_TYPE\_V10\_106 (0x0055)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.4.11 EDGE\_STYLE\_V10\_106 (0x0056)

Table 119. EDGE\_STYLE\_V10\_106 (0x0056)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V10_106 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V10_106 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V10_106 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V10_106 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.4.12 EDGE\_LENGTH\_V10\_106 (0x0057)

Table 120. EDGE\_LENGTH\_V10\_106 (0x0057)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.4.13 RESIDUAL\_AMPL\_LEVEL\_V10\_212 (0x0058)

Table 121. RESIDUAL\_AMPL\_LEVEL\_V10\_212 (0x0058)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.4.14 EDGE\_TYPE\_V10\_212 (0x0059)

Table 122. EDGE\_TYPE\_V10\_212 (0x0059)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU



## 9.18.2.2.4.15 EDGE\_STYLE\_V10\_212 (0x005A)

Table 123. EDGE\_STYLE\_V10\_212 (0x005A)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V10_212 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V10_212 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V10_212 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V10_212 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.4.16 EDGE\_LENGTH\_V10\_212 (0x005B)

Table 124. EDGE\_LENGTH\_V10\_212 (0x005B)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.4.17 RESIDUAL\_AMPL\_LEVEL\_V100\_26 (0x003C)

Table 125. RESIDUAL\_AMPL\_LEVEL\_V100\_26 (0x003C)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.4.18 EDGE\_TYPE\_V100\_26 (0x003D)

Table 126. EDGE\_TYPE\_V100\_26 (0x003D)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.4.19 EDGE\_STYLE\_V100\_26 (0x003E)

Table 127. EDGE\_STYLE\_V100\_26 (0x003E)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V100_26 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V100_26 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V100_26 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V100_26 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.4.20 EDGE\_LENGTH\_V100\_26 (0x003F)

Table 128. EDGE\_LENGTH\_V100\_26 (0x003F)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.4.21 RESIDUAL\_AMPL\_LEVEL\_V100\_53 (0x0040)

Table 129. RESIDUAL\_AMPL\_LEVEL\_V100\_53 (0x0040)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.4.22 EDGE\_TYPE\_V100\_53 (0x0041)

Table 130. EDGE\_TYPE\_V100\_53 (0x0041)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.4.23 EDGE\_STYLE\_V100\_53 (0x0042)

Table 131. EDGE\_STYLE\_V100\_53 (0x0042)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V100_53 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V100_53 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V100_53 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V100_53 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.4.24 EDGE\_LENGTH\_V100\_53 (0x0043)

Table 132. EDGE\_LENGTH\_V100\_53 (0x0043)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.4.25 RESIDUAL\_AMPL\_LEVEL\_V100\_106 (0x0044)

Table 133. RESIDUAL\_AMPL\_LEVEL\_V100\_106 (0x0044)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.4.26 EDGE\_TYPE\_V100\_106 (0x0045)

Table 134. EDGE\_TYPE\_V100\_106 (0x0045)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.2.4.27 EDGE\_STYLE\_V100\_106 (0x0046)

Table 135. EDGE\_STYLE\_V100\_106 (0x0046)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V100_106 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V100_106 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V100_106 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V100_106 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.4.28 EDGE\_LENGTH\_V100\_106 (0x0047)

Table 136. EDGE\_LENGTH\_V100\_106 (0x0047)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.2.4.29 RESIDUAL\_AMPL\_LEVEL\_V100\_212 (0x0048)

Table 137. RESIDUAL\_AMPL\_LEVEL\_V100\_212 (0x0048)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.2.4.30 EDGE\_TYPE\_V100\_212 (0x0049)

Table 138. EDGE\_TYPE\_V100\_212 (0x0049)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU



## 9.18.2.2.4.31 EDGE\_STYLE\_V100\_212 (0x004A)

Table 139. EDGE\_STYLE\_V100\_212 (0x004A)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V100_212 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V100_212 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_V100_212 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_V100_212 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.2.4.32 EDGE\_LENGTH\_V100\_212 (0x004B)

Table 140. EDGE\_LENGTH\_V100\_212 (0x004B)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

### 9.18.2.3 DPC NFC FORUM settings

This section provides the settings related to DPC configuration

#### 9.18.2.3.1 DPC\_CONFIG (0x0068)

DPC configuration

Table 141. DPC\_CONFIG (0x0068)

Function	bit	Values	Description
RFU	[7:3]		RFU
DPC in Active target mode	[2]		DPC configuration in active target mode
		0x00	disabled
		0x01	enabled
DPC in Active initiator mode	[1]		DPC configuration in active initiator mode
		0x00	disabled
		0x01	enabled
DPC in Reader/Passive Initiator mode	[0]		DPC configuration in Reader/ Passive Initiator mode
		0x00	disabled
		0x01	enabled

#### 9.18.2.3.2 DPC\_TARGET\_CURRENT (0x0069)

DPC configuration unloaded VDDPA target current in mA

Table 142. DPC\_TARGET\_CURRENT (0x0069)

Function	bit	Values	Description
DPC in Active target mode	[15:0]		VDDPA target current in mA. The target current +/- hysteresis defines the limiting maximum current for the DPC.

Note: This configuration shall not exceed 350 mA - hysteresis.

Note: The resulting current that is driven by the transmitter can be further reduced based on the current reduction lookup table entries.

### 9.18.2.3.3 DPC\_HYSTERESIS\_LOADING (0x006B)

The hysteresis (**bHysteresis** and **bHysteresis\_Unloading**) together with the target current (**wTargetCurrent**) defines the current limit, at which the DPC automatically decreases or raises the VDDPA. The VDDPA is automatically reduced, as soon as the current exceeds the **wTargetCurrent + bHysteresis**, and the VDDPA is automatically increased again, as soon as the current is below **wTargetCurrent # bHysteresis\_Unloading**.

Table 143. DPC\_HYSTERESIS\_LOADING (0x006B)

Function	bit	Values	Description
DPC hysteresis loading	[7:0]		Absolute difference to current Target Current in mA that triggers a DPC update event during loading.

**Note:** If the hysteresis is configured too small, it might cause an oscillation of the transmitted field.

In most application, the default values work well and do not need to be modified.

### 9.18.2.3.4 DPC\_HYSTERESIS\_UNLOADING (0x006E)

Table 144. DPC\_HYSTERESIS\_UNLOADING (0x006E)

Function	bit	Values	Description
DPC hysteresis unloading	[7:0]		Absolute difference to current Target Current in mA that triggers a DPC update event during unloading.

### 9.18.2.3.5 DPC\_TXLDOVDDPALow (0x006F)

Table 145. DPC\_TXLDOVDDPALow (0x006F)

Function	bit	Values	Description
TXLDOVDDPALow	[7:0]		VDDPA Low Limit for RDON

### 9.18.2.3.6 DPC\_TXGSN (0x0070)

TXGSN configuration.

Table 146. DPC\_TXGSN (0x0070)

Function	bit	Values	Description
DPC hysteresis loading	[7:0]	Less than 20	resistance = $10 \Omega / (tx1\_gsn + 1)$
		more than or equal 20	20: resistance = $0.5 \Omega$

### 9.18.2.3.7 DPC\_RDON\_CONTROL (0x0071)

Table 147. DPC\_RDON\_CONTROL (0x0071)

Function	bit	Values	Description
VDDPA low limit control	[7:0]	0x00	Disabled
		0x01	RdON Control
		0x02	PWM control
		Others	RFU

## 9.18.2.3.8 DPC\_InitialRDOOn\_RFOOn (0x0072)

Table 148. DPC\_InitialRDOOn\_RFOOn (0x0072)

Function	bit	Values	Description
DPC_InitialRDOOn_RFOOn	[7:0]		Initial GSP TX1/TX2 value during FieldON

## 9.18.2.3.9 DPC\_TXLDO\_MAX\_DROPOUT (0x0073)

Table 149. DPC\_TXLDO\_MAX\_DROPOUT (0x0073)

Function	bit	Values	Description
DPC_TXLDO_MAX_DROPOUT	[15:0]		At DPC start (on initial RF ON), if TXLDO drop out is higher to this value then VDDPA is reduced to: e VddpaSafe if no boost bypass on going else Vddpa is stopped. Unit is mV. Default = E10h = 3600 mV.

## 9.18.2.3.10 DPC\_GUARD\_TIME (0x0079)

Table 150. DPC\_GUARD\_TIME (0x0079)

Function	bit	Values	Description
algointerval	[7:0]		DPC guard time configuration. Guard time before tx. 1 unit = 1 $\mu$ s.

The DPC regulation is done once before TX and once after RX.

The guard time parameter is the time between DPC regulation completion and TX start.

The guard time parameter is the time between RX stop and DPC regulation start.

The guard time is always enabled for TX

**Note:** Recommendation is not to modify the default value.

## 9.18.2.3.11 DPC\_ENABLE\_DURING\_FDT (0x007A)

DPC regulation enable during FDT.

Table 151. DPC\_ENABLE\_DURING\_FDT (0x007A)

Function	bit	Values	Description
Disable DPC during FDT	[7:0]	0x00	DPC disabled during FDT (debug purpose only)
		0x01	DPC enabled during FDT (recommendation)
		others	RFU

## 9.18.2.3.12 DPC\_GUARD\_TIME\_AFTER\_RX (0x007B)

Enable DPC with guard time after RX

Table 152. DPC\_GUARD\_TIME\_AFTER\_RX (0x007B)

Function	bit	Values	Description
Enable DPC guard time after RX	[7:0]	0x00	DPC disabled after RX (debug purpose only)
		0x01	DPC enabled after RX (recommendation)
		others	RFU

## 9.18.2.3.13 DPC Lookup table entries

Table 153. DPC lookup table entries

Entry	Address	Function	bit	Values	Description
ENTRY 0 for 1V5	0x7D	This below details are for entry 0. Similar is for all other entries.			
		Target current reduction	[31:24]	-	Byte 0. Target current reduction in mA (unsigned)
		AWC amp mod change	[23:16]	-	Byte 1. Relative change of modulated amplitude level (signed)
		AWC edge time constant for ASK100	[15:8]	-	Byte 2. Target current reduction in mA (unsigned)
			[15:12]	-	ASK100, Relative change of rising edge time constant (signed)
			[11:8]	-	ASK100, Relative change of falling edge time constant (signed)
		AWC edge time constant for ASK10	[7:0]	-	Byte 2. Target current reduction in mA (unsigned)
			[7:4]	-	ASK10, Relative change of rising edge time constant (signed)
			[3:0]	-	ASK10, Relative change of falling edge time constant (signed)
ENTRY_01 for 1.60V	0x0081	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_02 for 1.70V	0x0085	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_03 for 1.80V	0x0089	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_04 for 1.90V	0x008D	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_05 for 2.00V	0x0091	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_06 for 2.10V	0x0095	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_07 for 2.20V	0x0099	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_08 for 2.30V	0x009D	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_09 for 2.40V	0x00A1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_10 for 2.50V	0x00A5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_11 for 2.60V	0x00A9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_12 for 2.70V	0x00AD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_13 for 2.80V	0x00B1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_14 for 2.90V	0x00B5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_15 for 3.00V	0x00B9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_16 for 3.10V	0x00BD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_17 for 3.20V	0x00C1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_18 for 3.30V	0x00C5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_19 for 3.40V	0x00C9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_20 for 3.50V	0x00CD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_21 for 3.60V	0x00D1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			

Table 153. DPC lookup table entries...continued

Entry	Address	Function	bit	Values	Description
ENTRY_22 for 3.70V	0x00D5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_23 for 3.80V	0x00D9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_24 for 3.90V	0x00DD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_25 for 4.00V	0x00E1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_26 for 4.10V	0x00E5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_27 for 4.20V	0x00E9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_28 for 4.30V	0x00ED	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_29 for 4.40V	0x00F1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_30 for 4.50V	0x00F5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_31 for 4.60V	0x00F9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_32 for 4.70V	0x00FD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_33 for 4.80V	0x0101	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_34 for 4.90V	0x0105	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_35 for 5.00V	0x0109	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_36 for 5.10V	0x010D	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_37 for 5.20V	0x0111	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_38 for 5.30V	0x0115	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_39 for 5.40V	0x0119	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_40 for 5.50V	0x011D	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_41 for 5.60V	0x0121	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_42 for 5.70V	0x0125	Byte and bit-fields description, refer to <a href="#">Table 153</a>			

### 9.18.2.4 DPC EMVCo settings

This section provides the settings related to DPC configuration

#### 9.18.2.4.1 DPC\_EMVCo\_CONFIG (0x068E)

DPC EMVCo configuration

Table 154. DPC\_EMVCo\_CONFIG (0x0077)

Function	bit	Values	Description
RFU	[7:3]		RFU
DPC in Active target mode	[2]		DPC configuration in active target mode
		0x00	disabled
		0x01	enabled
DPC in Active initiator mode	[1]		DPC configuration in active initiator mode
		0x00	disabled
		0x01	enabled
DPC in Reader/Passive Initiator mode	[0]		DPC configuration in Reader/ Passive Initiator mode
		0x00	disabled
		0x01	enabled

#### 9.18.2.4.2 DPC\_EMVCo\_TARGET\_CURRENT (0x068F)

DPC configuration unloaded VDDPA target current in mA

Table 155. DPC\_EMVCo\_TARGET\_CURRENT (0x0132)

Function	bit	Values	Description
DPC in Active target mode	[15:0]		VDDPA target current in mA. The target current +/- hysteresis defines the limiting maximum current for the DPC.

Note: This configuration shall not exceed 350 mA - hysteresis.

Note: The resulting current that is driven by the transmitter can be further reduced based on the current reduction lookup table entries.

#### 9.18.2.4.3 DPC\_EMVCo\_HYSTERESIS\_LOADING (0x0691)

The hysteresis (**bHysteresis** and **bHysteresis\_Unloading**) together with the target current (**wTargetCurrent**) defines the current limit, at which the DPC automatically decreases or raises the VDDPA. The VDDPA is automatically reduced, as soon as the current exceeds the **wTargetCurrent + bHysteresis**, and the VDDPA is automatically increased again, as soon as the current is below **wTargetCurrent # bHysteresis\_Unloading**.

Table 156. DPC\_EMVCo\_HYSTERESIS\_LOADING (0x006B)

Function	bit	Values	Description
DPC hysteresis loading	[7:0]		Absolute difference to current Target Current in mA that triggers a DPC update event during loading.

**Note:** If the hysteresis is configured too small, it might cause an oscillation of the transmitted field.

**Note:** In most application, the default values work well and do not need to be modified.

#### 9.18.2.4.4 DPC\_EMVCo\_HYSTERESIS\_UNLOADING (0x0694)

Table 157. DPC\_EMVCo\_HYSTERESIS\_UNLOADING (0x006E)

Function	bit	Values	Description
DPC hysteresis unloading	[7:0]		Absolute difference to current Target Current in mA that triggers a DPC update event during unloading.

#### 9.18.2.4.5 DPC\_EMVCo\_TXLDOVDDPALow (0x0695)

Table 158. DPC\_EMVCo\_TXLDOVDDPALow (0x006F)

Function	bit	Values	Description
TXLDOVDDPALow	[7:0]		VDDPA Low Limit for RDON

#### 9.18.2.4.6 DPC\_EMVCo\_TXGSN (0x0696)

TXGSN configuration.

Table 159. DPC\_EMVCo\_TXGSN (0x0696)

Function	bit	Values	Description
DPC hysteresis loading	[7:0]	Less than 20	resistance = $10 \Omega / (tx1\_gsn + 1)$
		more than or equal 20	20: resistance = $0.5 \Omega$

#### 9.18.2.4.7 DPC\_EMVCo\_RDON\_CONTROL (0x0697)

Table 160. DPC\_EMVCo\_RDON\_CONTROL (0x0697)

Function	bit	Values	Description
VDDPA low limit control	[7:0]	0x00	Disabled
		0x01	RdON Control
		0x02	PWM control
		Others	RFU



## 9.18.2.4.8 DPC\_EMVCo\_InitialRDOOn\_RFOOn (0x0698)

Table 161. DPC\_EMVCo\_InitialRDOOn\_RFOOn (0x0698)

Function	bit	Values	Description
DPC_InitialRDOOn_RFOOn	[7:0]		Initial GSP TX1/TX2 value during FieldON

## 9.18.2.4.9 DPC\_EMVCo\_TXLDO\_MAX\_DROPOUT (0x0699)

Table 162. DPC\_EMVCo\_TXLDO\_MAX\_DROPOUT (0x0699)

Function	bit	Values	Description
DPC_TXLDO_MAX_DROPOUT	[15:0]		At DPC start (on initial RF ON), if TXLDO drop out is higher to this value then VDDPA is reduced to: e VddpaSafe if no boost bypass on going else Vddpa is stopped. Unit is mV. Default = E10h = 3600 mV.

## 9.18.2.4.10 DPC\_EMVCo\_GUARD\_TIME (0x069F)

Table 163. DPC\_EMVCo\_GUARD\_TIME (0x069F)

Function	bit	Values	Description
algorithinterval	[7:0]		DPC guard time configuration. Guard time before tx. 1 unit = 1 $\mu$ s.

The DPC regulation is done once before TX and once after RX.

The guard time parameter is the time between DPC regulation completion and TX start.

The guard time parameter is the time between RX stop and DPC regulation start.

The guard time is always enabled for TX

**Note:** The recommendation is not to modify the default value.

## 9.18.2.4.11 DPC\_EMVCo\_ENABLE\_DURING\_FDT (0x06A0)

DPC regulation enable during FDT.

Table 164. DPC\_EMVCo\_ENABLE\_DURING\_FDT (0x06A0)

Function	bit	Values	Description
Disable DPC during FDT	[7:0]	0x00	DPC disabled during FDT (debug purpose only)
		0x01	DPC enabled during FDT (recommendation)
		others	RFU

## 9.18.2.4.12 DPC\_EMVCo\_GUARD\_TIME\_AFTER\_RX (0x06A1)

Enable DPC with guard time after RX

Table 165. DPC\_EMVCo\_GUARD\_TIME\_AFTER\_RX (0x06A1)

Function	bit	Values	Description
Enable DPC guard time after RX	[7:0]	0x00	DPC disabled after RX (debug purpose only)
		0x01	DPC enabled after RX (recommendation)
		others	RFU

## 9.18.2.4.13 DPC EMVCo Lookup table entries

Table 166. DPC EMVCo lookup table entries

Entry	Address	Function	bit	Values	Description
ENTRY 0 for 1V5	0x7D	This below details are for entry 0. Similar is for all other entries.			
		Target current reduction	[31:24]	-	Byte 0. Target current reduction in mA (unsigned)
		AWC amp mod change	[23:16]	-	Byte 1. Relative change of modulated amplitude level (signed)
		AWC edge time constant for ASK100	[15:8]	-	Byte 2. Target current reduction in mA (unsigned)
			[15:12]	-	ASK100, Relative change of rising edge time constant (signed)
			[11:8]	-	ASK100, Relative change of falling edge time constant (signed)
		AWC edge time constant for ASK10	[7:0]	-	Byte 2. Target current reduction in mA (unsigned)
			[7:4]	-	ASK10, Relative change of rising edge time constant (signed)
			[3:0]	-	ASK10, Relative change of falling edge time constant (signed)
ENTRY_01 for 1.60V	0x0081	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_02 for 1.70V	0x0085	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_03 for 1.80V	0x0089	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_04 for 1.90V	0x008D	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_05 for 2.00V	0x0091	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_06 for 2.10V	0x0095	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_07 for 2.20V	0x0099	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_08 for 2.30V	0x009D	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_09 for 2.40V	0x00A1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_10 for 2.50V	0x00A5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_11 for 2.60V	0x00A9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_12 for 2.70V	0x00AD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_13 for 2.80V	0x00B1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_14 for 2.90V	0x00B5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_15 for 3.00V	0x00B9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_16 for 3.10V	0x00BD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_17 for 3.20V	0x00C1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_18 for 3.30V	0x00C5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_19 for 3.40V	0x00C9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_20 for 3.50V	0x00CD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_21 for 3.60V	0x00D1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			

Table 166. DPC EMVCo lookup table entries...continued

Entry	Address	Function	bit	Values	Description
ENTRY_22 for 3.70V	0x00D5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_23 for 3.80V	0x00D9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_24 for 3.90V	0x00DD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_25 for 4.00V	0x00E1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_26 for 4.10V	0x00E5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_27 for 4.20V	0x00E9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_28 for 4.30V	0x00ED	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_29 for 4.40V	0x00F1	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_30 for 4.50V	0x00F5	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_31 for 4.60V	0x00F9	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_32 for 4.70V	0x00FD	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_33 for 4.80V	0x0101	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_34 for 4.90V	0x0105	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_35 for 5.00V	0x0109	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_36 for 5.10V	0x010D	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_37 for 5.20V	0x0111	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_38 for 5.30V	0x0115	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_39 for 5.40V	0x0119	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_40 for 5.50V	0x011D	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_41 for 5.60V	0x0121	Byte and bit-fields description, refer to <a href="#">Table 153</a>			
ENTRY_42 for 5.70V	0x0125	Byte and bit-fields description, refer to <a href="#">Table 153</a>			

9.18.2.5 ARC settings for passive reader modes

This section provides the ARC settings for Reader Mode TX wave shaping configuration

9.18.2.5.1 ARC\_SETTINGS\_ARCCONFIG (0x0129)

ARC settings configuration.

Table 167. ARC\_SETTINGS\_ARCCONFIG (0x0129)

Function	bit	Values	Description
ARC settings configuration	[7]	0x00	ARC algorithm is disabled.
		0x01	ARC algorithm is enabled.
	[6:3]		RFU
	[2:0]		Number of entries in ARC table
		0x00	one entry
		0x01	two entries
		0x02	three entries
		0x03	four entries
		0x04	five entries
		others	RFU

9.18.2.5.2 ARC\_SETTINGS\_ARCVDDPA (0x012B)

VDDPA settings.

Table 168. ARC\_SETTINGS\_ARCVDDPA (0x012B)

Function	byte	Values	Description
VDDPA settings	[4]	See below note	VDDPA_range_index 4: if VDDPA voltage between VDDPA_3 to ARC_VDDPA_4
	[3]		VDDPA_range_index 3: if VDDPA voltage between VDDPA_2 to ARC_VDDPA_3 - 0.1
	[2]		VDDPA_range_index 2: if VDDPA voltage between VDDPA_1 to ARC_VDDPA_2 - 0.1
	[1]		VDDPA_range_index 1: if VDDPA voltage between VDDPA_0 to (ARC_VDDPA_1 - 0.1)
	[0]		VDDPA_range_index 0: if VDDPA voltage between 1.5 to (VDDPA_0 - 0.1)

**Note:** For above settings, value of 0x00 indicates for 1V50, 0x01 indicates for 1V60. Further increase with 100 mV and value of 0x2A corresponds to 5V70.

## 9.18.2.5.3 ARC\_SETTINGS\_WRMARCA\_106 (0x0130)

ARC table settings for reader mode Type A 106kbps

Table 169. ARC\_SETTINGS\_WRMARCA\_106 (0x0130)

Function	byte	bits	Values	Description
RM_RX_ARC_0	[9:8]	[15]		ARC settings applicability. Settings will be taken into account only if bit[14] of this settings is set to '1'.
			0x00	ARC settings applicable always. bits [9:0] of ARC_RM_A106 are used.
			0x01	ARC settings applicable during FDT. bits [9:0] of ARM_RM_A106_FDT are used else bits[9:0] of table ARC_RM_A106 are used.
		[14]		ARC enable/disable
			0x00	ARC disabled for this technology and baudrate
			0x01	ARC enabled for this technology and baudrate
		[13:10]		RFU
		[9]		Enable the IIR filter
		[8:7]		MF_GAIN (this value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled)
		[6:0]		DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)
RM_RX_ARC_1	[7:6]	[15]		ARC settings applicability. Settings will be taken into account only if bit[14] of this settings is set to '1'.
			0x00	ARC settings applicable always. bits [9:0] of ARC_RM_A106 are used.
			0x01	ARC settings applicable during FDT. bits [9:0] of ARM_RM_A106_FDT are used else bits[9:0] of table ARC_RM_A106 are used.
		[14]		RFU
		[13:10]		RFU
		[9]		Enable the IIR filter
		[8:7]		MF_GAIN (this value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled)
		[6:0]		DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)

Table 169. ARC\_SETTINGS\_WRMARCA\_106 (0x0130)...continued

Function	byte	bits	Values	Description
RM_RX_ARC_2	[5:4]	[15]		ARC settings applicability. Settings will be taken into account only if bit[14] of this settings is set to '1'.
			0x00	ARC settings applicable always. bits [9:0] of ARC_RM_A106 are used.
			0x01	ARC settings applicable during FDT. bits [9:0] of ARM_RM_A106_FDT are used else bits[9:0] of table ARC_RM_A106 are used.
		[14]		RFU
		[13:10]		RFU
		[9]		Enable the IIR filter
		[8:7]		MF_GAIN (this value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled)
		[6:0]		DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)
RM_RX_ARC_3	[3:2]	[15]		ARC settings applicability. Settings will be taken into account only if bit[14] of this settings is set to '1'.
			0x00	ARC settings applicable always. bits [9:0] of ARC_RM_A106 are used.
			0x01	ARC settings applicable during FDT. bits [9:0] of ARM_RM_A106_FDT are used else bits[9:0] of table ARC_RM_A106 are used.
		[14]		RFU
		[13:10]		RFU
		[9]		Enable the IIR filter
		[8:7]		MF_GAIN (this value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled)
		[6:0]		DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)

Table 169. ARC\_SETTINGS\_WRMARCA\_106 (0x0130)...continued

Function	byte	bits	Values	Description
RM_RX_ARC_4	[1:0]	[15]		ARC settings applicability. Settings will be taken into account only if bit[14] of this settings is set to '1'.
			0x00	ARC settings applicable always. bits [9:0] of ARC_RM_A106 are used.
			0x01	ARC settings applicable during FDT. bits [9:0] of ARM_RM_A106_FDT are used else bits[9:0] of table ARC_RM_A106 are used.
		[14]		RFU
		[13:10]		RFU
		[9]		Enable the IIR filter
		[8:7]		MF_GAIN (this value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled)
		[6:0]		DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)

#### 9.18.2.5.4 ARC\_SETTINGS\_TABLE for other technologies

Table 170. ARC\_SETTINGS\_TABLE for other technologies

Technology	Address	Function	Byte	Description
ARC_SETTINGS_A_212	0x13A-0x143	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_A_424	0x144-0x14D	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_A_848	0x14E-0x157	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_B_106	0x158-0x161	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>

Table 170. ARC\_SETTINGS\_TABLE for other technologies...continued

Technology	Address	Function	Byte	Description
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_B_212	0x162-0x16B	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_B_424	0x16C-0x175	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_B_848	0x176-0x17F	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_F_424	0x180-0x189	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_F_424	0x18A-0x193	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_V_6P6	0x19E-0x1A7	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_V_26	0x19E-0x1A7	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>



Table 170. ARC\_SETTINGS\_TABLE for other technologies...continued

Technology	Address	Function	Byte	Description
ARC_SETTINGS_V_53	0x1A8-0x1B1	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_V_106	0x1B2-0x1BB	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_V_212	0x1BC-0x1C5	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_RmArcEMVCo F212	0x1C6-1CF	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_RmArcEMVCo F424	0x1D0-1D9	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_RmArcEMVCo A106	0x1DA-0x1E3	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>
ARC_SETTINGS_RmArcEMVCo B106	0x1E4-0x1ED	RM_RX_ARC_0	[9:8]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_1	[7:6]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_2	[5:4]	Refer to <a href="#">Section 9.18.2.5.3</a>
		RM_RX_ARC_3	[3:2]	Refer to <a href="#">Section 9.18.2.5.3</a>
	0x202-0x20B	RM_RX_ARC_4	[1:0]	Refer to <a href="#">Section 9.18.2.5.3</a>

## 9.18.2.5.5 ARC\_RM\_A106\_FDT\_NFC\_FORUM (0x051B)

Table 171. ARC\_RM\_A106\_FDT\_NFC\_FORUM (0x051B)

Function	Address	Bytesn	Bits	Value	Description
RM_RX_ARC_FDT_0	0x51B	[1:0]	Settings for RM_RX_ARC_FDT_0		
			[15]	0x00	ARC settings apply always
				0x01	ARC settings applicable during FDT
			[14]	0x00	ARC Disabled for this Tech and Baudrate
				0x01	ARC Enabled for this Tech and Baudrate
			NOTE This bit is RFU for RM_RX_ARC_FDT_1, RM_RX_ARC_FDT_2, RM_RX_ARC_FDT_3, RM_RX_ARC_FDT_4.		
			[13:10]	-	RFU. Reserved.
			[9]	-	Enable the IIR filter.
RM_RX_ARC_FDT_1	0x51D	[3:2]	[8:7]	-	MF_GAIN (ths value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled)
			[6:0]	-	DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)
RM_RX_ARC_FDT_2	0x51F	[5:4]	Settings for RM_RX_ARC_FDT_2. Bit definitions is same as that of RM_RX_ARC_FDT_0		
RM_RX_ARC_FDT_3	0x521	[7:6]	Settings for RM_RX_ARC_FDT_3. Bit definitions is same as that of RM_RX_ARC_FDT_0		
RM_RX_ARC_FDT_4	0x523	[9:8]	Settings for RM_RX_ARC_FDT_4. Bit definitions is same as that of RM_RX_ARC_FDT_0		

## 9.18.2.5.6 ARC\_RM\_A106\_FDT\_EMVCo (0x06A7)

Table 172. ARC\_RM\_A106\_FDT\_EMVCo (0x06A7)

Function	Address	Bytesn	Bits	Value	Description
RM_RX_ARC_FDT_0	0x51B	[1:0]	Settings for RM_RX_ARC_FDT_0		
			[15]	0x00	ARC settings apply always
				0x01	ARC settings applicable during FDT
			[14]	0x00	ARC Disabled for this Tech and Baudrate
				0x01	ARC Enabled for this Tech and Baudrate
			NOTE This bit is RFU for RM_RX_ARC_FDT_1, RM_RX_ARC_FDT_2, RM_RX_ARC_FDT_3, RM_RX_ARC_FDT_4.		
			[13:10]	-	RFU. Reserved.
			[9]	-	Enable the IIR filter.
RM_RX_ARC_FDT_1	0x51D	[3:2]	[8:7]	-	MF_GAIN (ths value will be applied to the SIGPR_RM_TECH register, applies as soon as the ARC is enabled)
			[6:0]	-	DPC_SIGNAL_DETECT_TH_OVR_VAL (this value will be applied to the DGRM_RSSI register, applies as soon as the ARC is enabled)
RM_RX_ARC_FDT_2	0x51F	[5:4]	Settings for RM_RX_ARC_FDT_2. Bit definitions is same as that of RM_RX_ARC_FDT_0		
RM_RX_ARC_FDT_3	0x521	[7:6]	Settings for RM_RX_ARC_FDT_3. Bit definitions is same as that of RM_RX_ARC_FDT_0		
RM_RX_ARC_FDT_4	0x523	[9:8]	Settings for RM_RX_ARC_FDT_4. Bit definitions is same as that of RM_RX_ARC_FDT_0		

### 9.18.2.6 RSSI configuration parameters (applicable for card emulation)

#### 9.18.2.6.1 EEPROM\_APC\_RSSI\_LIST

List of RSSI settings for card emulation only

Table 173. List of RSSI settings for card emulation only

Configuration Parameter	Address (Hex)	Address (Decimal)	Size (in bytes)	EEPROM_AREA
<a href="#">RSSI_TIMER (0x020C)</a>	0x020C	524	2	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">RSSI_TIMER_FIRST_PERIOD (0x020E)</a>	0x020E	526	2	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">RSSI_CTRL_00_AB (0x0210)</a>	0x0210	528	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">RSSI_NB_ENTRIES_AB (0x0211)</a>	0x0211	529	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">RSSI_THRESHOLD_AB entries table</a>	0x0212-0x271	530	2	E_PN76_EEPROM_SECURE_LIB_CONFIG

#### 9.18.2.6.2 RSSI\_TIMER (0x020C)

RSSI timer

Table 174. RSSI\_TIMER (0x020C)

Function	bits	Values	Description
RSSI_TIMER	[15:0]		RSSI timer. Default: 423d.

#### 9.18.2.6.3 RSSI\_TIMER\_FIRST\_PERIOD (0x020E)

First period duration after Rf field ON.

Table 175. RSSI\_TIMER\_FIRST\_PERIOD (0x020E)

Function	bits	Values	Description
RSSI	[15:0]		First period duration after Rffield ON. Unit is 128/fc (106 kHz) if set to 0 it means feature is not used 0D2 => ~2 ms

#### 9.18.2.6.4 RSSI\_CTRL\_00\_AB (0x0210)

RSSI control.

Table 176. RSSI\_CTRL\_00\_AB (0x0210)

Function	bits	Values	Description
RSSI	[7:6]	-	Reserved
	[5:0]	-	(APC_ID_REF_AB) ID of APC_TX entry that is equiv to RSSI = 0 (for Type AB)

## 9.18.2.6.5 RSSI\_NB\_ENTRIES\_AB (0x0211)

For Initial RF ON, CEA and CEB.

Table 177. RSSI\_NB\_ENTRIES\_AB (0x0211)

Function	bits	Values	Description
RSSI	[7:5]		Reserved
	[4:0]		Number of entries in RSSI look up table (it refers to RSSI_ENTRY_AB_01 to RSSI_ENTRY_AB_18);

## 9.18.2.6.6 RSSI\_THRESHOLD\_PHASE\_TABLE for Type-A and Type-B

Table 178. RSSI\_THRESHOLD\_PHASE\_TABLE for Type-A and Type-B

Entry	Address	Function	bit	Values	Description
RSSI_THRESHOLD_AB_01	0x212	RSSI	Threshold value for APC algorithm for TypeA and TypeB <b>Note:</b> <i>dwRssiEntryAB_00 = 0 (not in EEPROM) Signed phase compensation with 1/4 degree resolution: 16 bits signed value (using complement of 2)</i>		
			[15:13]	-	Reserved
			[12:0]	-	RSSI Value
RSSI_PHASE_AB_01	0x214	RSSI	[15:0]	-	Phase compensation value for APC algorithm for TypeA and TypeB. Signed phase compensation with 1/4 degree resolution: 16 bits signed value (using complement of 2)
RSSITHRESHOLDAB_02	0x0216	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_02	0x0218	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_03	0x021A	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_03	0x021C	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_04	0x021E	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_04	0x0220	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_05	0x0222	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_05	0x0224	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_06	0x0226	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_06	0x0228	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_07	0x022A	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_07	0x022C	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_08	0x022E	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_08	0x0230	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_09	0x0232	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_09	0x0234	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_0A	0x0236	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_0A	0x0238	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			

Table 178. RSSI\_THRESHOLD\_PHASE\_TABLE for Type-A and Type-B...continued

Entry	Address	Function	bit	Values	Description
RSSITHRESHOLDAB_0B	0x023A	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_0B	0x023C	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_0C	0x023E	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_0C	0x0240	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_0D	0x0242	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_0D	0x0244	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_0E	0x0246	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_0E	0x0248	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_0F	0x024A	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_0F	0x024C	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_10	0x024E	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_10	0x0250	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_11	0x0252	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_11	0x0254	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_12	0x0256	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_12	0x0258	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_13	0x025A	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_13	0x025C	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_14	0x025E	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_14	0x0260	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_15	0x0262	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_15	0x0264	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_16	0x0266	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_16	0x0268	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_17	0x026A	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_17	0x026C	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			
RSSITHRESHOLDAB_18	0x026E	Refer to the entry RSSI_THRESHOLD_AB_01 for bit-fields and description.			
ARBPHASEAB_18	0x0270	Refer to the entry RSSI_PHASE_AB_01 for bit-fields and description.			

### 9.18.2.6.7 RSSI\_CTRL\_00\_F (0x0272)

Table 179. RSSI\_CTRL\_00\_F (0x0272)

Function	bits	Values	Description
RSSI	[7:6]		Reserved
	[5:0]		(APC_ID_REF_AB) ID of APC_TX entry that is equiv to RSSI = 0 (for Type F)

## 9.18.2.6.8 RSSI\_NB\_ENTRIES\_F (0x0273)

Table 180. RSSI\_NB\_ENTRIES\_F (0x0273)

Function	bits	Values	Description
RSSI	[7:5]		Reserved
	[4:0]		Number of entries in RSSI look up table (it refers to RSSI_ENTRY_F_01 to RSSI_ENTRY_F_18);

## 9.18.2.6.9 RSSI\_THRESHOLD\_PHASE\_TABLE for Type-F

Table 181. RSSI\_THRESHOLD\_PHASE\_TABLE for Type-F

Entry	Address	Function	bit	Values	Description
RSSI_THRESHOLD_F_01	0x276	RSSI	Threshold value for APC algorithm for TypeF <b>Note:</b> <i>dwRssiEntryF_00 = 0 (not in EEPROM) Signed phase compensation with 1/4 degree resolution: 16 bits signed value (using complement of 2)</i>		
			[15:13]	-	Reserved
			[12:0]	-	RSSI Value
RSSI_PHASE_F_01	0x276	RSSI	[15:0]	-	Phase compensation value for APC algorithm for TypeF. Signed phase compensation with 1/4 degree resolution: 16 bits signed value (using complement of 2)
RSSITHRESHOLDF_02	0x0278	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_02	0x027A	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_03	0x027C	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_03	0x027E	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_04	0x0280	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_04	0x0282	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_05	0x0284	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_05	0x0286	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_06	0x0288	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_06	0x028A	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_07	0x028C	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_07	0x028E	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_08	0x0290	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_08	0x0292	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_09	0x0294	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_09	0x0296	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_0A	0x0298	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_0A	0x029A	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_0B	0x029C	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_0B	0x029E	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			

Table 181. RSSI\_THRESHOLD\_PHASE\_TABLE for Type-F...continued

Entry	Address	Function	bit	Values	Description
RSSITHRESHOLDF_0C	0x02A0	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_0C	0x02A2	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_0D	0x02A4	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_0D	0x02A6	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_0E	0x02A8	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_0E	0x02AA	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_0F	0x02AC	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_0F	0x02AE	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_10	0x02B0	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_10	0x02B2	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_11	0x02B4	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_11	0x02B6	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_12	0x02B8	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_12	0x02BA	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_13	0x02BC	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_13	0x02BE	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_14	0x02C0	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_14	0x02C2	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_15	0x02C4	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_15	0x02C6	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_16	0x02C8	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_16	0x02CA	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_17	0x02CC	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_17	0x02CE	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			
RSSITHRESHOLDF_18	0x02D0	Refer to the entry RSSI_THRESHOLD_F_01 for bit-fields and description.			
ARBPHASEF_18	0x02D2	Refer to the entry RSSI_PHASE_F_01 for bit-fields and description.			



### 9.18.2.7 RSSI APC algorithm table output settings TX\_PARAM\_ENTRY\_TABLE. Applicable only for card emulation.

APC TX\_PARAM\_ENTRY for ID.

Table 182. TX\_PARAM\_ENTRY\_00\_ID (0x02D4)

Entry ID	Address	Function	bits	Values	Description
ENTRY_00_ID	0x2D4	Driver count	[7]	-	Driver count (CLIF_TX_CONTROL_REG.TX_ALM_TYPE_SELECT):
				0x00	Dual driver
				0x01	Single driver
		BPSK mode	[6]	-	BPSK mode (CLIF_TX_CONTROL_REG.TX_ALM_BPSK_ENABLE):
				0x00	Dual driver
				0x01	Single driver
		ID	[5:0]	-	ID
ENTRY_00_Tx1	0x2D5	RFU	[7:6]	-	Reserved
		PMU VDDPA setting	[5:0]	-	VDDPA(V) = (val × 10) + 1,5 V 0x00 = 1.50 V ... 0x2Ah = 5.70 V
ENTRY_00_Tx2	0x2D6	Scaling factor	[7:0]	-	Scaling factor for TX1 and TX2
ENTRY_01_ID	0x02D7	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_01_TX1	0x02D8	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_01_TX2	0x02D9	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_02_ID	0x02DA	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_02_TX1	0x02DB	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_02_TX2	0x02DC	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_03_ID	0x02DD	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_03_TX1	0x02DE	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_03_TX2	0x02DF	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_04_ID	0x02E0	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_04_TX1	0x02E1	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_04_TX2	0x02E2	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_05_ID	0x02E3	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_05_TX1	0x02E4	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_05_TX2	0x02E5	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_06_ID	0x02E6	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_06_TX1	0x02E7	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_06_TX2	0x02E8	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_07_ID	0x02E9	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_07_TX1	0x02EA	For bit-field values, refer to ENTRY_00_TX1 above			

Table 182. TX\_PARAM\_ENTRY\_00\_ID (0x02D4)...continued

Entry ID	Address	Function	bits	Values	Description
ENTRY_07_TX2	0x02EB	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_08_ID	0x02EC	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_08_TX1	0x02ED	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_08_TX2	0x02EE	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_09_ID	0x02EF	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_09_TX1	0x02F0	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_09_TX2	0x02F1	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_0A_ID	0x02F2	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_0A_TX1	0x02F3	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_0A_TX2	0x02F4	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_0B_ID	0x02F5	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_0B_TX1	0x02F6	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_0B_TX2	0x02F7	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_0C_ID	0x02F8	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_0C_TX1	0x02F9	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_0C_TX2	0x02FA	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_0D_ID	0x02FB	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_0D_TX1	0x02FC	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_0D_TX2	0x02FD	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_0E_ID	0x02FE	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_0E_TX1	0x02FF	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_0E_TX2	0x0300	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_0F_ID	0x0301	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_0F_TX1	0x0302	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_0F_TX2	0x0303	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_10_ID	0x0304	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_10_TX1	0x0305	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_10_TX2	0x0306	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_11_ID	0x0307	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_11_TX1	0x0308	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_11_TX2	0x0309	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_12_ID	0x030A	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_12_TX1	0x030B	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_12_TX2	0x030C	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_13_ID	0x030D	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_13_TX1	0x030E	For bit-field values, refer to ENTRY_00_TX1 above			

Table 182. TX\_PARAM\_ENTRY\_00\_ID (0x02D4)...continued

Entry ID	Address	Function	bits	Values	Description
ENTRY_13_TX2	0x030F	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_14_ID	0x0310	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_14_TX1	0x0311	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_14_TX2	0x0312	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_15_ID	0x0313	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_15_TX1	0x0314	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_15_TX2	0x0315	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_16_ID	0x0316	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_16_TX1	0x0317	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_16_TX2	0x0318	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_17_ID	0x0319	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_17_TX1	0x031A	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_17_TX2	0x031B	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_18_ID	0x031C	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_18_TX1	0x031D	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_18_TX2	0x031E	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_19_ID	0x031F	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_19_TX1	0x0320	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_19_TX2	0x0321	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_1A_ID	0x0322	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_1A_TX1	0x0323	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_1A_TX2	0x0324	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_1B_ID	0x0325	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_1B_TX1	0x0326	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_1B_TX2	0x0327	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_1C_ID	0x0328	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_1C_TX1	0x0329	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_1C_TX2	0x032A	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_1D_ID	0x032B	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_1D_TX1	0x032C	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_1D_TX2	0x032D	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_1E_ID	0x032E	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_1E_TX1	0x032F	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_1E_TX2	0x0330	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_1F_ID	0x0331	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_1F_TX1	0x0332	For bit-field values, refer to ENTRY_00_TX1 above			

Table 182. TX\_PARAM\_ENTRY\_00\_ID (0x02D4)...continued

Entry ID	Address	Function	bits	Values	Description
ENTRY_1F_TX2	0x0333	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_20_ID	0x0334	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_20_TX1	0x0335	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_20_TX2	0x0336	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_21_ID	0x0337	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_21_TX1	0x0338	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_21_TX2	0x0339	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_22_ID	0x033A	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_22_TX1	0x033B	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_22_TX2	0x033C	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_23_ID	0x033D	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_23_TX1	0x033E	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_23_TX2	0x033F	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_24_ID	0x0340	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_24_TX1	0x0341	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_24_TX2	0x0342	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_25_ID	0x0343	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_25_TX1	0x0344	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_25_TX2	0x0345	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_26_ID	0x0346	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_26_TX1	0x0347	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_26_TX2	0x0348	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_27_ID	0x0349	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_27_TX1	0x034A	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_27_TX2	0x034B	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_28_ID	0x034C	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_28_TX1	0x034D	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_28_TX2	0x034E	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_29_ID	0x034F	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_29_TX1	0x0350	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_29_TX2	0x0351	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_2A_ID	0x0352	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_2A_TX1	0x0353	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_2A_TX2	0x0354	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_2B_ID	0x0355	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_2B_TX1	0x0356	For bit-field values, refer to ENTRY_00_TX1 above			

Table 182. TX\_PARAM\_ENTRY\_00\_ID (0x02D4)...continued

Entry ID	Address	Function	bits	Values	Description
ENTRY_2B_TX2	0x0357	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_2C_ID	0x0358	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_2C_TX1	0x0359	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_2C_TX2	0x035A	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_2D_ID	0x035B	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_2D_TX1	0x035C	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_2D_TX2	0x035D	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_2E_ID	0x035E	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_2E_TX1	0x035F	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_2E_TX2	0x0360	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_2F_ID	0x0361	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_2F_TX1	0x0362	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_2F_TX2	0x0363	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_30_ID	0x0364	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_30_TX1	0x0365	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_30_TX2	0x0366	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_31_ID	0x0367	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_31_TX1	0x0368	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_31_TX2	0x0369	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_32_ID	0x036A	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_32_TX1	0x036B	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_32_TX2	0x036C	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_33_ID	0x036D	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_33_TX1	0x036E	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_33_TX2	0x036F	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_34_ID	0x0370	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_34_TX1	0x0371	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_34_TX2	0x0372	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_35_ID	0x0373	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_35_TX1	0x0374	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_35_TX2	0x0375	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_36_ID	0x0376	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_36_TX1	0x0377	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_36_TX2	0x0378	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_37_ID	0x0379	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_37_TX1	0x037A	For bit-field values, refer to ENTRY_00_TX1 above			

Table 182. TX\_PARAM\_ENTRY\_00\_ID (0x02D4)...continued

Entry ID	Address	Function	bits	Values	Description
ENTRY_37_TX2	0x037B	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_38_ID	0x037C	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_38_TX1	0x037D	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_38_TX2	0x037E	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_39_ID	0x037F	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_39_TX1	0x0380	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_39_TX2	0x0381	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_3A_ID	0x0382	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_3A_TX1	0x0383	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_3A_TX2	0x0384	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_3B_ID	0x0385	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_3B_TX1	0x0386	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_3B_TX2	0x0387	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_3C_ID	0x0388	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_3C_TX1	0x0389	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_3C_TX2	0x038A	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_3D_ID	0x038B	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_3D_TX1	0x038C	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_3D_TX2	0x038D	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_3E_ID	0x038E	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_3E_TX1	0x038F	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_3E_TX2	0x0390	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_3F_ID	0x0391	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_3F_TX1	0x0392	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_3F_TX2	0x0393	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_40_ID	0x0394	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_40_TX1	0x0395	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_40_TX2	0x0396	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_41_ID	0x0397	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_41_TX1	0x0398	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_41_TX2	0x0399	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_42_ID	0x039A	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_42_TX1	0x039B	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_42_TX2	0x039C	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_43_ID	0x039D	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_43_TX1	0x039E	For bit-field values, refer to ENTRY_00_TX1 above			

Table 182. TX\_PARAM\_ENTRY\_00\_ID (0x02D4)...continued

Entry ID	Address	Function	bits	Values	Description
ENTRY_43_TX2	0x039F	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_44_ID	0x03A0	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_44_TX1	0x03A1	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_44_TX2	0x03A2	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_45_ID	0x03A3	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_45_TX1	0x03A4	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_45_TX2	0x03A5	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_46_ID	0x03A6	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_46_TX1	0x03A7	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_46_TX2	0x03A8	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_47_ID	0x03A9	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_47_TX1	0x03AA	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_47_TX2	0x03AB	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_48_ID	0x03AC	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_48_TX1	0x03AD	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_48_TX2	0x03AE	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_49_ID	0x03AF	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_49_TX1	0x03B0	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_49_TX2	0x03B1	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_4A_ID	0x03B2	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_4A_TX1	0x03B3	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_4A_TX2	0x03B4	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_4B_ID	0x03B5	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_4B_TX1	0x03B6	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_4B_TX2	0x03B7	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_4C_ID	0x03B8	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_4C_TX1	0x03B9	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_4C_TX2	0x03BA	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_4D_ID	0x03BB	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_4D_TX1	0x03BC	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_4D_TX2	0x03BD	For bit-field values, refer to ENTRY_00_TX2 above			
ENTRY_4E_ID	0x03BE	For bit-field values, refer to ENTRY_00_ID above			
ENTRY_4E_TX1	0x03BF	For bit-field values, refer to ENTRY_00_TX1 above			
ENTRY_4E_TX2	0x03C0	For bit-field values, refer to ENTRY_00_TX2 above			

9.18.2.8 Autocol configuration settings

9.18.2.8.1 List of Autocoll configuration settings

List of Autocoll configuration settings

Table 183. List of Autocoll configuration settings

Configuration Parameter	Address (Hex)	Address (Decimal)	Size (in bytes)	EEPROM_AREA
<a href="#">RF_DEBOUNCE_TIMEOUT (0x03C4)</a>	0x03C4	964	1	EEPROM_SECURE_LIB_CONFIG
<a href="#">SENSE_RES (0x03C5)</a>	0x03C5	965	2	EEPROM_SECURE_LIB_CONFIG
<a href="#">NFC_ID1 (0x03C7)</a>	0x03C7	967	3	EEPROM_SECURE_LIB_CONFIG
<a href="#">SEL_RES (0x03CA)</a>	0x03CA	970	1	EEPROM_SECURE_LIB_CONFIG
<a href="#">FELICA_POLLRES (0x03CB)</a>	0x03CB	971	18	EEPROM_SECURE_LIB_CONFIG
<a href="#">RANDOM_UID_ENABLE (0x03DD)</a>	0x03DD	989	1	EEPROM_SECURE_LIB_CONFIG

9.18.2.8.2 RF\_DEBOUNCE\_TIMEOUT (0x03C4)

Debounce timeout

Table 184. RF\_DEBOUNCE\_TIMEOUT (0x03C4)

Function	bits	Values	Description
DEBOUNCE_TIMEOUT	[7:0]	-	Timeout used after the RF detection during the AUTOCOLL to detect if there is a glitch or continuous RF. Value is entered in 1 $\mu$ s.

9.18.2.8.3 SENSE\_RES (0x03C5)

Response to ReqA / ATQA in order byte 0, byte 1.

Table 185. SENSE\_RES (0x03C5)

Function	bits	Values	Description
Response to ReqA / ATQA	[15:0]		ATQA in order byte 0, byte 1
	[15:8]		Byte1 value
	[7:0]		Byte0 value



## 9.18.2.8.4 NFC\_ID1 (0x03C7)

Response to ReqA / ATQA in order byte 0, byte 1

Table 186. NFC\_ID1 (0x03C7)

Function	bits	Values	Description
UID address generation	[31:0]		If Random UID is disabled (EEPROM address 0x2CB), the content of these addresses is used to generate a Fixed UID. The order is byte 0, Byte 1, Byte 2; Byte3 - which is the first NFCID1 byte - is fixed to 08h, the check byte is calculated automatically.
	[31:24]	0x08	Byte3 value
	[23:16]		Byte2 value
	[15:8]		Byte1 value
	[7:0]		Byte0 value

## 9.18.2.8.5 SEL\_RES (0x03CA)

Response to Select : SAK.

Table 187. SEL\_RES (0x03CA)

Function	bits	Values	Description
Response to Select	[7:0]		Response to Select : SAK

## 9.18.2.8.6 FELICA\_POLLRES (0x03CB)

Response to Select : SAK

Table 188. FELICA\_POLLRES (0x03CB)

Function	byte	bits	Values	Description
Felica Poll response	[1:0]	[15:0]	0x01FE	FeliCa polling response. Shall be the same value.
	[7:2]	[47:0]		FeliCa polling response. NFCID2 (6 bytes).
	[15:8]	[63:0]		FeliCa polling response. PAD (8 bytes).
	[17:16]	[15:0]		FeliCa polling response. System code (2 bytes).

### 9.18.2.8.7 RANDOM\_UID\_ENABLE (0x03DD)

Random UID enable

Table 189. RANDOM\_UID\_ENABLE (0x03DD)

Function	bits	Values	Description
Random UID enable	[7:1]		Reserved
	[0]	0x00	Use UID stored in EEPROM
		0x01	Randomly generate the UID in which the first byte is fixed and the remaining 3 bytes are random. A new random number is generated after each RF-OFF to RF-ON.

### 9.18.2.9 LPCD related configuration parameters

#### 9.18.2.9.1 EEPROM\_LPCD\_SETTINGS\_LIST

List of LPCD related configuration settings

Table 190. List of LPCD related configuration settings

Configuration Parameter	Address (Hex)	Address (Decimal)	Size (in bytes)	EEPROM_AREA
EEPR10M_LPCD_SETTINGS_AVG_SAMPLES	0x03DE	990	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">LPCD_RSSI_TARGET (0x03E0)</a>	0x03E0	992	2	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">LPCD_RSSI_HYST (0x03E2)</a>	0x03E2	994	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">LPCD_CONFIG (0x03E3)</a>	0x03E3	995	2	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">LPCD_THRESHOLD (0x03E6)</a>	0x03E6	998	4	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">LPCD_WAIT_RX_SETTLE (0x03F7)</a>	0x03F7	1015	2	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">LPCD_VDDPA (0x03FB)</a>	0x03FB	1019	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">LPCD_CHECK_PERIOD (0x03FC)</a>	0x03FC	1020	2	E_PN76_EEPROM_SECURE_LIB_CONFIG

### 9.18.2.9.2 LPCD\_AVG\_SAMPLES (0x03DE)

Number of samples used for averaging

Table 191. LPCD\_AVG\_SAMPLES (0x03DE)

Function	bits	Values	Description
Random UID enable	[7:3]		Reserved
LPCD_AVG_SAMPLES	[2:0]		Defines how many samples of the I and Q values are used for the averaging. Average samples in power of 2.
		0x00	1 sample
		0x01	2 samples
		0x02	4 samples
		0x03	8 samples
		0x04	16 samples
		0x05	32 samples
		0x06	64 samples
		0x07	RFU

### 9.18.2.9.3 LPCD\_RSSI\_TARGET (0x03E0)

Table 192. LPCD\_RSSI\_TARGET (0x03E0)

Function	bits	Values	Description
LPCD_RSSI_TARGET	[15:0]		Value to be set in register DGRM_RSSI_REG_DGRM_RSSI_TARGET. Typically the same values from the Type A106 LOAD_RF_CONFIGURATION API (DGRM_RSSI register) are used.

### 9.18.2.9.4 LPCD\_RSSI\_HYST (0x03E2)

Table 193. LPCD\_RSSI\_HYST (0x03E2)

Function	bits	Values	Description
LPCD_RSSI_HYST	[7:0]		Value to be set in CLIF_DGRM_RSSI_REG_DGRM_RSSI_HYST. Typically the same values from the Type A106 LOAD_RF_CONFIGURATION API (DGRM_RSSI register) are used.

## 9.18.2.9.5 LPCD\_CONFIG (0x03E3)

Number of samples used for averaging

Table 194. LPCD\_CONFIG (0x03E3)

Function	bits	Values	Description
RFU	[15:8]		Reserved
Enable LPCD	[7]	0x00	Enable (1) / Disable (0) the LPCD
RFU	[6]		Reserved
RF OFF before TXLDO shutdown	[5]	0x00	Disables feature Immediate RF OFF before TXLDO shutdown to save power
		0x01	Enables feature Immediate RF OFF before TXLDO shutdown to save power. For this feature, Enable VDDPA fast discharge must be enabled.
RFU	[4:0]		Reserved

## 9.18.2.9.6 LPCD\_THRESHOLD (0x03E6)

LPCD threshold type depends upon the LPCD\_CONFIG[2:0] value in [Table 194](#)

For 'I and Q' mode: 1<sup>st</sup> threshold = I ch; 2<sup>nd</sup> threshold = Q ch.

Table 195. LPCD\_THRESHOLD (0x03E6)

Function	bits	Values	Description
LPCD Q channel threshold	[31:16]		ADC LSB granularity of threshold depends of avg_samples_meas value:
		0x00	unit 1
		0x01	unit 1/2
		0x02	unit 1/4
		0x03	unit 1/8
		0x04	unit 1/16
		0x05	unit 1/32
		Other	Reserved
LPCD I channel threshold	[15:0]	-	ADC LSB granularity of threshold depends of avg_samples_meas value:
		0x00	unit 1
		0x01	unit 1/2
		0x02	unit 1/4
		0x03	unit 1/8
		0x04	unit 1/16
		0x05	unit 1/32
		Other	Reserved

**Note:** If the difference between the measured value and the reference is greater than the threshold on either channels, then a card is detected.

9.18.2.9.7 LPCD\_WAIT\_RX\_SETTLE (0x03F7)

Delay between FieldOn and starting ADC data averaging.

Table 196. LPCD\_WAIT\_RX\_SETTLE (0x03F7)

Function	bits	Values	Description
LPCD DELAY	[15:0]		Delay between FieldOn and starting ADC data averaging. Value in us, default 14h = 20 μs

9.18.2.9.8 LPCD\_VDDPA (0x03FB)

VDDPA voltage when DCDC (internal or external) or external power source is used to feed TXLDO.

Table 197. LPCD\_VDDPA (0x03FB)

Function	bits	Values	Description
VDDPA voltage LPCD DELAY	[7:0]		TXLDO output voltage.
		0x00-0x2A	resultant voltage would be: 1V50 + this value × 0.1 V)
		Others	Reserved

9.18.2.9.9 WAIT\_RX\_SETTLE (0x03FC)

Timer value defining standby duration before calibration and reference measurement in LPCD single mode(Mode 4)

Table 198. WAIT\_RX\_SETTLE (0x03FC)

Function	bits	Values	Description
LPCD DELAY	[15:0]	-	2.63ms resolution, default 0x26 = ~100 ms

## 9.18.2.10 CORRECTION\_ENTRY\_TABLE

Table 199. CORRECTION\_ENTRY\_TABLE

Entry	Address	Function	bit	Values	Description
CORRECTION_ENTRY 0 for 1V5	0x042B	PROP_CORRECTION_ENTRY	[15:8]		Correction applied for ASK10 Range would be -128 to +127.
			[7:0]		Correction applied for ASK100. Range would be -128 to +127.
CORRECTION_ENTRY1 for 1.60V	0x042D	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY2 for 1.70V	0x042F	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY3 for 1.80V	0x0431	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY4 for 1.90V	0x0433	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY5 for 2.00V	0x0435	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY6 for 2.10V	0x0437	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY7 for 2.20V	0x0439	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY8 for 2.30V	0x043B	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY9 for 2.40V	0x043D	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY10 for 2.50V	0x043F	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY11 for 2.60V	0x0441	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY12 for 2.70V	0x0443	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY13 for 2.80V	0x0445	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY14 for 2.90V	0x0447	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY15 for 3.00V	0x0449	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY16 for 3.10V	0x044B	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY17 for 3.20V	0x044D	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY18 for 3.30V	0x044F	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY19 for 3.40V	0x0451	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			

Table 199. CORRECTION\_ENTRY\_TABLE...continued

Entry	Address	Function	bit	Values	Description
CORRECTION_ENTRY20 for 3.50V	0x0453	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY21 for 3.60V	0x0455	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY22 for 3.70V	0x0457	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY23 for 3.80V	0x0459	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY24 for 3.90V	0x045B	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY25 for 4.00V	0x045D	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY26 for 4.10V	0x045F	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY27 for 4.20V	0x0461	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY28 for 4.30V	0x0463	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY29 for 4.40V	0x0465	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY30 for 4.50V	0x0467	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY31 for 4.60V	0x0469	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY32 for 4.70V	0x046B	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY33 for 4.80V	0x046D	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY34 for 4.90V	0x046F	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY35 for 5.00V	0x0471	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY36 for 5.10V	0x0473	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY37 for 5.20V	0x0475	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY38 for 5.30V	0x0477	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY39 for 5.40V	0x0479	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY40 for 5.50V	0x047B	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			
CORRECTION_ENTRY41 for 5.60V	0x047D	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			

Table 199. CORRECTION\_ENTRY\_TABLE...continued

Entry	Address	Function	bit	Values	Description
CORRECTION_ENTRY42 for 5.70V	0x047F	Byte and bit-fields description, refer to CORRECTION_ENTRY 0			

### 9.18.2.11 TX\_SHAPING\_RTRANS\_FTRANS\_TABLE TX wave shaping for proprietary correction configuration for rising edge and falling edges. (0x0481)

#### 9.18.2.11.1 TX\_SHAPING\_RTRANS\_FTRANS\_1 (0x0481)

The rising Transition register values loaded when Proprietary TX Shaping configuration is set in the RM\_TECHNO\_TX\_SHAPING table to use proprietary TX shaping.

Table 200. TX\_SHAPING\_RTRANS\_FTRANS\_1 (0x0481)

Function	Address	Bytes	Bits	Description
RTRANS0	0x0481	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS1	0x0485	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS2	0x0489	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS3	0x048D	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
FTRANS0	0x0491	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS1	0x0495	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS2	0x0499	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS3	0x049D	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge



### 9.18.2.11.2 TX\_SHAPING\_RTRANS\_FTRANS\_2 (0x4A1)

The rising Transition register values loaded when Proprietary TX Shaping configuration is set in the RM\_TECHNO\_TX\_SHAPING table to use proprietary TX shaping.

Table 201. TX\_SHAPING\_RTRANS\_FTRANS\_2 (0x4A1)

Function	Address	Bytes	Bits	Description
RTRANS0	0x4A1	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS1	0x04A5	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS2	0x04A9	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS3	0x04AD	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
FTRANS0	0x04B1	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS1	0x04B5	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS2	0x04B9	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS3	0x04BD	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge

### 9.18.2.11.3 TX\_SHAPING\_RTRANS\_FTRANS\_3 (0x04C1)

The rising Transition register values loaded when Proprietary TX Shaping configuration is set in the RM\_TECHNO\_TX\_SHAPING table to use proprietary TX shaping.

Table 202. TX\_SHAPING\_RTRANS\_FTRANS\_3 (0x04C1)

Function	Address	Bytes	Bits	Description
RTRANS0	0x04C1	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS1	0x04C5	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS2	0x04C9	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS3	0x04CD	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
FTRANS0	0x04D1	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS1	0x04D5	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS2	0x04D9	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS3	0x04DD	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge

9.18.2.11.4 TX\_SHAPING\_RTRANS\_FTRANS\_1 (0x04E1)

The rising Transition register values loaded when Proprietary TX Shaping configuration is set in the RM\_TECHNO\_TX\_SHAPING table to use proprietary TX shaping.

Table 203. TX\_SHAPING\_RTRANS\_FTRANS\_1 (0x04E1)

Function	Address	Bytes	Bits	Description
RTRANS0	0x04E1	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS1	0x04E5	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS2	0x04E9	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
RTRANS3	0x04ED	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the rising edge
FTRANS0	0x04F1	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS1	0x04F5	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS2	0x04F9	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge
FTRANS3	0x04FD	[3:0]	[31:0]	These values apply in case EDGE_STYLE = 0 is configured for the falling edge

9.18.2.12 TX driver NOV (non-overlap) settings configuration.

9.18.2.12.1 EEPROM\_TX\_DRIVER\_NOV\_LIST

List of NOV configuration parameters

Table 204. List of NOV configuration parameters

Configuration Parameter	Address (Hex)	Address (Decimal)	Size (in bytes)	EEPROM_AREA
<a href="#">NOV_CFG_CAL (0x0501)</a>	0x0501	1281	1	EEPROM_SECURE_LIB_CONFIG
<a href="#">NOV_CAL_VAL1 (0x0502)</a>	0x0502	1282	1	EEPROM_SECURE_LIB_CONFIG
<a href="#">NOV_CAL_VAL2 (0x0503)</a>	0x0503	1283	1	EEPROM_SECURE_LIB_CONFIG
<a href="#">NOV_CAL_THRESHOLD (0x0504)</a>	0x0504	1284	1	EEPROM_SECURE_LIB_CONFIG
<a href="#">NOV_CAL_OFFSET1 (0x0505)</a>	0x0505	1285	4	EEPROM_SECURE_LIB_CONFIG
<a href="#">NOV_CAL_OFFSET2 (0x0509)</a>	0x0509	1289	4	EEPROM_SECURE_LIB_CONFIG

## 9.18.2.12.2 NOV\_CFG\_CAL (0x0501)

NOV calibration type

Table 205. NOV\_CFG\_CAL (0x0501)

Function	bits	Values	Description
RFU	[7:2]	-	Reserved
NOV_CALIBRATION_TYPE	[1:0]	0x00	No calibration performed, needs to be updated to 01 or 10 before the first RF on of the chip is performed.
		0x01	Enable FW calibration after every cold boot.
		0x02	Use calibration value coming from EEPROM NOV_CAL_VAL1, NOV_CAL_VAL2 (Default)
		0x03	RFU

## 9.18.2.12.3 NOV\_CAL\_VAL1 (0x0502)

Table 206. NOV\_CAL\_VAL1 (0x0502)

Function	bits	Values	Description
VDDPACALVAL1	[7:0]	0x03	(1.8 V)
		0x0D	(2.8 V)

## 9.18.2.12.4 NOV\_CAL\_VAL2 (0x0503)

Table 207. NOV\_CAL\_VAL2 (0x0503)

Function	bits	Values	Description
VDDPACALVAL2	[7:0]	0x15	(3.6 V)
		0x24	(5.1 V)

## 9.18.2.12.5 NOV\_CAL\_THRESHOLD (0x0504)

Table 208. NOV\_CAL\_THRESHOLD (0x0504)

Function	bits	Values	Description
VDDPACALVAL2	[7:0]	0x08	(2.3 V)
		0x16	(3.7 V)

## 9.18.2.12.6 NOV\_CAL\_OFFSET1 (0x0505)

Table 209. NOV\_CAL\_OFFSET1 (0x0505)

Function	bits	Values	Description
RFU	[31:29]		Reserved
VDDAPA MIN	[28:24]		Group#1 (VDDPA min to CfgThreshold), offset_2l(1)
	[23:21]		Reserved
	[20:16]		Group#1 (VDDPA min to CfgThreshold), offset_2l(0)
	[15:13]		Reserved
	[12:08]		Group#1 (VDDPA min to CfgThreshold), offset_3l_p2
	[07:05]		Reserved
	[04:00]		Group#1 (VDDPA min to CfgThreshold), offset_3l

## 9.18.2.12.7 NOV\_CAL\_OFFSET2 (0x0509)

Table 210. NOV\_CAL\_OFFSET2 (0x0509)

Function	bits	Values	Description
RFU	[31:29]		Reserved
VDDAPA MAX	[28:24]		Group#1 (VDDPA max to CfgThreshold), offset_2l(1)
	[23:21]		Reserved
	[20:16]		Group#1 (VDDPA max to CfgThreshold), offset_2l(0)
	[15:13]		Reserved
	[12:08]		Group#1 (VDDPA max to CfgThreshold), offset_3l_p2
	[07:05]		Reserved
	[04:00]		Group#1 (VDDPA max to CfgThreshold), offset_3l

## 9.18.2.13 Active reader mode TX wave shaping configuration

This section provides the active reader mode TX wave shaping configuration settings.

## 9.18.2.13.1 RESIDUAL\_AMPL\_LEVEL\_ACTIVE\_A106 (0X050E)

Table 211. RESIDUAL\_AMPL\_LEVEL\_ACTIVE\_A106 (0X050E)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.13.2 EDGE\_TYPE\_ACTIVE\_A106 (0X050F)

Table 212. EDGE\_TYPE\_ACTIVE\_A106 (0X050F)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.13.3 EDGE\_STYLE\_ACTIVE\_A106 (0X0510)

Table 213. EDGE\_STYLE\_ACTIVE\_A106 (0X0510)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_A106 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A106 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]		Defines edge style configuration
			For Firmware based shaping ( bEdgeType_A106 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_A106 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.13.4 EDGE\_LENGTH\_ACTIVE\_A106 (0X0511)

Table 214. EDGE\_LENGTH\_ACTIVE\_A106 (0X0511)

Function	bit	Values	Description
Edge transition length	[7]		Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.13.5 RESIDUAL\_AMPL\_LEVEL\_ACTIVE\_F212 (0X0512)

Table 215. RESIDUAL\_AMPL\_LEVEL\_ACTIVE\_F212 (0X0512)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier

9.18.2.13.6 EDGE\_TYPE\_ACTIVE\_F212 (0X0513)

Table 216. EDGE\_TYPE\_ACTIVE\_F212 (0X0513)

Function	bit	Values	Description
Edge transition style	[7:4]	Defines style of edge transition of falling edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU
	[3:0]	Definition of edge transition style of rising edge, Defines style of edge transition:	
		Firmware based shaping	
		0x01	linear transition between two amplitude levels
		0x02	two linear transitions between amplitude levels
		0x03	three linear transitions between amplitude levels
		Others	RFU
		Lookup table based shaping	
		0x04	lookup table-based transition, no automatic adaptation based on VDDPA
		0x05	lookup table-based transition, automatic adaptation based on VDDPA including Correction
		0x06	lookup table-based transition, automatic adaptation based on VDDPA but no Correction
		Others	RFU

## 9.18.2.13.7 EDGE\_STYLE\_ACTIVE\_F212 (0X0514)

Table 217. EDGE\_STYLE\_ACTIVE\_F212 (0X0514)

Function	bit	Values	Description
RFU	[7]	RFU	
Edge style configuration falling edge	[6:4]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_F212 is 1, 2, or 3: time constant configuration of falling edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_F212 is 4, 5, or 6: This number is the lookup table which shall be used of falling edge (0,1,2,3)
RFU	[3]		RFU
Edge style configuration rising edge	[2:0]	Defines edge style configuration	
			For Firmware based shaping ( bEdgeType_F212 is 1, 2, or 3: time constant configuration of rising edge (depends on edge style)
			For lookup table based shaping ( bEdgeType_F212 is 4, 5, or 6: This number is the lookup table which shall be used of rising edge (0,1,2,3)

## 9.18.2.13.8 EDGE\_LENGTH\_ACTIVE\_F212 (0X0515)

Table 218. EDGE\_LENGTH\_ACTIVE\_F212 (0X0515)

Function	bit	Values	Description
Edge transition length	[7]	Scaling of edge transition by factor 2 of rising/falling edge (refers to both rising and falling edge at the same time)	
		0x00	disabled (1 transition state = one carrier cycle)
		0x01	enabled (1 transition state = two carrier cycles)
	[6:5]		RFU
	[4:0]		Number of active transition states in rising and falling edge pattern (refers to both rising and falling edge at the same time)

## 9.18.2.13.9 RESIDUAL\_AMPL\_LEVEL\_ACTIVE\_F424 (0X0516)

Table 219. RESIDUAL\_AMPL\_LEVEL\_ACTIVE\_F424 (0X0516)

Function	bit	Values	Description
Residual amplitude level	[7:0]	0x00	0 % carrier
		0xFF	100 % carrier



9.18.2.14 Global TX\_SHAPING configuration

This section provides configuration global TX waveform shaping settings.

9.18.2.14.1 EEPROM\_RM\_GLOBAL\_TX\_SHAPING\_LIST

List of Settings related TX\_SHAPING configuration.

Table 220. List of Settings related TX\_SHAPING configuration.

Configuration Parameter	Address (Hex)	Address (Decimal)	Size (in bytes)	EEPROM_AREA
<a href="#">TX_SHAPING_CONIFG (0x058C)</a>	0x058C	1420	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TX_INV_RM (0x058D)</a>	0x058D	1421	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TX_CLK_MODE_1 (0x058E)</a>	0x058E	1422	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TX_CLK_MODE_2 (0x058F)</a>	0x058F	1423	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">GSN_MOD_RM (0x0590)</a>	0x0590	1424	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">GSN_CW_RM (0x0591)</a>	0x0591	1425	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">GSP_RM (0x0592)</a>	0x0592	1426	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TX_FRCZERO_THR (0x0593)</a>	0x0593	1427	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">SIGNAL_SCALING_CONFIG (0x0594)</a>	0x0594	1428	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TX_PH_SHIFT_DIV10 (0x0595)</a>	0x0595	1429	1	E_PN76_EEPROM_SECURE_LIB_CONFIG
<a href="#">TX_PH_SHIFT_MOD10 (0x0596)</a>	0x0596	1430	1	E_PN76_EEPROM_SECURE_LIB_CONFIG

9.18.2.14.2 TX\_SHAPING\_CONIFG (0x058C)

PWM scheme for RM

Table 221. TX\_SHAPING\_CONIFG (0x058C)

Function	bits	Values	Description
RFU	[7:1]		Reserved
PWM scheme for RM	[0]	0x00	defining 3-levels for drivers TX1/2 - required for balanced antenna (default)
		0x01	defining 2-levels for drivers TX1/2 - required for single ended antenna

9.18.2.14.3 TX\_INV\_RM (0x058D)

Transmitter configuration

Table 222. TX\_INV\_RM (0x058D)

Function	bits	Values	Description
RFU	[7:6]		Reserved
TX1 output configuration	[5]	0x00	TX1 non-inverted output (output zero remains zero)
		0x01	TX1 inverted output (common mode operation, output zero becomes one)
TX2 output configuration	[4]	0x00	TX2 non-inverted output (output zero remains zero)
		0x01	TX2 inverted output (common mode operation, output zero becomes one)
RFU	[3:2]		Reserved
TX1 phase shift configuration	[1]	0x00	TX1 no phase shift, 0 deg
		0x01	TX1 phase shifted by 180 deg
TX2 phase shift configuration	[0]	0x00	TX2 no phase shift, 0 deg
		0x01	TX2 phase shifted by 180 deg

9.18.2.14.4 TX\_CLK\_MODE\_1 (0x058E)

Transmitter configuration

Table 223. TX\_CLK\_MODE\_1 (0x058E)

Function	bits	Values	Description
RFU	[7]		Reserved
CLK_MODE_CW_RM	[6:4]		CLK_MODE_CW_RM
RFU	[3]		Reserved
CLK_MODE_MOD_RM	[2:0]		CLK_MODE_MOD_RM

9.18.2.14.5 TX\_CLK\_MODE\_2 (0x058F)

CLK\_MODE configuration

Table 224. TX\_CLK\_MODE\_2 (0x058F)

Function	bits	Values	Description
RFU	[7]		Reserved
CLK_MODE_DEFAULT	[6:4]		CLK_MODE_DEFAULT
RFU	[3]		Reserved
CLK_MODE_TRANS_RM	[2:0]		CLK_MODE_TRANS_RM

9.18.2.14.6 GSN\_MOD\_RM (0x0590)

GSN\_MOD\_RM configuration

Table 225. GSN\_MOD\_RM (0x0590)

Function	bits	Values	Description
RFU	[7:5]		Reserved
GSN_MOD_RM	[4:0]		GSN_MOD_RM

9.18.2.14.7 GSN\_CW\_RM (0x0591)

GSN\_CW\_RM configuration

Table 226. GSN\_CW\_RM (0x0591)

Function	bits	Values	Description
RFU	[7:5]		Reserved
GSN_CW_RM	[4:0]		GSN_CW_RM

9.18.2.14.8 GSP\_RM (0x0592)

GSP\_RM configuration

Table 227. GSP\_RM (0x0592)

Function	bits	Values	Description
RFU	[7:5]		Reserved
GSP_RM	[4:0]		GSP_RM

9.18.2.14.9 TX\_FRCZERO\_THR (0x0593)

CLIF\_SS\_TX\_CFG\_REG configuration

Table 228. TX\_FRCZERO\_THR (0x0593)

Function	bits	Values	Description
RFU	[7]		Reserved
CLIF_SS_TX_CFG_REG	[6:0]		Defining CLIF_SS_TX_CFG_REG[12:6]

9.18.2.14.10 SIGNAL\_SCALING\_CONFIG (0x0594)

Global TX\_SS\_TARGET\_SCALE configuration

Table 229. SIGNAL\_SCALING\_CONFIG (0x0594)

Function	bits	Values	Description
Global TX_SS_TARGET_SCALE	[7:0]		Global TX_SS_TARGET_SCALE configuration for debugging purposes

9.18.2.14.11 TX\_PH\_SHIFT\_DIV10 (0x0595)

Global TX\_SS\_TARGET\_SCALE configuration

Table 230. TX\_PH\_SHIFT\_DIV10 (0x0595)

Function	bits	Values	Description
RFU	[7:5]		Reserved
CLIF_ANACTRL_TX_CONFIG_REG	[4:0]		CLIF_ANACTRL_TX_CONFIG_REG.TX_PH_SHIFT_DIV10

9.18.2.14.12 TX\_PH\_SHIFT\_MOD10 (0x0596)

Global CLIF\_ANACTRL\_TX\_CONFIG\_REG.TX\_PH\_SHIFT\_MOD10 configuration

Table 231. TX\_PH\_SHIFT\_MOD10 (0x0596)

Function	bits	Values	Description
RFU	[7:4]		Reserved
CLIF_ANACTRL_TX_CONFIG_REG.TX_PH_SHIFT_MOD10	[3:0]		CLIF_ANACTRL_TX_CONFIG_REG.TX_PH_SHIFT_MOD10

9.18.2.15 RFLD and NFCLD settings

9.18.2.15.1 EEPROM\_RFLD\_NFCLD\_SETTINGS\_LIST

List of settings related to RFLD and NFCLD

Table 232. List of settings related to RFLD and NFCLD

Configuration Parameter	Address (Hex)	Address (Decimal)	Size (in bytes)	EEPROM_AREA
<a href="#">NFCLD_RFLD_VALID (0x05C5)</a>	0x05C5	1477	1	EEPROM_SECURE_LIB_CONFIG

9.18.2.15.2 NFCLD\_RFLD\_VALID (0x05C5)

Table 233. NFCLD\_RFLD\_VALID (0x05C5)

Function	bits	Values	Description
RFU	[7:1]		Resreved.
NFCLD_RFLD_VALID	[0:0]		If this bit is set to 1 then the NFCLD Threshold and RFLD Threshold is a valid data and calibration wont be done gain till this bit is cleared and POR is issued.

9.18.2.16 TEMPERATURE related settings

This section provides the configuration of Temperature warning settings.

9.18.2.16.1 EEPROM\_TEMP\_WARNING\_LIST

List of settings for Temperature related cut-offs and notifications

Table 234. List of settings for Temperature related cut-offs and notifications

Configuration Parameter	Address (Hex)	Address (Decimal)	Size (in bytes)	EEPROM_AREA
<a href="#">TEMP_WARNING (0x0648)</a>	0x0648	1608	1	EEPROM_SECURE_LIB_CONFIG

9.18.2.16.2 TEMP\_WARNING (0x0648)

Table 235. TEMP\_WARNING (0x0648)

Function	bits	Values	Description
PMU high threshold	[7:6]	0x00	Disabled
		0x01	114 °C
		0x02	125 °C
		0x03	130 °C
PMU low threshold	[5:4]	0x00	Disabled
		0x01	114 °C
		0x02	125 °C
		0x03	130 °C
CLIF high threshold	[3:2]	0x00	Disabled
		0x01	114 °C
		0x02	125 °C
		0x03	130 °C
CLIF low threshold	[1:0]	0x00	Disabled
		0x01	114 °C
		0x02	125 °C
		0x03	130 °C

9.18.2.17 TESTBUS configuration settings

This section provides the configuration of Testbus related settings.

9.18.2.17.1 DigitalTBSignalIndex (06A3h)

Test bus number to be configured. Selected from the list of exposed test buses described in the user manual.

Table 236. DigitalTBSignalIndex (address 06A3h) EEPROM configuration bit description

Address (hex)	Function	Bit	Description
6A3	TB signal index	7:0	Digital signal test bus number from table "CTS and test bus signals" in the user manual Valid data as described in table, all others: RFU

9.18.2.17.2 DigitalTBSignalBit (06A4h)

Test bus bit number to be configured. Selected from the list of exposed test buses described in the user manual.

Table 237. DigitalTBSignalBit (address 06A4h) EEPROM configuration bit description

Address (hex)	Function	Bit	Description
6A4	TB signal bit	7:0	Digital signal test bus bit number from table "CTS and test bus signals" in the user manual Valid data as described in table, all others: RFU

9.18.2.17.3 AnalogTBSignalIndex (06A5h)

Analog test bus to be configured. Selected from the list of exposed test buses described in the user manual.

Table 238. AnalogTBSignalIndex (address 06A5h) EEPROM configuration bit description

Address (hex)	Function	Bit	Description
6A5		7:0	Analog signal test bus number: 0x78 - obs_clif_tbcontrol_patchbox0 0x79 - obs_clif_tbcontrol_patchbox1 0x7A - obs_clif_tbcontrol_patchbox2 0x7B - obs_clif_tbcontrol_patchbox3 all others: RFU

9.18.2.18 Contact interface configuration settings

This section provides the configuration of the contact interface settings.

9.18.2.18.1 CT\_PROFILE\_CONFIG (0x06B1)

Parameter to configure the Mode of CT interface profile

Table 239. CT\_PROFILE\_CONFIG (0x06B1)

Function	bit	Values	Description
	15:8		0x20: Slot 1 0x21: Slot 2 0x22: Slot 3 Other values => RFU
	7:0		0x00 => ISO Mode 0x01 => EMVCo Mode 0x02-0xFF => RFU

9.18.2.18.2 CT\_CHIPSELECT\_CONFIG (0x06B3)

Parameter to configure the number of CT slots:

Table 240. CT\_CHIPSELECT\_CONFIG (0x06B3)

Function	bit	Values	Description
RFU	[23:16]		Byte 3 (LSB) value : RFU 0x01 => Default
Number of CT Slots Enabled	[15:8]		0x03 => Slot1, Slot2 & Slot3 enabled (all 3 CT slots enabled) 0x02 => Slot1 & Slot2 Enabled (2 CT slots enabled) 0x01 => Slot1 Enabled (only 1 CT slot enabled) 0x04-0xFF => RFU
RFU	[7:0]		1 (MSB) value : RFU Default : 0xFF

## 10 Limiting values

**Table 241. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD(VUP\_TX)}$	supply voltage on pin VUP_TX	-	-0.3	6.3	V
$V_{DD(VBAT)}$	supply voltage on pin VBAT	-	-0.3	5.8	V
$V_{DD(VDDIO)}$	supply voltage on pin VDDIO	on pin VDDIO, power supply for host interface and GPIOs	-0.3	3.8	V
$V_{DD(GPIO\_x)}$	input voltage on pin used as GPIO	-	-0.3	3.8	V
$V_{DD(VDDPA)}$	supply voltage on pin VDDPA	maximum limiting values for $I_{DD(VDDPA)}$ and $T_{j(max)}$ not violated	-	6.0	V
$V_{i(RXP)}$	input voltage on pin RXP	-	-0.3	2	V
$V_{i(RXN)}$	input voltage on pin RXN	-	-0.3	2	V
$V_{ESD}$	electrostatic discharge voltage	human body model (HBM) <sup>[1]</sup>	-2000	2000	V
		charge device model (CDM) <sup>[2]</sup>	-500	500	V
$T_{j(max)}$	junction temperature	-	-	125	°C
$T_{stg}$	storage temperature	no supply voltage applied	-55	150	°C

[1] According to ANSI/ESDA/JEDEC JS-001

[2] According to ANSI/ESDA/JEDEC JS-002

Stress above one or more of the limiting values may cause permanent damage to the device or limit the lifetime.

Product might not behave according to specification.



## 11 Characteristics

This chapter describes the electrical characteristics for the usage of the product.

Functionality according to this specification and compliancy to referred standards is guaranteed if the device is operated within the limits.

For further information, refer to the PQP (product qualification package) which summarizes the results of the characterization and qualification performed.

### 11.1 Static characteristics

Table 242. Supply voltage

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DD(VBAT\_PWR)}$	supply voltage on pin VBAT_PWR (DC-DC input pin)	DC-DC disabled	2.4	-	5.5	V
		DC-DC enabled	2.8	-	4.8	V
$V_{DD(VUP\_TX)}$	supply voltage on pin VUP_TX (TX_LDO input pin)	Remark: If DC-DC is used, its output $V_{DD(BOOST)}$ Min is limited to 3.1 V	2.4	-	6	V
$V_{DD(VDDPA)}$	supply voltage on pin VDDPA (input of the transmitter power amplifier)	-	1.5	-	5.7	V
$V_{DD(VDDPA)}$	supply voltage on pin VDDPA		2.4	-	4.7	V
$V_{DD(VBAT)}$	supply voltage on pin VBAT (analog and digital supply)	$VBAT \geq VDDIO$	2.4	-	5.5	V
$V_{DD(VDDIO)}$	supply voltage on pin VDDIO (supply for host interface and GPIOs)	typical 1.8 V interface supply voltage	1.62	-	1.98	V
		typical 3.3 V interface supply voltage	2.4	-	3.6	V
$V_{I(RXP)}$	input voltage on pin RXP	-	-0.5	-	1.8	V
$V_{I(RXN)}$	input voltage on pin RXN	-	-0.5	-	1.8	V

**Note:** The voltage on pin VDDIO must always be smaller or equal to the voltage on pin VBAT.

Table 243. Current consumption in active mode

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{DD(VBAT)}$	system supply		-	-	20	mA
$I_{DD(VDDIO)}$		This current depends on the output current of peripherals. At no time, the sum of the maximum output currents shall exceed $I_{DD(VDDIO)} \text{ max}$	-	-	30	mA
$I_{DD(BOOST\_IN)}$	DC-DC boost supply	average input current	-	-	1.0	A
		peak input current (short peak)	-	-	1.7	A

Table 243. Current consumption in active mode...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{DD}(VUP\_TX)$	input supply for transmitter LDO	-	-	-	350	mA
$I_{DD}(VDDPA)$	RF power amplifier (transmitter) current	supplied via VUP_TX (TX_LDO active)	-	-	350	mA
		supplied without DC-DC and without TXLDO active	-	-	400	mA

Table 244. Current consumption during power-saving modes

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{OFF}$ Plus Mode (VDDIO+VBAT)	sum of supply current on pin VDDIO and VBAT in OFF Plus mode	25 °C ambient operating temperature	-	5	-	μA
$I_{hard}$ power down (VDDIO+VBAT)	sum of supply current on pin VDDIO and VBAT in hard Power-down mode	25 °C ambient operating temperature	-	40	105	μA
$I_{standby}$ (VDDIO +VBAT)	sum of supply current on pin VDDIO and VBAT in Standby mode	25 °C ambient operating temperature	-	45	110	μA
$I_{suspend}$ (VBAT)	supply current on pin VBAT in suspend mode	25 °C ambient operating temperature	-	2.5	-	mA
$I_{LPCD}$ (VDDIO+VBAT)	sum of supply current on pin VDDIO and VBAT in LPCD (Enhanced Low-Power Card Detection with highest sensitivity) mode, without DC-DC used	25 °C ambient operating temperature, VBAT supply voltage 3.6 V, antenna matching 50 R, 3x RF-on per second	-	250	-	μA

Table 245. Overcurrent detection function

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{DD}(VUP\_TX)$	current of overcurrent detection becoming active	-	450	550	650	mA

The Overcurrent detection function is a safety feature only. A design shall not functionally rely on this feature since the operating conditions will be violated if the overcurrent detection becomes active.

Table 246. VEN pin

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{IH}$	HIGH-level input voltage	$V_{DD}(VDDIO) \leq V_{DD}(VBAT)$	$0.7 \times V_{DD}(VDDIO)$	-	$V_{DD}(VDDIO)$	V
$V_{IL}$	LOW-level input voltage		0	-	$0.3 \times V_{DD}(VDDIO)$	V
$I_{IH}$	HIGH-level input current	$V_I = V_{DD}(VBAT)$	-	-	1	μA
$I_{IL}$	LOW-level input current	$V_I = 0$ V	-1	-	-	μA

Table 246. VEN pin ...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
C <sub>i</sub>	input capacitance		-	5	-	pF

Table 247. CLK1, CLK2 pins

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>i(p-p)</sub>	peak-to-peak input voltage	-	0.4	-	1.65	V
I <sub>IH</sub>	HIGH-level input current	V <sub>I</sub> = 1.65 V, no power saving, active mode	-	-	5	μA
I <sub>IL</sub>	LOW-level input current	V <sub>I</sub> = 0 V, no power saving, active mode	-	-	1	μA
δ	duty cycle	-	35	-	65	%
C <sub>i(CLK1)</sub>	input capacitance on pin CLK1	VDD = 1.8 V, VDC = 0.65 V, VAC = 0.9 V (p-p)	-	1	-	pF
C <sub>i(CLK2)</sub>	input capacitance on pin CLK2	VDD = 1.8 V, VDC = 0.65 V, VAC = 0.9 V (p-p)	-	1	-	pF

Table 248. IRQ1 pin

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OH</sub> < 3 mA	V <sub>DD(VDDIO)</sub> - 0.4	-	V <sub>DD(VDDIO)</sub>	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> < 3 mA	0	-	0.4	V
I <sub>OH</sub>	HIGH-level output current		-	-	3	mA
I <sub>OL</sub>	LOW-level output current		-	-	3	mA
C <sub>L</sub>	load capacitance		-	-	10	pF
t <sub>f</sub>	fall time	C <sub>L</sub> = 12 pF max	1	-	3	ns
t <sub>r</sub>	rise time	C <sub>L</sub> = 12 pF max	1	-	3	ns
R <sub>pd</sub>	pull-down resistance		40	-	62	kΩ

Table 249. SPI SCK / I2C1\_SCL, SPI NSS / I2C Adr Bit 0, SPI COTI / I2C Adr Bit 1 pins

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>IH</sub>	HIGH-level input voltage		0.65 × V <sub>DD(VDDIO)</sub>	-	V <sub>DD(VDDIO)</sub>	V
V <sub>IL</sub>	LOW-level input voltage		- 0.5	-	0.35 × V <sub>DD(VDDIO)</sub>	V
I <sub>IH</sub>	HIGH-level input current	V <sub>I</sub> = V <sub>VDDIO</sub>	-	-	1	μA
I <sub>IL</sub>	LOW-level input current	V <sub>I</sub> = 0 V	-	-	1	μA
C <sub>i</sub>	input capacitance		-	5	-	pF

Table 250. I2C1\_SDA pin

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OH</sub> < 3 mA	V <sub>DD(VDDIO)</sub> - 0.4	-	V <sub>DD(VDDIO)</sub>	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> < 3 mA	0	-	0.4	V
I <sub>OH</sub>	HIGH-level output current		-	-	3	mA
I <sub>OL</sub>	LOW-level output current		-	-	3	mA
C <sub>L</sub>	load capacitance		-	-	10	pF
t <sub>f</sub>	fall time	C <sub>L</sub> = 12 pF max	1	-	3	ns
t <sub>r</sub>	rise time	C <sub>L</sub> = 12 pF max	1	-	3	ns

Table 251. Mode selection, HOST\_IF\_SEL0, HOST\_IF\_SEL1, I2C2\_IRQ, WAKEUP pins

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>IH</sub>	HIGH-level input voltage	V <sub>DD(VDDIO)</sub> ≤ V <sub>DD(VBAT)</sub> ; 1.62 ≤ VDDIO ≤ 1.98 or 2.4 ≤ VDDIO ≤ 3.6	0.65 × VDDIO	-	VDDIO + 0.5 V	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>DD(VDDIO)</sub> ≤ V <sub>DD(VBAT)</sub> ; 1.62 ≤ VDDIO ≤ 1.98 or 2.4 ≤ VDDIO ≤ 3.6	- 0.5	-	0.35 × VDDIO	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>DD(VDDIO)</sub> = 3.3 V	VDDIO - 0.4	-	VDDIO	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>DD(VDDIO)</sub> = 3.3 V	0	-	0.4	V
I <sub>OH</sub>	HIGH-level output current	V <sub>DD(VDDIO)</sub> = 3.3 V	-	-	3	mA
I <sub>OL</sub>	LOW-level output current	V <sub>DD(VDDIO)</sub> = 3.3 V	-	-	3	mA
I <sub>IH</sub>	HIGH-level input current	V <sub>DD(VDDIO)</sub> = 3.3 V	-	-	1	μA
I <sub>IL</sub>	LOW-level input current	V <sub>DD(VDDIO)</sub> = 3.3 V	-	-	1	μA
R <sub>PU</sub>	Weak pullup resistor	-	40	50	62	kΩ
R <sub>PD</sub>	Weak pulldown resistor	-	40	50	62	kΩ

Table 252. RXp, RXn pins

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>i(dyn)</sub>	dynamic input voltage		-	-	1.8	V
C <sub>i</sub>	input capacitance		-	1	-	pF
Z <sub>i</sub>	input impedance from RXN, RXP pins to VMID	Reader, card, and P2P modes	-	-	15	kΩ

Table 253. TX1, TX2 pins

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>OH</sub>	HIGH-level output voltage	V <sub>DD(VDDPA)</sub> = 5 V; with internal VDDPA LDO	-	V <sub>DD(VDDPA)</sub> -150 mV	V <sub>DD(VDDPA)</sub>	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>DD(VDDPA)</sub> = 5 V; with internal VDDPA LDO	0	200	-	mV

Table 254. AUX1, AUX2, AUX3 pins (Debug output)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>AUX_OH</sub>	HIGH-level output voltage	pin used as debug signal output	VDDIO - 0.4	-	VDDIO	V
V <sub>AUX_OL</sub>	LOW-level output voltage	pin used as debug signal output	0	-	0.4	mV
I <sub>AUX_OH</sub>	HIGH-level output current	V <sub>DD(VDDIO)</sub> = 3.3 V	-	-	3	mA
I <sub>AUX_OL</sub>	LOW-level output current	V <sub>DD(VDDIO)</sub> = 3.3 V	-	-	3	mA
C <sub>O_LOAD</sub>	output capacitance load of pin		-	5	10	pF

## 11.2 Timing characteristics

Table 255. Power supply connection timing

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>rise_vbat</sub>	VBAT supply ramp	VEN = Low	0	-	2.75	V/μs
t <sub>vbat_vddio</sub>	time between ramping up VBAT and ramping VDDIO	vddio condition: VBAT>2.4 V, VDDIO supply (External), hpd_off_sel = x	0	500	1000	ms
t <sub>vbat_ven</sub>	time between ramping VBAT and VEN	vddio condition: VBAT>2.4 V, VDDIO supply (External), hpd_off_sel = x	0	500.5	-	ms
t <sub>boot</sub>	start-up time <sup>[1]</sup>	vddio condition: VBAT>2.4 V, VDDIO supply (External), hpd_off_sel = x	3.2	3.27	dependent on configuration of XTAL_CHECK_DELAY (0013h) in EEPROM. This configuration can be used to optimize the boot time for crystals which allow a fast settling. This allows to optimize the average current consumption during LPCD.	ms

[1] (PN7220 ready to receive commands on the host interface). For ULPCD and LPCD, the PN7220 indicates the ability to receive commands from a host by raising an IDLE IRQ.

Table 256. Pulse length

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>(VEN)</sub>	on Pin VEN, pulse width to reset the chip or exit from Hard power down State	-	5	-	-	ms

Table 257. I<sup>2</sup>C timing specification: Standard, Fast Mode

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f <sub>SCL</sub>	SCL clock frequency	Load capacitance < 400 pF	0	-	0.4	MHz
t <sub>SU</sub> START	Set-up time for a (repeated) START condition	Load capacitance < 400 pF	600	-	-	ns
t <sub>HD</sub> START	hold time of a (repeated) START condition	Load capacitance < 400 pF	600	-	-	ns
t <sub>LOW</sub>	Timing of the LOW period of the SCL clock	Load capacitance < 400 pF	1.3	-	-	μs
t <sub>HIGH</sub>	Timing of the HIGH period of the SCL clock	Load capacitance < 400 pF	600	-	-	ns
t <sub>SU</sub> DATA	DATA set-up time	Load capacitance < 400 pF	100	-	-	ns
t <sub>HD</sub> DATA	DATA hold-up time	Load capacitance < 400 pF	0	-	900	ns
t <sub>rDA</sub>	Rise time of SDA	Load capacitance < 400 pF	30	-	250	ns
t <sub>fDA</sub>	Fall time of SDA	Load capacitance < 400 pF	30	-	250	ns

Table 258. I<sup>2</sup>C timing specification: High-Speed Mode

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f <sub>SCL</sub>	SCL clock frequency	Load capacitance < 100 pF	0	-	3.4	MHz
t <sub>SU</sub> START	Set-up time for a (repeated) START condition	Load capacitance < 100 pF	160	-	-	ns

Table 258. I<sup>2</sup>C timing specification: High-Speed Mode...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>HD</sub> START	hold time of a (repeated) START condition	Load capacitance < 100 pF	160	-	-	ns
t <sub>LOW</sub>	Timing of the LOW period of the SCL clock	Load capacitance < 100 pF	160	-	-	ns
t <sub>HIGH</sub>	Timing of the HIGH period of the SCL clock	Load capacitance < 100 pF	60	-	-	ns
t <sub>SU</sub> DATA	DATA set-up time	Load capacitance < 100 pF	10	-	-	ns
t <sub>HD</sub> DATA	DATA hold-up time	Load capacitance < 100 pF	0	-	-	ns
tr <sub>DA</sub>	Rise time of SDA	Load capacitance < 100 pF	10	-	80	ns
tf <sub>DA</sub>	Fall time of SDA	Load capacitance < 100 pF	10	-	80	ns

Table 259. I<sup>2</sup>C timing specification: Fast + High-Speed-Mode

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f <sub>SCL</sub>	SCL clock frequency	Load capacitance < 100 pF	0	-	1	MHz
t <sub>SU</sub> START	Set-up time for a (repeated) START condition	Load capacitance < 100 pF	260	-	-	ns
t <sub>HD</sub> START	hold time of a (repeated) START condition	Load capacitance < 100 pF	260	-	-	ns
t <sub>LOW</sub>	Timing of the LOW period of the SCL clock	Load capacitance < 100 pF	500	-	-	ns
t <sub>HIGH</sub>	Timing of the HIGH period of the SCL clock	Load capacitance < 100 pF	260	-	-	ns
t <sub>SU</sub> DATA	DATA set-up time	Load capacitance < 100 pF	50	-	-	ns

Table 259. I<sup>2</sup>C timing specification: Fast + High-Speed-Mode...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>HD</sub> DATA	DATA hold-up time	Load capacitance < 100 pF	0	-	-	ns
t <sub>rDA</sub>	Rise time of SDA	Load capacitance < 100 pF	-	-	120	ns
t <sub>fDA</sub>	Fall time of SDA	Load capacitance < 100 pF	-	-	120	ns



11.3 Timing characteristics of host interface commands

TIMING OF VEN TRIGGERED BOOT

Table 260. Timing of VEN and command processing (Single Host – HIF1 I2C)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>BOOT</sub>	Boot time, chip initialization	VEN transition from L to H starts the chip initialization. During this time I2C commands/packets are not accepted and processed.	-	-	2.0	ms
t <sub>FW_DOWNLOAD_CMD</sub>	Time after VEN transition from L to H, at which firmware download commands can be processed	After boot System waits for incoming packets for secure firmware update, FW download commands are accepted	2.0	-	4950.0	ms
t <sub>CMD_MODE_SWITCH</sub>	Duration to switch from secure firmware download command mode to NCI handling command mode	Command are not accepted	3.0	-	103.0	ms
t <sub>NCI_CMD</sub>	Time after VEN transition L to H at which NCI commands can be processed	NCI commands are accepted	5105.0	-	-	ms

Table 261. Timing of VEN and command processing (Dual Host – HIF1 SPI)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>BOOT</sub>	Boot time, chip initialization	VEN transition from L to H starts the chip initialization. During this time SPI commands/packets are not accepted and processed	-	-	2.0	ms
t <sub>FW_DOWNLOAD_CMD</sub>	Time after VEN transition from L to H, at which firmware download commands can be processed	After boot System waits for incoming packets for secure firmware update, FW download commands are accepted	2.0	-	4950.0	ms
t <sub>CMD_MODE_SWITCH</sub>	Duration to switch from secure firmware download command mode to NCI handling command mode	commands are not accepted	3.0	-	103.0	ms
t <sub>NCI_CMD</sub>	Time after VEN transition L to H at which NCI commands can be processed	NCI commands are accepted	5105.0	-	-	ms

Table 262. Timing of VEN and command processing in NFC Forum mode (Dual Host – HIF2 I2C)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>BOOT</sub>	Boot time, chip initialization	VEN transition from L to H starts the chip initialization. During this time I2C commands/packets are not accepted and processed	-	-	5.0	ms
t <sub>FW_DOWNLOAD_CMD</sub>	Time after VEN transition from L to H, at which firmware download commands can be processed	Firmware download not supported in dual-host configuration on the HIF2	0	-	0	ms
t <sub>NCI_CMD</sub>	Time after VEN transition L to H at which NCI commands can be processed	NCI commands are accepted	5.0	-	-	ms

TIMING OF CORE RESET COMMAND TRIGGERED BY COLD BOOT

The core reset command can be used to shorten the time before the NCI commands are accepted.

Table 263. Timing of CORE RESET command after COLD RESET command (Single Host – HIF1 I2C)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>NCI_CORE_RESET_IRQ_H</sub>	duration from NCI core reset in firmware download mode until NCI command processing is entered. Indicated by IRQ transition to H	NCI core reset command sent min 2.0 ms after VEN transition from L to H and max 5052.0 ms after VEN transition from L to H and	-	-	6.4	ms

Table 264. Timing of CORE RESET command after COLD RESET command (Dual Host – HIF1 SPI)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>NCI_CORE_RESET_IRQ_H</sub>	duration from NCI core reset in firmware download mode until NCI command processing is entered, indicated by IRQ transition to H	NCI core reset command sent min 2.0 ms after VEN transition from L to H and max 5052.0 ms after VEN transition from L to H and	-	-	6.4	ms

TIMING OF NCI CORE RESET COMMAND TRIGGERED BY WARM BOOT

Table 265. Timing of NCI CORE RESET command to NCI command mode (Single Host – HIF1 I2C)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>NCI_CORE_RESET_IRQ_H</sub>	duration from NCI core reset in NCI mode until NCI command processing is entered	NCI core reset command sent in NCI command mode	-	-	4.1	ms

Table 266. Timing of NCI CORE RESET to NCI command mode (Dual Host – HIF1 SPI)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>NCI_CORE_RESET_IRQ_H</sub>	duration from NCI core reset in NCI mode until NCI command processing is entered	NCI core reset command sent in NCI command mode on HIF1	-	-	4.1	ms

Table 267. Timing NCI CORE RESET to NCI command mode (Dual Host – HIF2 I2C )

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>NCI_CORE_RESET_IRQ_H</sub>	duration from NCI core reset in NCI mode until NCI command processing is entered	NCI core reset command sent in NCI command mode on HIF2	-	-	4.1	ms

TIMING OF VEN TRIGGERED BOOT TO SECURE FIRMWARE DOWNLOAD MODE

Table 268. Timing of VEN triggered boot to secure firmware download mode (single Host – HIF1 I2C )

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>DWL_COMMAND_PROCESSING</sub>	duration from DWL GET SESSION command until download command processing is entered		-	0.7	1.0	ms

Table 269. Timing of VEN triggered boot to secure firmware download mode (single Host – HIF1 SPI )

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t <sub>DWL_COMMAND_PROCESSING</sub>	duration from DWL GET SESSION command until download command processing is entered		-	0.7	1.0	ms

## 11.4 Clock input

Table 270. Crystal requirements for ISO/IEC14443 compliant operation

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$f_{\text{xtal}}$	crystal frequency	ISO/IEC compliance	-	27.12	-	MHz
$\Delta f_{\text{xtal}}$	crystal frequency accuracy	for full RF operating range	-40	-	+40	ppm
ESR	equivalent series resistance	-	10	30	100	$\Omega$
$C_L$	load capacitance	-	6	8	10	pF
$t_{\text{startup}}$	crystal startup time	-	-	-	1	ms
$P_{\text{xtal}}$	crystal power dissipation	-	-	-	100	$\mu\text{W}$

Table 271. Frequency requirements for a direct clock input (no crystal)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$f_{\text{clk}}$	clock frequency	ISO/IEC compliance	-	24	-	MHz
			-	32	-	
			-	48	-	
$\Delta f_{\text{clk}}$	clock frequency accuracy	for full RF operating range	-40	-	+40	ppm
$\Phi_n$	phase noise	input phase noise floor at 100 kHz offset	-	- 150	-145	dBc/Hz
$\Phi_n$	phase noise	input phase noise floor at 1 MHz offset	-	- 152	-149	dBc/Hz
$V_i$	Input voltage boundary	sinus signal	0	-	1.8	V
$V_{i(p-p)}$	peak-to-peak Input voltage	sinus signal	0.4	-	1.8	V
$V_{i(\text{clk})}$	clock input voltage	square signal	0	-	1.8 +/-10 %	V

11.5 DPC characteristics

Table 272. Dynamic power control characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
	Minimum hysteresis configured in EEPROM DPC_HYSTERESIS (address 079h)	depends on application target current	$\text{ApplicationTargetCurrent} \times 0.0609 + 2 \text{ mA}$	-	-	mA
	Max target current configured in EEPROM DPC_TARGET_CURRENT (077h)	hysteresis as configured in DPC_HYSTERESIS (address 079h)		-	350-Hysteresis	mA

11.6 EEPROM characteristics

Table 273. EEPROM characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$N_{\text{endu(W)}}$	write endurance	at ambient temperature $T_a = +25 \text{ }^{\circ}\text{C}$	100	-	-	Kcycle
$t_{\text{ret}}$	retention time	at ambient temperature $T_a = +25 \text{ }^{\circ}\text{C}$	25	-	-	year

## 11.7 Thermal characteristics

Table 274. Operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T <sub>amb</sub>	ambient operating temperature	in still air with exposed pins soldered on a 4 layer JEDEC PCB, transmitter output current up to 350 mA	-40	25	85	°C
		in still air with exposed pins soldered on a 4 layer JEDEC PCB, TX current = 120 mA @ VDDPA=3.6 V	-40	25	105	°C

Table 275. Thermal characteristics VFBGA64 package

Symbol	Parameter	Conditions	Typ	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air with exposed pad soldered on a 4 layer JEDEC PCB, package VFBGA64	53	K/W
R <sub>th(j-c)</sub>	thermal resistance from junction to case	-	22	K/W

Table 276. Junction temperature

Symbol	Parameter	Conditions	Min	Max	Unit
T <sub>j_max</sub>	maximum junction temperature	-	-	125	°C

Table 277. Thermal shutdown temperature

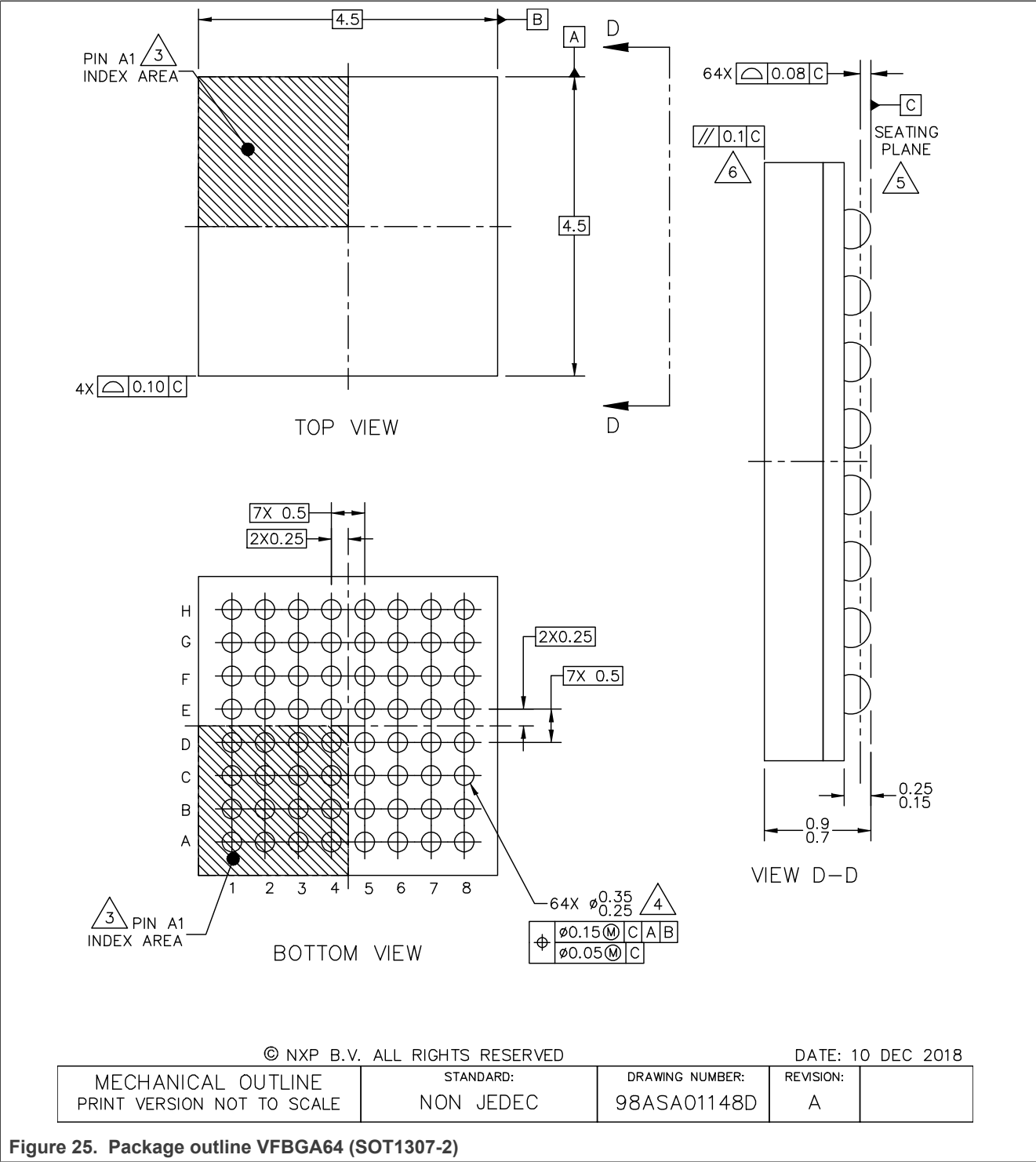
Symbol	Parameter	Conditions	Typ	Unit
T <sub>shutdown</sub>	shutdown of chip due to high temperature detected by temp sensor	-	125	°C



12 Package outline

12.1 VFBGA64 package

Table 278. Package outline VFBGA64 (SOT1307-2)



NOTES:

- 1. ALL DIMENSIONS IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M–1994.
- 3. PIN A1 FEATURE SHAPE, SIZE AND LOCATION MAY VARY.
- 4. MAXIMUM SOLDER BALL DIAMETER MEASURED PARALLEL TO DATUM C.
- 5. DATUM C, THE SEATING PLANE, IS DETERMINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 6. PARALLELISM MEASUREMENT SHALL EXCLUDE ANY EFFECT OF MARK ON TOP SURFACE OF PACKAGE.

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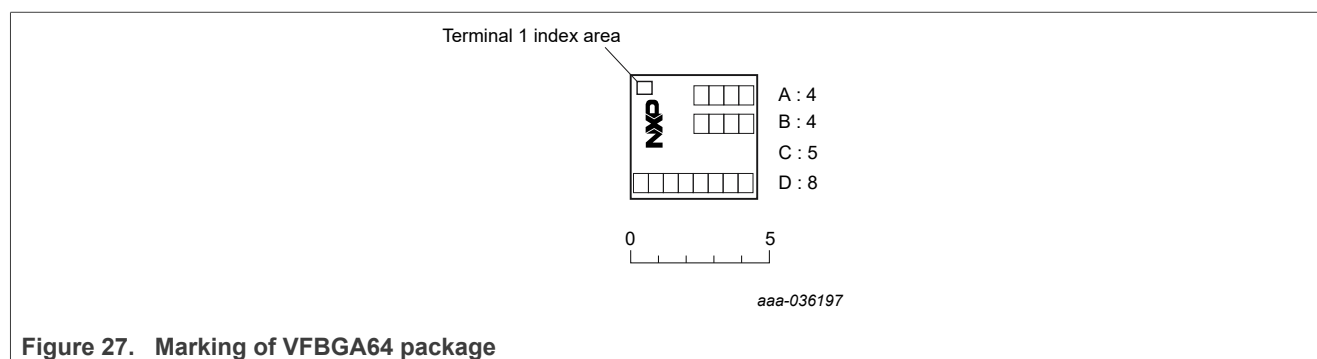
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Figure 26. Package outline note VFBGA64 (SOT1307-2)

## 13 Package marking

### 13.1 Package marking drawing VFBGA64



Line A: 4 characters; **"7220"**

Line B: 4 characters, contains the firmware version: C100 or C101

Line C: 5 characters; contains the diffusion batch identifier (DB ID), a blank " " and the assembly sequence identifier (AS ID)

Line D: 8 characters; stDYYWW(X) - contains information assembly center, date code, and maturity level ("X" = engineering samples, " " = released product)

## 14 Handling information

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

## 15 Abbreviations

Table 279. Abbreviations

Acronym	Description
AA	audio accelerator
ADC	analog-to-digital converter
AGC	automatic gain control
AHB	advanced high-performance bus
AHB-Lite	advanced high-performance bus (single-controller implementation)
AHB bus	advanced high-performance bus
APB	advanced peripheral bus
API	application programming interface
ARC	adaptive receiver control
Arm	Advanced RISC Machine
AWC	adaptive waveshape control
BBA	baseband amplifier
BOD	brownout detection
CITO	controller input target output (previously master input slave output)
CLIF	contactless interface
COTI	controller output target input (previously master output slave input)
CPU	central processing unit
CRC	cyclic redundancy check
CTR	current transfer ratio
CTS	clear to send
DAC	digital-to-analog converter
DC-DC	switch-mode voltage regulator which uses an inductor to store and transfer energy to the output, used for a power supply voltage conversion. PN7220 integrates a step-up/boost converter
DDR	double data rate
DMA	direct memory access
DPC	dynamic power control
ECC	elliptic curve cryptography
EEPROM	electrically erasable programmable read-only memory
EMC	electromagnetic compatibility
EMD	electromagnetic disturbance
ETB	Embedded Trace Buffer
ETM	Embedded Trace Macro
EOF	end-of-frame
Fm+	Fast-mode Plus
FSM	finite state machine

Table 279. Abbreviations...continued

Acronym	Description
GND	Ground
GPIO	general-purpose input output
HID	human interface device
HPD	hard power down
HW	hardware
IC	Integrated Circuit
IIR	infinite impulse response
IrDA	Infrared Data Association
IAP	In-Application Programming
ISP	In-System Programming
I/O	input/output
I/Q	in-phase/quadrature-phase
JEDEC	Joint Electron Device Engineering Council
LDO	low dropout regulator
LPCD	low-power card detection
LPUART	Low-Power Universal Asynchronous Receiver / Transmitter
LSB	least significant bit
LSByte	least significant byte
MISO	SPI interface controller in target out
MSL	moisture sensitivity level
MOSI	SPI interface controller out target In
NFC	near-field communication
NRZ	non-return-to-zero
NSS	SPI interface active-low target-select signal
NTS	not target select (previously not slave select)
NVIC	nested vectored interrupt controller
OS	operating system
OTP	one time programmable
PCB	printed-circuit board
PC	personal computer
PCD	power card detection
PICC	proximity inductive coupling card
PLL	phase-locked loop
PMU	power management unit
PWM	pulse width modulation
RAM	random-access memory

Table 279. Abbreviations...continued

Acronym	Description
RF	radio frequency
RNG	random number generator
ROM	read-only memory
RSA	Rivest, Shamir, and Adleman public key cryptosystem
RSSI	receiver signal strength indicator
RTOS	real-time operating system
RTS	request to send
SCK	SPI interface serial clock
SCL	I <sup>2</sup> C interface serial clock
SDA	serial data
SMPS	switch mode power supply
SPI	serial peripheral interface
SRAM	static random-access memory
SWD	serial wire debug
TFT	display technology: thin-film transistor-display
TX	transmit
UART	universal asynchronous receiver transmitter
UID	Unique identifier of a card, used during anti-collision sequence to select one out of multiple cards.
ULPCD	ultra low-power card detection
USB	universal serial bus
VREF	voltage reference

16 Revision history

Table 280. Revision history

Document ID	Release date	Description
PN7220 v.3.3	16 April 2024	<ul style="list-style-type: none"><li>• <a href="#">Section 5 "Firmware versions"</a>: added.</li><li>• <a href="#">Section 9.5 "System power states"</a>: updated.</li><li>• <a href="#">Section 9.12 "Adaptive receiver control (ARC)"</a>: updated.</li><li>• <a href="#">Section 9.18.2.1.12 "XTAL_DELAY (06B8h)"</a>: added.</li><li>• <a href="#">Section 9.18.2.1.13 "CLK_INPUT_FREQ (0x0011)"</a>: updated.</li><li>• <a href="#">Table 255 "Power supply connection timing"</a>: updated t<sub>boot</sub> max value.</li><li>• <a href="#">Section 11.3 "Timing characteristics of host interface commands"</a>: added.</li><li>• <a href="#">Section 13.1 "Package marking drawing VFBGA64"</a>: updated.</li></ul>
PN7220 v.3.2	24 November 2023	<ul style="list-style-type: none"><li>• <a href="#">Section 6 "Ordering information"</a>: updated</li><li>• <a href="#">Section 8.1 "Pin description VFBGA64"</a>: updated.</li></ul>
PN7220 v.3.1	20 September 2023	<ul style="list-style-type: none"><li>• <a href="#">Section 8.1 "Pin description VFBGA64"</a>: Pin description for E7 and C7 corrected</li></ul>
PN7220 v.3.0	5 July 2023	<ul style="list-style-type: none"><li>• Initial version</li></ul>



Legal information

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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## Tables

Tab. 1.	Quick reference data .....	6	Tab. 34.	TXLDO_VOUT_CURR (0x56) register bit description .....	66
Tab. 2.	Ordering information .....	8	Tab. 35.	CLIF_RXM_FREQ (0x59) register bit description .....	66
Tab. 3.	Pin description VFBGA64 .....	12	Tab. 36.	INTERPOLATED_RSSI_REG (0x5C) register bit description .....	67
Tab. 4.	PN7220 power states .....	21	Tab. 37.	TX_NOV_CALIBRATE_AND_STORE_VAL_REG (0x5D) register bit description .....	67
Tab. 5.	Supply voltage range configuration .....	29	Tab. 38.	CLIF_SS_TX1_RTRANS0 (0x80) register bit description .....	67
Tab. 6.	Supply voltage range .....	30	Tab. 39.	CLIF_SS_TX1_RTRANS1 (0x81) register bit description .....	67
Tab. 7.	DPC_LOOKUP_TABLE element, defining the configuration for one dedicated VDDPA voltage .....	36	Tab. 40.	CLIF_SS_TX1_RTRANS2 (0x82) register bit description .....	67
Tab. 8.	ARC_VDDPA EEPROM configuration bit description .....	39	Tab. 41.	CLIF_SS_TX1_RTRANS3 (0x83) register bit description .....	68
Tab. 9.	ARC_RM_A106 EEPROM configuration bit description .....	40	Tab. 42.	CLIF_SS_TX2_RTRANS0 (0x84) register bit description .....	68
Tab. 10.	Low-Power Card Detection: relevant EEPROM configuration .....	43	Tab. 43.	CLIF_SS_TX2_RTRANS1 (0x85) register bit description .....	68
Tab. 11.	Low-Power Card Detection: relevant EEPROM configuration .....	43	Tab. 44.	CLIF_SS_TX2_RTRANS2 (0x86) register bit description .....	68
Tab. 12.	Antenna register configuration .....	45	Tab. 45.	CLIF_SS_TX2_RTRANS3 (0x87) register bit description .....	69
Tab. 13.	Antenna EEPROM configuration .....	46	Tab. 46.	CLIF_SS_TX1_FTRANS0 (0x88) register bit description .....	69
Tab. 14.	DEBUG SIGNALS .....	47	Tab. 47.	CLIF_SS_TX1_FTRANS1 (0x89) register bit description .....	69
Tab. 15.	TRIGGER SIGNALS .....	48	Tab. 48.	CLIF_SS_TX1_FTRANS2 (0x8A) register bit description .....	69
Tab. 16.	List of CLIF registers .....	49	Tab. 49.	CLIF_SS_TX1_FTRANS3 (0x8B) register bit description .....	70
Tab. 17.	SYSTEM_CONFIG (0x00) register bit description .....	51	Tab. 50.	CLIF_SS_TX2_FTRANS0 (0x8C) register bit description .....	70
Tab. 18.	CLIF_RX_STATUS (0x05) register bit description .....	52	Tab. 51.	CLIF_SS_TX2_FTRANS1 (0x8D) register bit description .....	70
Tab. 19.	CLIF_RX_STATUS_ERROR (0x06) register bit description .....	53	Tab. 52.	CLIF_SS_TX2_FTRANS2 (0x8E) register bit description .....	70
Tab. 20.	CLIF_STATUS (0x07) register bit description .....	55	Tab. 53.	CLIF_SS_TX2_FTRANS3 (0x8F) register bit description .....	71
Tab. 21.	CLIF_CRC_TX_CONFIG (0x12) register bit description .....	58	Tab. 54.	List of EEPROM configuration parameters for power, TXLDO, XTAL and Clocks .....	72
Tab. 22.	CLIF_SS_TX1_RMCFG (0x16) register bit description .....	58	Tab. 55.	DCDC_PWR_CONFIG (0x0000) .....	73
Tab. 23.	CLIF_SIGPRO_RM_TECH (0x22) register bit description .....	59	Tab. 56.	DCDC_CONFIG (0x0001) .....	73
Tab. 24.	CLIF_SIGPRO_IIR_CONFIG0 (0x2A) register bit description .....	59	Tab. 57.	TXLDO_CONFIG (0x0002) .....	74
Tab. 25.	CLIF_DGRM_BBA (0x2D) register bit description .....	60	Tab. 58.	TXLDO_VDDPA_CONFIG (0x0006) .....	74
Tab. 26.	CLIF_DGRM_DCO (0x2E) register bit description .....	61	Tab. 59.	TXLDO_VDDPA_MAX_RDR_NFC_FORUM (0x0007) .....	74
Tab. 27.	CLIF_DGRM_RSSI (0x30) register bit description .....	62	Tab. 60.	TXLDO_VDDPA_MAX_RDR_EMVCo (0x06A6) .....	74
Tab. 28.	CLIF_CRC_RX_CONFIG (0x31) register bit description .....	63	Tab. 61.	TXLDO_VDDPA_MAX_CARD (0x0008) .....	74
Tab. 29.	CLIF_RX_WAIT (0x32) register bit description .....	64	Tab. 62.	BOOST_DEFAULT_VOLTAGE (0x0009) .....	75
Tab. 30.	CLIF_SS_TX1_CMCFG (0x3B) register bit description .....	64	Tab. 63.	XTAL_CONFIG (0x000F) .....	75
Tab. 31.	CLIF_TIMER1_CONFIG (0x3F) register bit description .....	64	Tab. 64.	XTAL_TIMEOUT (0x0010) .....	75
Tab. 32.	CLIF_TIMER1_RELOAD (0x40) register bit description .....	66	Tab. 65.	XTAL_DELAY (address 06B8h) EEPROM configuration bit description .....	75
Tab. 33.	TXLDO_VDDPA_CONFIG (0x54) register bit description .....	66			

Tab. 66.	CLK_INPUT_FREQ (0x0011) .....	76	Tab. 121.	RESIDUAL_AMPL_LEVEL_V10_212 (0x0058) .....	103
Tab. 67.	XTAL_CHECK_DELAY (0x0012) .....	77	Tab. 122.	EDGE_TYPE_V10_212 (0x0059) .....	104
Tab. 68.	VDDPA_DISCHARGE (0x050D) .....	77	Tab. 123.	EDGE_STYLE_V10_212 (0x005A) .....	105
Tab. 69.	RESIDUAL_AMPL_LEVEL_A106 (0x0014) ....	77	Tab. 124.	EDGE_LENGTH_V10_212 (0x005B) .....	105
Tab. 70.	EDGE_TYPE_A106 (0x0015) .....	78	Tab. 125.	RESIDUAL_AMPL_LEVEL_V100_26 (0x003C) .....	105
Tab. 71.	EDGE_STYLE_A106 (0x0016) .....	79	Tab. 126.	EDGE_TYPE_V100_26 (0x003D) .....	106
Tab. 72.	EDGE_LENGTH_A106 (0x0017) .....	79	Tab. 127.	EDGE_STYLE_V100_26 (0x003E) .....	107
Tab. 73.	RESIDUAL_AMPL_LEVEL_A212 (0x0018) ....	79	Tab. 128.	EDGE_LENGTH_V100_26 (0x003F) .....	107
Tab. 74.	EDGE_TYPE_A212 (0x0019) .....	80	Tab. 129.	RESIDUAL_AMPL_LEVEL_V100_53 (0x0040) .....	107
Tab. 75.	EDGE_STYLE_A212 (0x001A) .....	81	Tab. 130.	EDGE_TYPE_V100_53 (0x0041) .....	108
Tab. 76.	EDGE_LENGTH_A212 (0x001B) .....	81	Tab. 131.	EDGE_STYLE_V100_53 (0x0042) .....	109
Tab. 77.	RESIDUAL_AMPL_LEVEL_A424 (0x001C) ....	81	Tab. 132.	EDGE_LENGTH_V100_53 (0x0043) .....	109
Tab. 78.	EDGE_TYPE_A424 (0x001D) .....	82	Tab. 133.	RESIDUAL_AMPL_LEVEL_V100_106 (0x0044) .....	109
Tab. 79.	EDGE_STYLE_A424 (0x001E) .....	83	Tab. 134.	EDGE_TYPE_V100_106 (0x0045) .....	110
Tab. 80.	EDGE_LENGTH_A424 (0x001F) .....	83	Tab. 135.	EDGE_STYLE_V100_106 (0x0046) .....	111
Tab. 81.	RESIDUAL_AMPL_LEVEL_A848 (0x0020) ....	83	Tab. 136.	EDGE_LENGTH_V100_106 (0x0047) .....	111
Tab. 82.	EDGE_TYPE_A848 (0x0021) .....	84	Tab. 137.	RESIDUAL_AMPL_LEVEL_V100_212 (0x0048) .....	111
Tab. 83.	EDGE_STYLE_A848 (0x0022) .....	85	Tab. 138.	EDGE_TYPE_V100_212 (0x0049) .....	112
Tab. 84.	EDGE_LENGTH_A848 (0x0023) .....	85	Tab. 139.	EDGE_STYLE_V100_212 (0x004A) .....	113
Tab. 85.	RESIDUAL_AMPL_LEVEL_B106 (0x0024) ....	85	Tab. 140.	EDGE_LENGTH_V100_212 (0x004B) .....	113
Tab. 86.	EDGE_TYPE_B106 (0x0025) .....	86	Tab. 141.	DPC_CONFIG (0x0068) .....	114
Tab. 87.	EDGE_STYLE_B106 (0x0026) .....	87	Tab. 142.	DPC_TARGET_CURRENT (0x0069) .....	114
Tab. 88.	EDGE_LENGTH_B106 (0x0027) .....	87	Tab. 143.	DPC_HYSTERESIS_LOADING (0x006B) ....	115
Tab. 89.	RESIDUAL_AMPL_LEVEL_B212 (0x0028) ....	87	Tab. 144.	DPC_HYSTERESIS_UNLOADING (0x006E) .....	115
Tab. 90.	EDGE_TYPE_B212 (0x0029) .....	88	Tab. 145.	DPC_TXLDOVDDPALow (0x006F) .....	115
Tab. 91.	EDGE_STYLE_B212 (0x002A) .....	89	Tab. 146.	DPC_TXGSN (0x0070) .....	115
Tab. 92.	EDGE_LENGTH_B212 (0x002B) .....	89	Tab. 147.	DPC_RDON_CONTROL (0x0071) .....	115
Tab. 93.	RESIDUAL_AMPL_LEVEL_B424 (0x002C) ....	89	Tab. 148.	DPC_InitialRDOOn_RFOOn (0x0072) .....	116
Tab. 94.	EDGE_TYPE_B424 (0x002D) .....	90	Tab. 149.	DPC_TXLDO_MAX_DROPOUT (0x0073) ....	116
Tab. 95.	EDGE_STYLE_B424 (0x002E) .....	91	Tab. 150.	DPC_GUARD_TIME (0x0079) .....	116
Tab. 96.	EDGE_LENGTH_B424 (0x002F) .....	91	Tab. 151.	DPC_ENABLE_DURING_FDT (0x007A) ....	116
Tab. 97.	RESIDUAL_AMPL_LEVEL_B848 (0x0030) ....	91	Tab. 152.	DPC_GUARD_TIME_AFTER_RX (0x007B) .....	116
Tab. 98.	EDGE_TYPE_B848 (0x0031) .....	92	Tab. 153.	DPC lookup table entries .....	117
Tab. 99.	EDGE_STYLE_B848 (0x0032) .....	93	Tab. 154.	DPC_EMVCo_CONFIG (0x0077) .....	119
Tab. 100.	EDGE_LENGTH_B848 (0x0033) .....	93	Tab. 155.	DPC_EMVCo_TARGET_CURRENT (0x0132) .....	119
Tab. 101.	RESIDUAL_AMPL_LEVEL_F212 (0x0034) ....	93	Tab. 156.	DPC_EMVCo_HYSTERESIS_LOADING (0x006B) .....	120
Tab. 102.	EDGE_TYPE_F212 (0x0035) .....	94	Tab. 157.	DPC_EMVCo_HYSTERESIS_ UNLOADING (0x006E) .....	120
Tab. 103.	EDGE_STYLE_F212 (0x0036) .....	95	Tab. 158.	DPC_EMVCo_TXLDOVDDPALow (0x006F) .....	120
Tab. 104.	EDGE_LENGTH_F212 (0x0037) .....	95	Tab. 159.	DPC_EMVCo_TXGSN (0x0696) .....	120
Tab. 105.	RESIDUAL_AMPL_LEVEL_F424 (0x0038) ....	95	Tab. 160.	DPC_EMVCo_RDON_CONTROL (0x0697) .	120
Tab. 106.	EDGE_TYPE_F424 (0x0039) .....	96	Tab. 161.	DPC_EMVCo_InitialRDOOn_RFOOn (0x0698) ..	121
Tab. 107.	EDGE_STYLE_F424 (0x003A) .....	97	Tab. 162.	DPC_EMVCo_TXLDO_MAX_DROPOUT (0x0699) .....	121
Tab. 108.	EDGE_LENGTH_F424 (0x003B) .....	97	Tab. 163.	DPC_EMVCo_GUARD_TIME (0x09F) .....	121
Tab. 109.	RESIDUAL_AMPL_LEVEL_V10_26 (0x004C) .....	97	Tab. 164.	DPC_EMVCo_ENABLE_DURING_FDT (0x06A0) .....	121
Tab. 110.	EDGE_TYPE_V10_26 (0x004D) .....	98	Tab. 165.	DPC_EMVCo_GUARD_TIME_AFTER_RX (0x06A1) .....	121
Tab. 111.	EDGE_STYLE_V10_26 (0x004E) .....	99			
Tab. 112.	EDGE_LENGTH_V10_26 (0x004F) .....	99			
Tab. 113.	RESIDUAL_AMPL_LEVEL_V10_53 (0x0050) .....	99			
Tab. 114.	EDGE_TYPE_V10_53 (0x0051) .....	100			
Tab. 115.	EDGE_STYLE_V10_53 (0x0052) .....	101			
Tab. 116.	EDGE_LENGTH_V10_53 (0x0053) .....	101			
Tab. 117.	RESIDUAL_AMPL_LEVEL_V10_106 (0x0054) .....	101			
Tab. 118.	EDGE_TYPE_V10_106 (0x0055) .....	102			
Tab. 119.	EDGE_STYLE_V10_106 (0x0056) .....	103			
Tab. 120.	EDGE_LENGTH_V10_106 (0x0057) .....	103			

Tab. 166.	DPC EMVCo lookup table entries .....	122	Tab. 214.	EDGE_LENGTH_ACTIVE_A106 (0X0511) ...	158
Tab. 167.	ARC_SETTINGS_ARCCONFIG (0x0129) ....	124	Tab. 215.	RESIDUAL_AMPL_LEVEL_ACTIVE_F212 (0X0512) .....	158
Tab. 168.	ARC_SETTINGS_ARCVDDPA (0x012B) .....	124	Tab. 216.	EDGE_TYPE_ACTIVE_F212 (0X0513) .....	159
Tab. 169.	ARC_SETTINGS_WRMARCA_106 (0x0130) .....	125	Tab. 217.	EDGE_STYLE_ACTIVE_F212 (0X0514) .....	160
Tab. 170.	ARC_SETTINGS_TABLE for other technologies .....	127	Tab. 218.	EDGE_LENGTH_ACTIVE_F212 (0X0515) ...	160
Tab. 171.	ARC_RM_A106_FDT_NFC_FORUM (0x051B) .....	130	Tab. 219.	RESIDUAL_AMPL_LEVEL_ACTIVE_F424 (0X0516) .....	160
Tab. 172.	ARC_RM_A106_FDT_EMVCo (0x06A7) .....	131	Tab. 220.	List of Settings related TX_SHAPING configuration. ....	161
Tab. 173.	List of RSSI settings for card emulation only .....	132	Tab. 221.	TX_SHAPING_CONIFG (0x058C) .....	161
Tab. 174.	RSSI_TIMER (0x020C) .....	132	Tab. 222.	TX_INV_RM (0x058D) .....	162
Tab. 175.	RSSI_TIMER_FIRST_PERIOD (0x020E) ....	132	Tab. 223.	TX_CLK_MODE_1 (0x058E) .....	162
Tab. 176.	RSSI_CTRL_00_AB (0x0210) .....	132	Tab. 224.	TX_CLK_MODE_2 (0x058F) .....	162
Tab. 177.	RSSI_NB_ENTRIES_AB (0x0211) .....	133	Tab. 225.	GSN_MOD_RM (0x0590) .....	163
Tab. 178.	RSSI_THRESHOLD_PHASE_TABLE for Type-A and Type-B .....	133	Tab. 226.	GSN_CW_RM (0x0591) .....	163
Tab. 179.	RSSI_CTRL_00_F (0x0272) .....	134	Tab. 227.	GSP_RM (0x0592) .....	163
Tab. 180.	RSSI_NB_ENTRIES_F (0x0273) .....	135	Tab. 228.	TX_FRCZERO_THR (0x0593) .....	163
Tab. 181.	RSSI_THRESHOLD_PHASE_TABLE for Type-F .....	135	Tab. 229.	SIGNAL_SCALING_CONFIG (0x0594) .....	163
Tab. 182.	TX_PARAM_ENTRY_00_ID (0x02D4) .....	137	Tab. 230.	TX_PH_SHIFT_DIV10 (0x0595) .....	164
Tab. 183.	List of Autocoll configuration settings .....	144	Tab. 231.	TX_PH_SHIFT_MOD10 (0x0596) .....	164
Tab. 184.	RF_DEBOUNCE_TIMEOUT (0x03C4) .....	144	Tab. 232.	List of settings related to RFLD and NFCLD .	164
Tab. 185.	SENSE_RES (0x03C5) .....	144	Tab. 233.	NFCLD_RFLD_VALID (0x05C5) .....	164
Tab. 186.	NFC_ID1 (0x03C7) .....	145	Tab. 234.	List of settings for Temperature related cut- offs and notifications .....	165
Tab. 187.	SEL_RES (0x03CA) .....	145	Tab. 235.	TEMP_WARNING (0x0648) .....	165
Tab. 188.	FELICA_POLLRES (0x03CB) .....	145	Tab. 236.	DigitalTBSignalIndex (address 06A3h) EEPROM configuration bit description .....	166
Tab. 189.	RANDOM_UID_ENABLE (0x03DD) .....	146	Tab. 237.	DigitalTBSignalBit (address 06A4h) EEPROM configuration bit description .....	166
Tab. 190.	List of LPCD related configuration settings ....	146	Tab. 238.	AnalogTBSignalIndex (address 06A5h) EEPROM configuration bit description .....	166
Tab. 191.	LPCD_AVG_SAMPLES (0x03DE) .....	147	Tab. 239.	CT_PROFILE_CONFIG (0x06B1) .....	167
Tab. 192.	LPCD_RSSI_TARGET (0x03E0) .....	147	Tab. 240.	CT_CHIPSELECT_CONFIG (0x06B3) .....	167
Tab. 193.	LPCD_RSSI_HYST (0x03E2) .....	147	Tab. 241.	Limiting values .....	168
Tab. 194.	LPCD_CONFIG (0x03E3) .....	148	Tab. 242.	Supply voltage .....	169
Tab. 195.	LPCD_THRESHOLD (0x03E6) .....	148	Tab. 243.	Current consumption in active mode .....	169
Tab. 196.	LPCD_WAIT_RX_SETTLE (0x03F7) .....	149	Tab. 244.	Current consumption during power-saving modes .....	170
Tab. 197.	LPCD_VDDPA (0x03FB) .....	149	Tab. 245.	Overcurrent detection function .....	170
Tab. 198.	WAIT_RX_SETTLE (0x03FC) .....	149	Tab. 246.	VEN pin .....	170
Tab. 199.	CORRECTION_ENTRY_TABLE .....	150	Tab. 247.	CLK1, CLK2 pins .....	171
Tab. 200.	TX_SHAPING_RTRANS_FTRANS_1 (0x0481) .....	152	Tab. 248.	IRQ1 pin .....	171
Tab. 201.	TX_SHAPING_RTRANS_FTRANS_2 (0x4A1) .....	153	Tab. 249.	SPI SCK / I2C1_SCL, SPI NSS / I2C_Adr Bit 0 , SPI COTI / I2C_Adr Bit 1 pins .....	171
Tab. 202.	TX_SHAPING_RTRANS_FTRANS_3 (0x04C1) .....	153	Tab. 250.	I2C1_SDA pin .....	172
Tab. 203.	TX_SHAPING_RTRANS_FTRANS_1 (0x04E1) .....	154	Tab. 251.	Mode selection, HOST_IF_SEL0, HOST_ IF_SEL1, I2C2_IRQ, WAKEUP pins .....	172
Tab. 204.	List of NOV configuration parameters .....	154	Tab. 252.	RXp, RXn pins .....	172
Tab. 205.	NOV_CFG_CAL (0x0501) .....	155	Tab. 253.	TX1, TX2 pins .....	173
Tab. 206.	NOV_CAL_VAL1 (0x0502) .....	155	Tab. 254.	AUX1, AUX2, AUX3 pins (Debug output) .....	173
Tab. 207.	NOV_CAL_VAL2 (0x0503) .....	155	Tab. 255.	Power supply connection timing .....	173
Tab. 208.	NOV_CAL_THRESHOLD (0x0504) .....	155	Tab. 256.	Pulse length .....	174
Tab. 209.	NOV_CAL_OFFSET1 (0x0505) .....	156	Tab. 257.	I2C timing specification: Standard, Fast Mode .....	174
Tab. 210.	NOV_CAL_OFFSET2 (0x0509) .....	156	Tab. 258.	I2C timing specification: High-Speed Mode ...	174
Tab. 211.	RESIDUAL_AMPL_LEVEL_ACTIVE_A106 (0X050E) .....	156	Tab. 259.	I2C timing specification: Fast + High- Speed-Mode .....	175
Tab. 212.	EDGE_TYPE_ACTIVE_A106 (0X050F) .....	157			
Tab. 213.	EDGE_STYLE_ACTIVE_A106 (0X0510) .....	158			

Tab. 260. Timing of VEN and command processing (Single Host – HIF1 I2C) .....	177	Tab. 268. Timing of VEN triggered boot to secure firmware download mode (single Host – HIF1 I2C ) .....	181
Tab. 261. Timing of VEN and command processing (Dual Host – HIF1 SPI) .....	178	Tab. 269. Timing of VEN triggered boot to secure firmware download mode (single Host – HIF1 SPI ) .....	181
Tab. 262. Timing of VEN and command processing in NFC Forum mode (Dual Host – HIF2 I2C) ....	178	Tab. 270. Crystal requirements for ISO/IEC14443 compliant operation .....	182
Tab. 263. Timing of CORE RESET command after COLD RESET command (Single Host – HIF1 I2C) .....	179	Tab. 271. Frequency requirements for a direct clock input (no crystal) .....	182
Tab. 264. Timing of CORE RESET command after COLD RESET command (Dual Host – HIF1 SPI) .....	179	Tab. 272. Dynamic power control characteristics .....	183
Tab. 265. Timing of NCI CORE RESET command to NCI command mode (Single Host – HIF1 I2C) .....	180	Tab. 273. EEPROM characteristics .....	183
Tab. 266. Timing of NCI CORE RESET to NCI command mode (Dual Host – HIF1 SPI) .....	180	Tab. 274. Operating conditions .....	184
Tab. 267. Timing NCI CORE RESET to NCI command mode (Dual Host – HIF2 I2C ) .....	180	Tab. 275. Thermal characteristics VFBGA64 package ..	184
		Tab. 276. Junction temperature .....	184
		Tab. 277. Thermal shutdown temperature .....	184
		Tab. 278. Package outline VFBGA64 (SOT1307-2) .....	185
		Tab. 279. Abbreviations .....	189
		Tab. 280. Revision history .....	192

## Figures

Fig. 1.	System connections .....	10	Fig. 16.	System overview: DPC, AWC, and ARC .....	34
Fig. 2.	Pin configuration for VFBGA64 .....	12	Fig. 17.	System overview: DPC, AWC, and ARC .....	35
Fig. 3.	Byte and bit order examples .....	20	Fig. 18.	Waveshaping transitions (example falling edge) .....	37
Fig. 4.	Blocking capacitors .....	23	Fig. 19.	One linear transition (example falling edge) ....	38
Fig. 5.	Transmitter supply .....	24	Fig. 20.	Two linear transitions (example falling edge) .....	38
Fig. 6.	Direct transmitter supply .....	25	Fig. 21.	Three linear transitions (example falling edge) .....	39
Fig. 7.	Transmitter supply by DC-DC .....	25	Fig. 22.	Push-Pull driver configuration .....	44
Fig. 8.	DC-DC active .....	26	Fig. 23.	Push-Push driver configuration .....	45
Fig. 9.	DC-DC bypassed (in DCDC_PWR_CONFIG) .....	26	Fig. 24.	Receiver block diagram .....	46
Fig. 10.	No DC-DC used .....	27	Fig. 25.	Package outline VFBGA64 (SOT1307-2) .....	185
Fig. 11.	No DC-DC used .....	27	Fig. 26.	Package outline note VFBGA64 (SOT1307-2) .....	186
Fig. 12.	No DC-DC used - no TX_LDO .....	28	Fig. 27.	Marking of VFBGA64 package .....	187
Fig. 13.	Clocking by crystal .....	30			
Fig. 14.	System overview: DPC, AWC, and ARC .....	33			
Fig. 15.	System overview: DPC, AWC, and ARC .....	34			

## Contents

<b>1</b>	<b>General description</b>	<b>1</b>	9.10.1	DPC algorithm	36
<b>2</b>	<b>Features and benefits</b>	<b>2</b>	9.11	Adaptive waveshaping control (AWC)	37
2.1	RF functionality	2	9.12	Adaptive receiver control (ARC)	39
2.1.1	ISO/IEC14443-A	2	9.13	Energy-saving card detection	41
2.1.2	ISO/IEC 14443-B	2	9.13.1	Low-power card detection (LPCD)	42
2.1.3	FeliCa	2	9.14	RF-level detection	44
2.1.4	Tag type reading	2	9.15	Antenna connection	44
2.1.5	MIFARE card reading	2	9.16	RF debug signals	46
2.1.6	ISO/IEC 15693	2	9.17	Polling loop	48
2.1.7	NFC Forum compliancy	2	9.18	System settings and configuration	49
2.1.8	EMVCo contactless compliancy	2	9.18.1	CLIF register description	49
2.1.9	Host interface	3	9.18.1.1	List of CLIF registers	49
2.2	Transmitter	3	9.18.1.2	SYSTEM_CONFIG (0x00)	51
2.3	Receiver	3	9.18.1.3	CLIF_RX_STATUS (0x05)	52
2.4	Integrated polling loop	3	9.18.1.4	CLIF_RX_STATUS_ERROR (0x06)	53
2.5	Integrated DC-DC	3	9.18.1.5	CLIF_STATUS (0x07)	55
2.6	RF debugging support	3	9.18.1.6	CLIF_CRC_TX_CONFIG (0x12)	58
2.7	ISO7816 contact interface	4	9.18.1.7	CLIF_SS_TX1_RMCFG (0x16)	58
<b>3</b>	<b>Applications</b>	<b>5</b>	9.18.1.8	CLIF_SIGPRO_RM_TECH (0x22)	59
<b>4</b>	<b>Quick reference data</b>	<b>6</b>	9.18.1.9	CLIF_SIGPRO_IIR_CONFIG0 (0x2A)	59
<b>5</b>	<b>Firmware versions</b>	<b>7</b>	9.18.1.10	CLIF_DGRM_BBA (0x2D)	60
<b>6</b>	<b>Ordering information</b>	<b>8</b>	9.18.1.11	CLIF_DGRM_DCO (0x2E)	61
<b>7</b>	<b>Block diagram</b>	<b>10</b>	9.18.1.12	CLIF_DGRM_RSSI (0x30)	62
<b>8</b>	<b>Pinning information</b>	<b>12</b>	9.18.1.13	CLIF_CRC_RX_CONFIG (0x31)	63
8.1	Pin description VFBGA64	12	9.18.1.14	CLIF_RX_WAIT (0x32)	64
<b>9</b>	<b>Functional description</b>	<b>16</b>	9.18.1.15	CLIF_SS_TX1_CMCFG (0x3B)	64
9.1	Functional overview	16	9.18.1.16	CLIF_TIMER1_CONFIG (0x3F)	64
9.2	NCI interface	19	9.18.1.17	CLIF_TIMER1_RELOAD (0x40)	66
9.3	Byte and bit order	20	9.18.1.18	TXLDO_VDDPA_CONFIG (0x54)	66
9.4	Initial calibration	21	9.18.1.19	TXLDO_VOUT_CURR (0x56)	66
9.5	System power states	21	9.18.1.20	CLIF_RXM_FREQ (0x59)	66
9.6	Power supply	22	9.18.1.21	INTERPOLATED_RSSI_REG (0x5C)	67
9.6.1	System power supply overview	22	9.18.1.22	TX_NOV_CALIBRATE_AND_STORE_VAL_REG (0x5D)	67
9.6.2	Connecting blocking capacitors	23	9.18.1.23	CLIF_SS_TX1_RTRANS0 (0x80)	67
9.6.3	Transmitter power supply	23	9.18.1.24	CLIF_SS_TX1_RTRANS1 (0x81)	67
9.6.3.1	TX_LDO transmitter supply	24	9.18.1.25	CLIF_SS_TX1_RTRANS2 (0x82)	67
9.6.3.2	Direct transmitter supply	25	9.18.1.26	CLIF_SS_TX1_RTRANS3 (0x83)	68
9.6.3.3	DC-DC (boost) supply	25	9.18.1.27	CLIF_SS_TX2_RTRANS0 (0x84)	68
9.6.3.4	Configuration example 1: TX_LDO transmitter supply - DC-DC active	26	9.18.1.28	CLIF_SS_TX2_RTRANS1 (0x85)	68
9.6.3.5	Configuration example 2: TX_LDO transmitter supply - DC-DC bypassed	26	9.18.1.29	CLIF_SS_TX2_RTRANS2 (0x86)	68
9.6.3.6	Configuration example 3: TX_LDO transmitter supply connected to VBAT - no DC-DC	27	9.18.1.30	CLIF_SS_TX2_RTRANS3 (0x87)	69
9.6.3.7	Configuration example 4: TX_LDO supplied independent from VBAT - no DC-DC	27	9.18.1.31	CLIF_SS_TX1_FTRANS0 (0x88)	69
9.6.3.8	Configuration example 5: TX_LDO not used - no DC-DC	28	9.18.1.32	CLIF_SS_TX1_FTRANS1 (0x89)	69
9.6.3.9	Supply voltage range for transmitter supply configuration examples	29	9.18.1.33	CLIF_SS_TX1_FTRANS2 (0x8A)	69
9.7	Clock generation	30	9.18.1.34	CLIF_SS_TX1_FTRANS3 (0x8B)	70
9.8	External interfaces	30	9.18.1.35	CLIF_SS_TX2_FTRANS0 (0x8C)	70
9.9	Transmitter overcurrent and temperature protection	31	9.18.1.36	CLIF_SS_TX2_FTRANS1 (0x8D)	70
9.10	Dynamic power control (DPC)	31	9.18.1.37	CLIF_SS_TX2_FTRANS2 (0x8E)	70
			9.18.1.38	CLIF_SS_TX2_FTRANS3 (0x8F)	71
			9.18.2	EEPROM configuration description	72
			9.18.2.1	EEPROM configuration for power, TXLDO, XTAL and clocks	72
			9.18.2.2	RM_TX_SHAPING - TX wave shaping for passive reader mode	77
			9.18.2.3	DPC NFC FORUM settings	114



9.18.2.4	DPC EMVCo settings .....	119
9.18.2.5	ARC settings for passive reader modes .....	124
9.18.2.6	RSSI configuration parameters (applicable for card emulation) .....	132
9.18.2.7	RSSI APC algorithm table output settings TX_PARAM_ENTRY_TABLE. Applicable only for card emulation. ....	137
9.18.2.8	Autocol configuration settings .....	144
9.18.2.9	LPCD related configuration parameters .....	146
9.18.2.10	CORRECTION_ENTRY_TABLE .....	150
9.18.2.11	TX_SHAPING_RTRANS_FTRANS_TABLE TX wave shaping for proprietary correction configuration for rising edge and falling edges. (0x0481) .....	152
9.18.2.12	TX driver NOV (non-overlap) settings configuration. ....	154
9.18.2.13	Active reader mode TX wave shaping configuration .....	156
9.18.2.14	Global TX_SHAPING configuration .....	161
9.18.2.15	RFLD and NFCLD settings .....	164
9.18.2.16	TEMPERATURE related settings .....	165
9.18.2.17	TESTBUS configuration settings .....	166
9.18.2.18	Contact interface configuration settings .....	167
<b>10</b>	<b>Limiting values .....</b>	<b>168</b>
<b>11</b>	<b>Characteristics .....</b>	<b>169</b>
11.1	Static characteristics .....	169
11.2	Timing characteristics .....	173
11.3	Timing characteristics of host interface commands .....	177
11.4	Clock input .....	182
11.5	DPC characteristics .....	183
11.6	EEPROM characteristics .....	183
11.7	Thermal characteristics .....	184
<b>12</b>	<b>Package outline .....</b>	<b>185</b>
12.1	VFPGA64 package .....	185
<b>13</b>	<b>Package marking .....</b>	<b>187</b>
13.1	Package marking drawing VFPGA64 .....	187
<b>14</b>	<b>Handling information .....</b>	<b>188</b>
<b>15</b>	<b>Abbreviations .....</b>	<b>189</b>
<b>16</b>	<b>Revision history .....</b>	<b>192</b>
	<b>Legal information .....</b>	<b>193</b>